

**128M-bit Synchronous DRAM  
4-bank, LVTTL****Description**

The  $\mu$ PD45128441, 45128841, 45128163 are high-speed 134,217,728-bit synchronous dynamic random-access memories, organized as  $8,388,608 \times 4 \times 4$ ,  $4,194,304 \times 8 \times 4$ ,  $2,097,152 \times 16 \times 4$  (word  $\times$  bit  $\times$  bank), respectively.

The synchronous DRAMs achieved high-speed data transfer using the pipeline architecture.

All inputs and outputs are synchronized with the positive edge of the clock.

The synchronous DRAMs are compatible with Low Voltage TTL (LVTTL).

These products are packaged in 54-pin TSOP (II).

**Features**

- Fully Synchronous Dynamic RAM, with all signals referenced to a positive clock edge
- Pulsed interface
- Possible to assert random column address in every cycle
- Quad internal banks controlled by BA0(A13) and BA1(A12)
- Byte control ( $\times 16$ ) by LDQM and UDQM
- Programmable Wrap sequence (Sequential / Interleave)
- Programmable burst length (1, 2, 4, 8 and full page)
- Programmable /CAS latency (2 and 3)
- Automatic precharge and controlled precharge
- CBR (Auto) refresh and self refresh
- $\times 4$ ,  $\times 8$ ,  $\times 16$  organization
- Single  $3.3\text{ V} \pm 0.3\text{ V}$  power supply
- LVTTL compatible inputs and outputs
- 4,096 refresh cycles / 64 ms
- Burst termination by Burst stop command and Precharge command

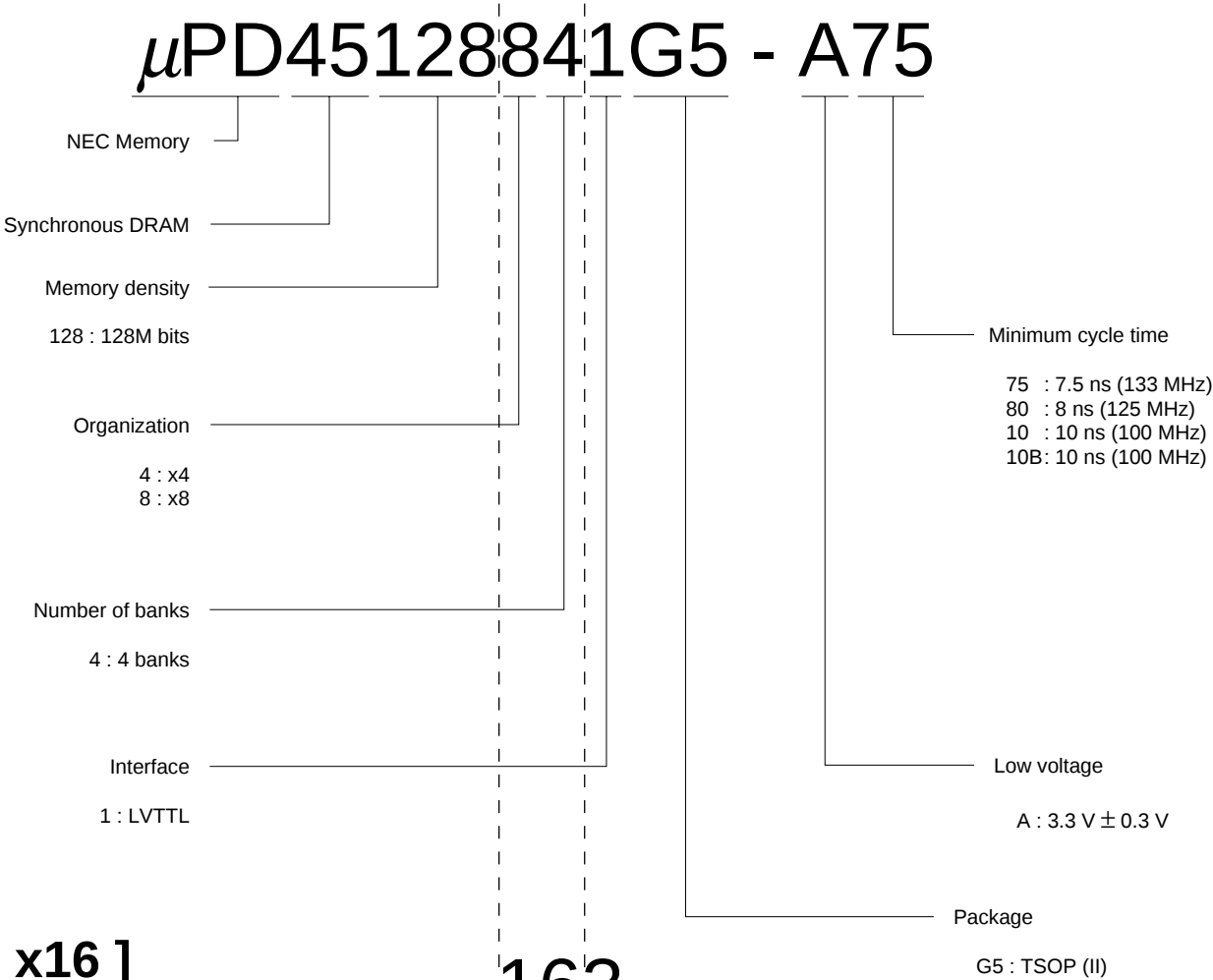
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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

## Ordering Information

| Part number            | Organization<br>(word × bit × bank) | Clock frequency<br>MHz (MAX.) | Package                                     |
|------------------------|-------------------------------------|-------------------------------|---------------------------------------------|
| μPD45128441G5-A75-9JF  | 8M × 4 × 4                          | 133                           | 54-pin Plastic TSOP (II)<br>(10.16mm (400)) |
| μPD45128441G5-A80-9JF  |                                     | 125                           |                                             |
| μPD45128441G5-A10-9JF  |                                     | 100                           |                                             |
| μPD45128441G5-A10B-9JF |                                     | 100                           |                                             |
| μPD45128841G5-A75-9JF  | 4M × 8 × 4                          | 133                           |                                             |
| μPD45128841G5-A80-9JF  |                                     | 125                           |                                             |
| μPD45128841G5-A10-9JF  |                                     | 100                           |                                             |
| μPD45128841G5-A10B-9JF |                                     | 100                           |                                             |
| μPD45128163G5-A75-9JF  | 2M × 16 × 4                         | 133                           |                                             |
| μPD45128163G5-A80-9JF  |                                     | 125                           |                                             |
| μPD45128163G5-A10-9JF  |                                     | 100                           |                                             |
| μPD45128163G5-A10B-9JF |                                     | 100                           |                                             |

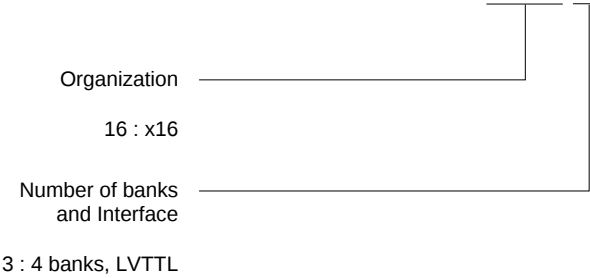
Part Number

[ x4, x8 ]



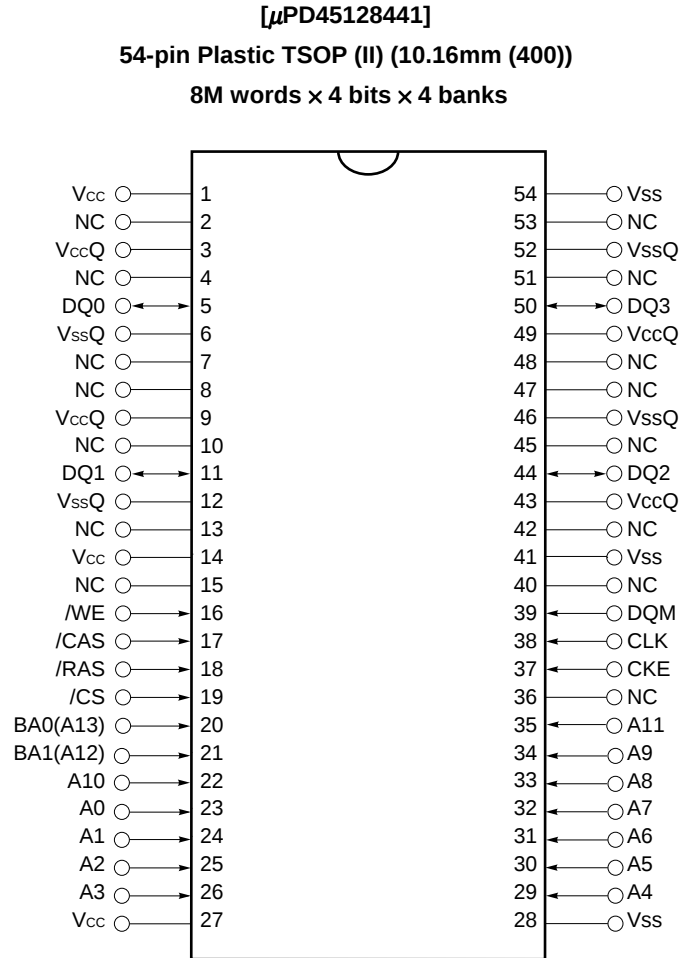
[ x16 ]

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## Pin Configurations

/xxx indicates active low signal.



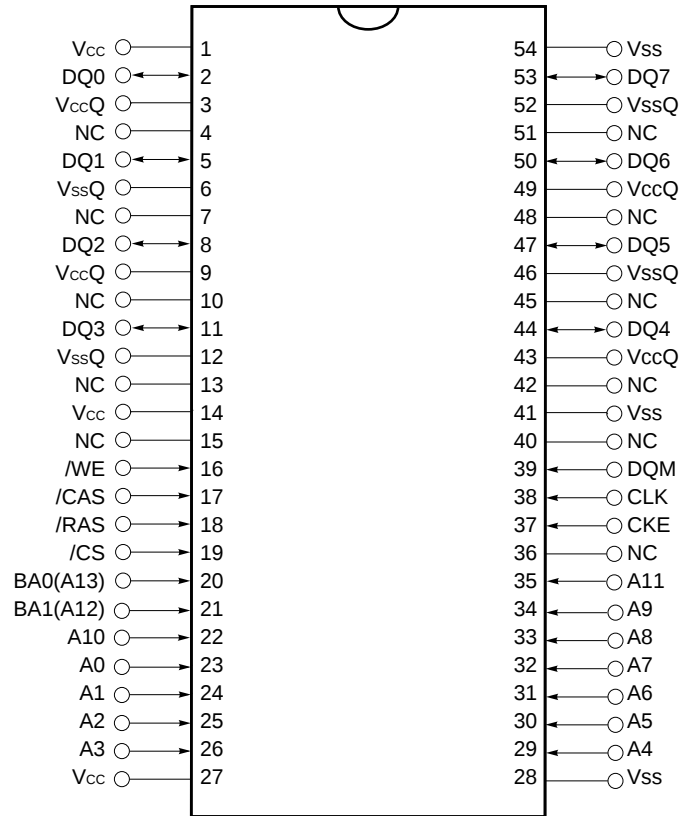
A0 to A11 <sup>Note</sup> : Address inputs  
 BA0(A13), BA1(A12): Bank select  
 DQ0 to DQ3 : Data inputs / outputs  
 CLK : Clock input  
 CKE : Clock enable  
 /CS : Chip select  
 /RAS : Row address strobe  
 /CAS : Column address strobe  
 /WE : Write enable  
 DQM : DQ mask enable  
 Vcc : Supply voltage  
 Vss : Ground  
 VccQ : Supply voltage for DQ  
 VssQ : Ground for DQ  
 NC : No connection

**Note** A0 to A11 : Row address inputs  
 A0 to A9, A11 : Column address inputs

[μPD45128841]

54-pin Plastic TSOP (II) (10.16mm (400))

4M words × 8 bits × 4 banks



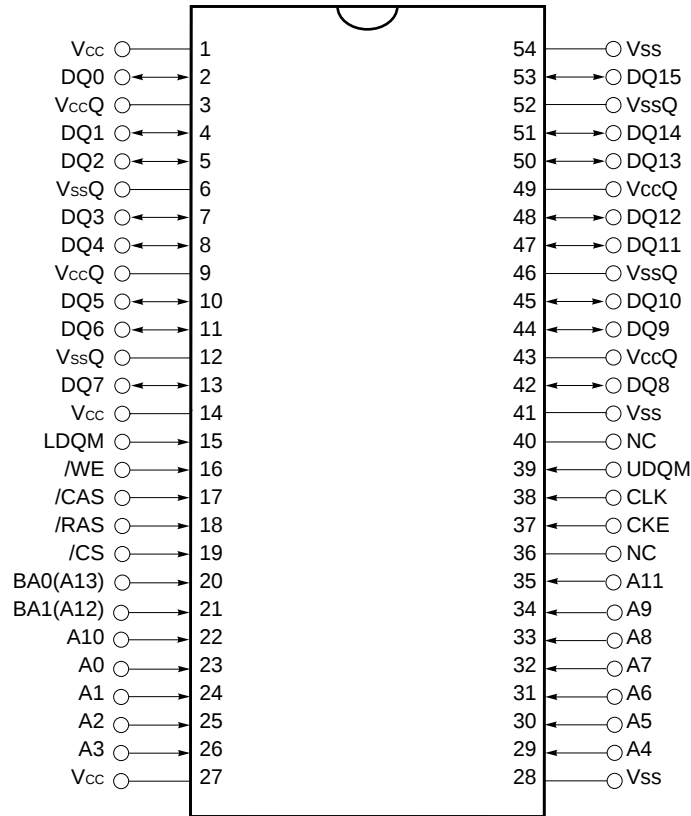
A0 to A11 <sup>Note</sup> : Address inputs  
 BA0(A13), BA1(A12): Bank select  
 DQ0 to DQ7 : Data inputs / outputs  
 CLK : Clock input  
 CKE : Clock enable  
 /CS : Chip select  
 /RAS : Row address strobe  
 /CAS : Column address strobe  
 /WE : Write enable  
 DQM : DQ mask enable  
 Vcc : Supply voltage  
 Vss : Ground  
 VccQ : Supply voltage for DQ  
 VssQ : Ground for DQ  
 NC : No connection

**Note** A0 to A11 : Row address inputs  
 A0 to A9 : Column address inputs

[μPD45128163]

54-pin Plastic TSOP (II) (10.16mm (400))

2M words × 16 bits × 4 banks



A0 to A11 <sup>Note</sup> : Address inputs

BA0(A13), BA1(A12): Bank select

DQ0 to DQ15 : Data inputs / outputs

CLK : Clock input

CKE : Clock enable

/CS : Chip select

/RAS : Row address strobe

/CAS : Column address strobe

/WE : Write enable

LDQM : Lower DQ mask enable

UDQM : Upper DQ mask enable

Vcc : Supply voltage

Vss : Ground

VccQ : Supply voltage for DQ

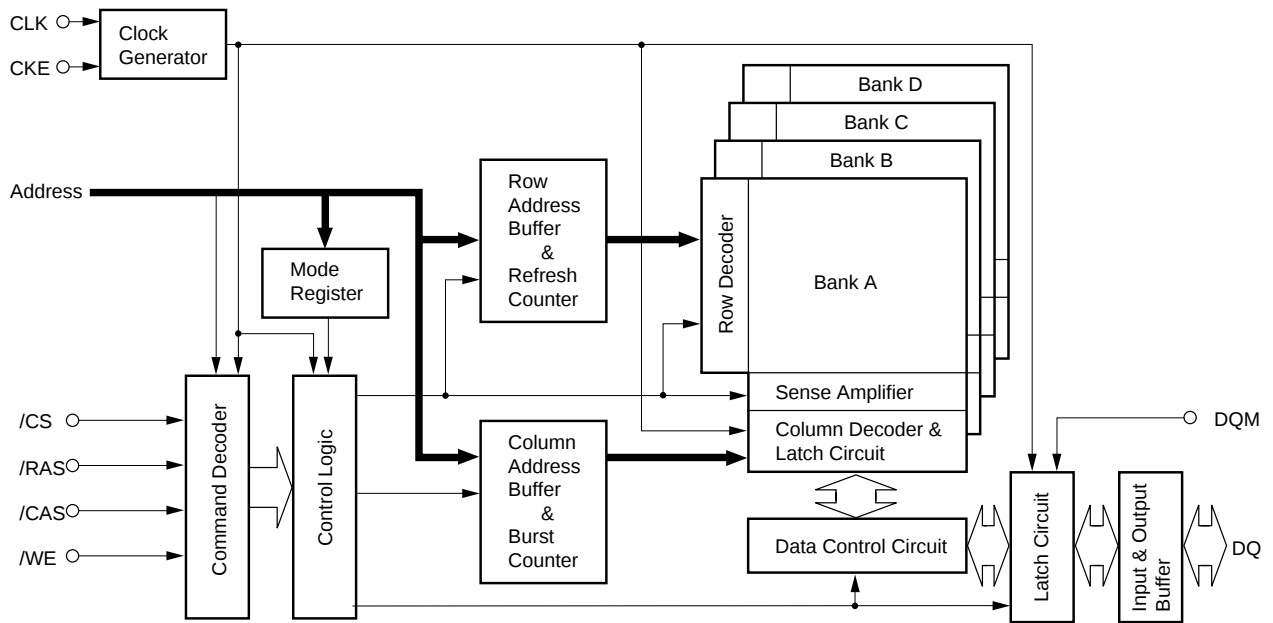
VssQ : Ground for DQ

NC : No connection

**Note** A0 to A11 : Row address inputs

A0 to A8 : Column address inputs

## Block Diagram



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## 1. Input / Output Pin Function

| Pin name             | Input / Output | Function                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|----------------------|----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CLK                  | Input          | CLK is the master clock input. Other inputs signals are referenced to the CLK rising edge.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| CKE                  | Input          | CKE determine validity of the next CLK (clock). If CKE is high, the next CLK rising edge is valid; otherwise it is invalid. If the CLK rising edge is invalid, the internal clock is not issued and the μPD45128xxx suspends operation.<br>When the μPD45128xxx is not in burst mode and CKE is negated, the device enters power down mode. During power down mode, CKE must remain low.                                                                                                                                                                                                                                                                                             |
| /CS                  | Input          | /CS low starts the command input cycle. When /CS is high, commands are ignored but operations continue.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| /RAS, /CAS, /WE      | Input          | /RAS, /CAS and /WE have the same symbols on conventional DRAM but different functions. For details, refer to the command table.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| A0 - A11             | Input          | Row Address is determined by A0 - A11 at the CLK (clock) rising edge in the active command cycle. It does not depend on the bit organization.<br>Column Address is determined by A0 - A9, A11 at the CLK rising edge in the read or write command cycle. It depends on the bit organization: A0 - A9, A11 for ×4 device, A0 - A9 for ×8 device, A0 - A8 for ×16 device.<br>A10 defines the precharge mode. When A10 is high in the precharge command cycle, all banks are precharged; when A10 is low, only the bank selected by BA0(A13) and BA1(A12) is precharged.<br>When A10 is high in read or write command cycle, the precharge starts automatically after the burst access. |
| BA0, BA1             | Input          | BA0(A13) and BA1(A12) are the bank select signal. In command cycle, BA0(A13) and BA1(A12) low select bank A, BA0(A13) high and BA1(A12) low select bank B, BA0(A13) low and BA1(A12) high select bank C and then BA0(A13) and BA1(A12) high select bank D.                                                                                                                                                                                                                                                                                                                                                                                                                           |
| DQM, UDQM, LDQM      | Input          | DQM controls I/O buffers. In ×16 products, UDQM and LDQM control upper byte and lower byte I/O buffers, respectively.<br>In read mode, DQM controls the output buffers like a conventional /OE pin.<br>DQM high and DQM low turn the output buffers off and on, respectively.<br>The DQM latency for the read is two clocks.<br>In write mode, DQM controls the word mask. Input data is written to the memory cell if DQM is low but not if DQM is high.<br>The DQM latency for the write is zero.                                                                                                                                                                                  |
| DQ0 - DQ15           | Input / Output | DQ pins have the same function as I/O pins on a conventional DRAM.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| Vcc, Vss, VccQ, VssQ | (Power supply) | Vcc and Vss are power supply pins for internal circuits. VccQ and VssQ are power supply pins for the output buffers.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |

## 2. Commands

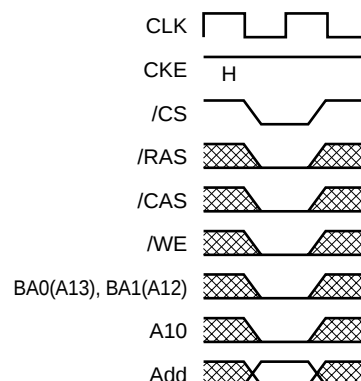
### Mode register set command

(/CS, /RAS, /CAS, /WE = Low)

The μPD45128xxx has a mode register that defines how the device operates. In this command, A0 through A11, BA0(A13) and BA1(A12) are the data input pins. After power on, the mode register set command must be executed to initialize the device.

The mode register can be set only when all banks are in idle state. During 2 CLK ( $t_{RSC}$ ) following this command, the μPD45128xxx cannot accept any other commands.

Fig.1 Mode register set command

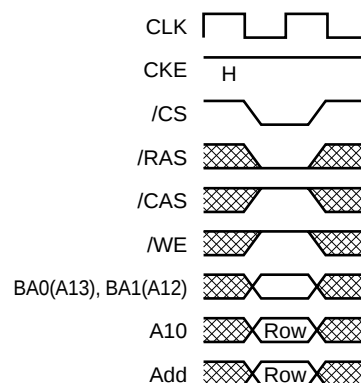


### Activate command

(/CS, /RAS = Low, /CAS, /WE = High)

The μPD45128xxx has four banks, each with 4,096 rows. This command activates the bank selected by BA0(A13) and BA1(A12) and a row address selected by A0 through A11. This command corresponds to a conventional DRAM's /RAS falling.

Fig.2 Row address strobe and bank activate command



### Precharge command

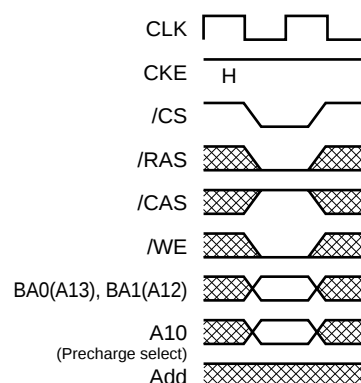
(/CS, /RAS, /WE = Low, /CAS = High)

This command begins precharge operation of the bank selected by BA0(A13) and BA1(A12). When A10 is High, all banks are precharged, regardless of BA0(A13) and BA1(A12). When A10 is Low, only the bank selected by BA0(A13) and BA1(A12) is precharged.

After this command, the μPD45128xxx can't accept the activate command to the precharging bank during  $t_{RP}$  (precharge to activate command period).

This command corresponds to a conventional DRAM's /RAS rising.

Fig.3 Precharge command

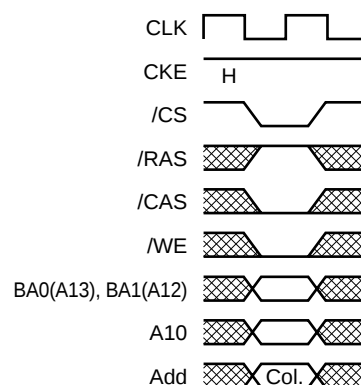


## Write command

(/CS, /CAS, /WE = Low, /RAS = High)

If the mode register is in the burst write mode, this command sets the burst start address given by the column address to begin the burst write operation. The first write data in burst mode can input with this command with subsequent data on following clocks.

Fig.4 Column address and write command

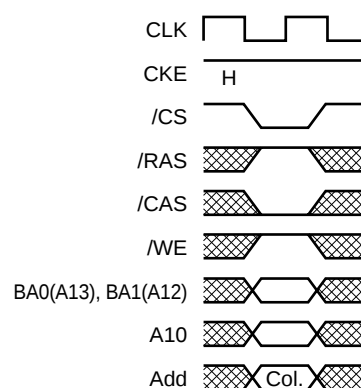


## Read command

(/CS, /CAS = Low, /RAS, /WE = High)

Read data is available after /CAS latency requirements have been met. This command sets the burst start address given by the column address.

Fig.5 Column address and read command



## CBR (auto) refresh command

(/CS, /RAS, /CAS = Low, /WE, CKE = High)

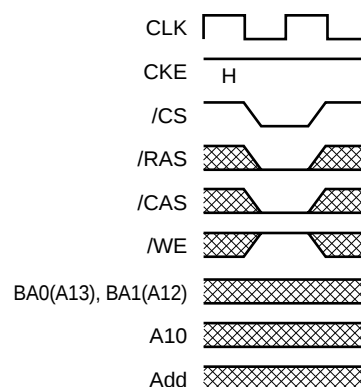
This command is a request to begin the CBR (auto) refresh operation. The refresh address is generated internally.

Before executing CBR (auto) refresh, all banks must be precharged.

After this cycle, all banks will be in the idle (precharged) state and ready for a row activate command.

During  $t_{RC}$  period (from refresh command to refresh or activate command), the μPD45128xxx cannot accept any other command.

Fig.6 CBR (auto) refresh command



### Self refresh entry command

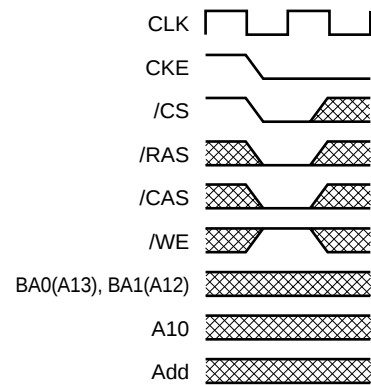
(/CS, /RAS, /CAS, CKE = Low, /WE = High)

After the command execution, self refresh operation continues while CKE remains low. When CKE goes high, the μPD45128xxx exits the self refresh mode.

During self refresh mode, refresh interval and refresh operation are performed internally, so there is no need for external control.

Before executing self refresh, all banks must be precharged.

Fig.7 Self refresh entry command

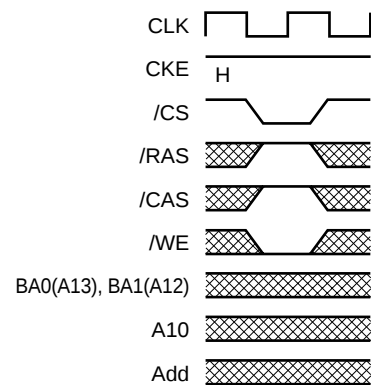


### Burst stop command

(/CS, /WE = Low, /RAS, /CAS = High)

This command can stop the current burst operation.

Fig.8 Burst stop command in Full Page Mode

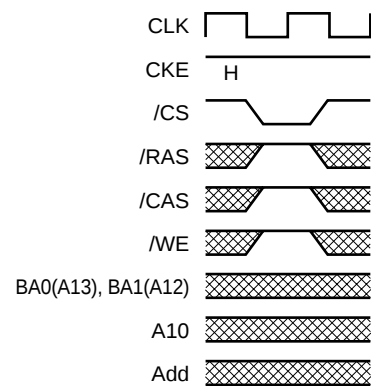


### No operation

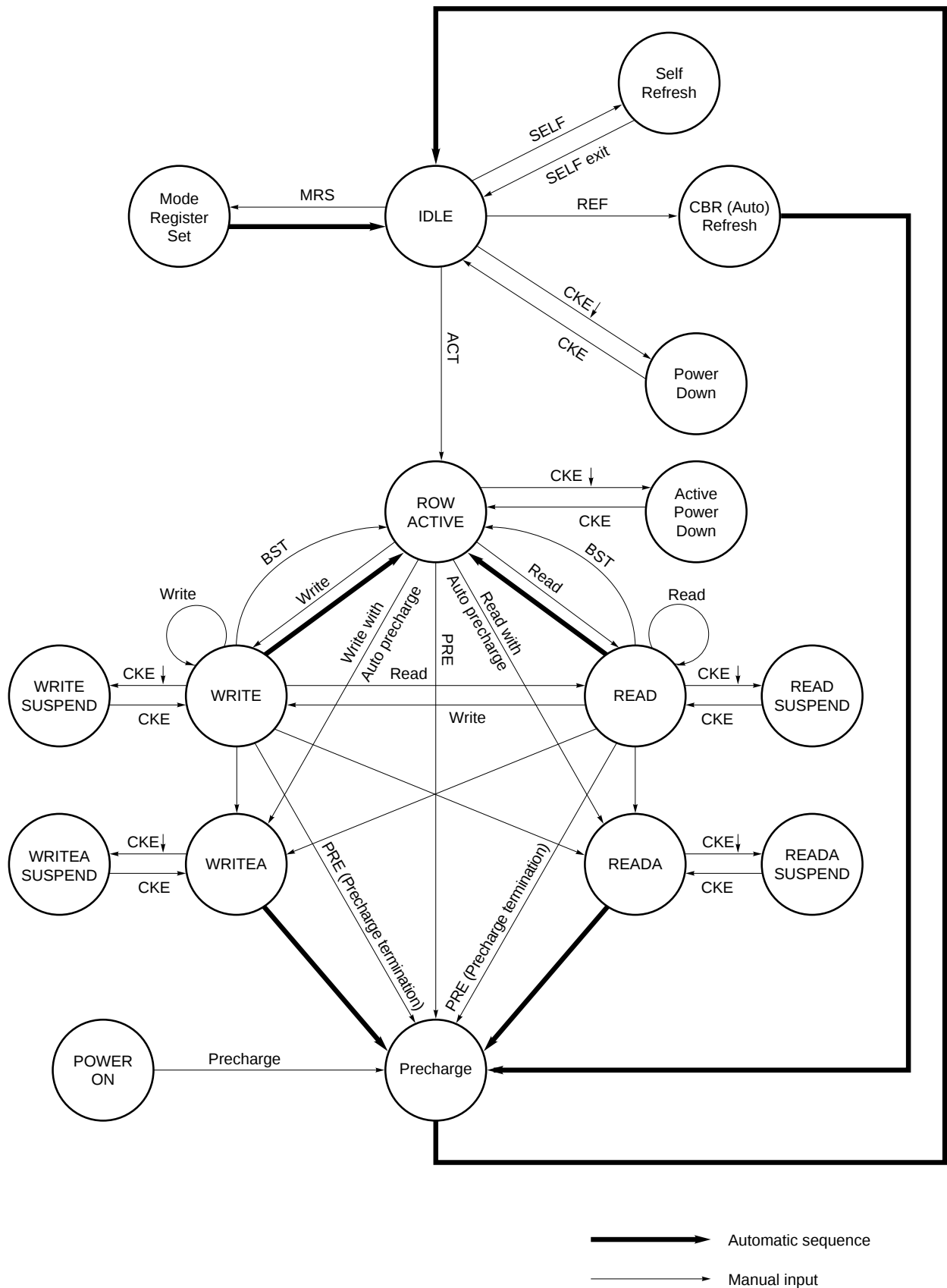
(/CS = Low, /RAS, /CAS, /WE = High)

This command is not an execution command. No operations begin or terminate by this command.

Fig.9 No operation



### 3. Simplified State Diagram



## 4. Truth Table

### 4.1 Command Truth Table

| Function                  | Symbol | CKE   |   | /CS | /RAS | /CAS | /WE | BA1,<br>BA0 | A10 | A11,<br>A9 - A0 |
|---------------------------|--------|-------|---|-----|------|------|-----|-------------|-----|-----------------|
|                           |        | n - 1 | n |     |      |      |     |             |     |                 |
| Device deselect           | DESL   | H     | × | H   | ×    | ×    | ×   | ×           | ×   | ×               |
| No operation              | NOP    | H     | × | L   | H    | H    | H   | ×           | ×   | ×               |
| Burst stop                | BST    | H     | × | L   | H    | H    | L   | ×           | ×   | ×               |
| Read                      | READ   | H     | × | L   | H    | L    | H   | V           | L   | V               |
| Read with auto precharge  | READA  | H     | × | L   | H    | L    | H   | V           | H   | V               |
| Write                     | WRIT   | H     | × | L   | H    | L    | L   | V           | L   | V               |
| Write with auto precharge | WRITA  | H     | × | L   | H    | L    | L   | V           | H   | V               |
| Bank activate             | ACT    | H     | × | L   | L    | H    | H   | V           | V   | V               |
| Precharge select bank     | PRE    | H     | × | L   | L    | H    | L   | V           | L   | ×               |
| Precharge all banks       | PALL   | H     | × | L   | L    | H    | L   | ×           | H   | ×               |
| Mode register set         | MRS    | H     | × | L   | L    | L    | L   | L           | L   | V               |

**Remark** H = High level, L = Low level, × = High or Low level (Don't care), V = Valid data input

### 4.2 DQM Truth Table

| Function                                  | Symbol | CKE   |   | DQM |   |
|-------------------------------------------|--------|-------|---|-----|---|
|                                           |        | n - 1 | n | U   | L |
| Data write / output enable                | ENB    | H     | × | L   |   |
| Data mask / output disable                | MASK   | H     | × | H   |   |
| Upper byte write enable / output enable   | ENBU   | H     | × | L   | × |
| Lower byte write enable / output enable   | ENBL   | H     | × | ×   | L |
| Upper byte write inhibit / output disable | MASKU  | H     | × | H   | × |
| Lower byte write inhibit / output disable | MASKL  | H     | × | ×   | H |

**Remark** H = High level, L = Low level, × = High or Low level (Don't care)

### 4.3 CKE Truth Table

| Current state | Function                   | Symbol | CKE   |   | /CS | /RAS | /CAS | /WE | Address |
|---------------|----------------------------|--------|-------|---|-----|------|------|-----|---------|
|               |                            |        | n - 1 | n |     |      |      |     |         |
| Activating    | Clock suspend mode entry   |        | H     | L | ×   | ×    | ×    | ×   | ×       |
| Any           | Clock suspend mode         |        | L     | L | ×   | ×    | ×    | ×   | ×       |
| Clock suspend | Clock suspend mode exit    |        | L     | H | ×   | ×    | ×    | ×   | ×       |
| Idle          | CBR (auto) refresh command | REF    | H     | H | L   | L    | L    | H   | ×       |
| Idle          | Self refresh entry         | SELF   | H     | L | L   | L    | L    | H   | ×       |
| Self refresh  | Self refresh exit          |        | L     | H | L   | H    | H    | H   | ×       |
|               |                            |        | L     | H | H   | ×    | ×    | ×   | ×       |
| Idle          | Power down entry           |        | H     | L | ×   | ×    | ×    | ×   | ×       |
| Power down    | Power down exit            |        | L     | H | H   | ×    | ×    | ×   | ×       |
|               |                            |        | L     | H | L   | H    | H    | H   | ×       |

**Remark** H = High level, L = Low level, × = High or Low level (Don't care)

4.4 Operative Command Table <sup>Note1</sup>

(1/3)

| Current state | /CS | /RAS | /CAS | /WE | Address     | Command    | Action                                      | Notes |
|---------------|-----|------|------|-----|-------------|------------|---------------------------------------------|-------|
| Idle          | H   | ×    | ×    | ×   | ×           | DESL       | Nop or power down                           | 2     |
|               | L   | H    | H    | ×   | ×           | NOP or BST | Nop or power down                           | 2     |
|               | L   | H    | L    | H   | BA, CA, A10 | READ/READA | ILLEGAL                                     | 3     |
|               | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | ILLEGAL                                     | 3     |
|               | L   | L    | H    | H   | BA, RA      | ACT        | Row activating                              |       |
|               | L   | L    | H    | L   | BA, A10     | PRE/PALL   | Nop                                         |       |
|               | L   | L    | L    | H   | ×           | REF/SELF   | CBR (auto) refresh or self refresh          | 4     |
|               | L   | L    | L    | L   | Op-Code     | MRS        | Mode register accessing                     |       |
| Row active    | H   | ×    | ×    | ×   | ×           | DESL       | Nop                                         |       |
|               | L   | H    | H    | ×   | ×           | NOP or BST | Nop                                         |       |
|               | L   | H    | L    | H   | BA, CA, A10 | READ/READA | Begin read : Determine AP                   | 5     |
|               | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | Begin write : Determine AP                  | 5     |
|               | L   | L    | H    | H   | BA, RA      | ACT        | ILLEGAL                                     | 3     |
|               | L   | L    | H    | L   | BA, A10     | PRE/PALL   | Precharge                                   | 6     |
|               | L   | L    | L    | H   | ×           | REF/SELF   | ILLEGAL                                     |       |
|               | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL                                     |       |
| Read          | H   | ×    | ×    | ×   | ×           | DESL       | Continue burst to end → Row active          |       |
|               | L   | H    | H    | H   | ×           | NOP        | Continue burst to end → Row active          |       |
|               | L   | H    | H    | L   | ×           | BST        | Burst stop → Row active                     |       |
|               | L   | H    | L    | H   | BA, CA, A10 | READ/READA | Terminate burst, new read : Determine AP    | 7     |
|               | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | Terminate burst, start write : Determine AP | 7, 8  |
|               | L   | L    | H    | H   | BA, RA      | ACT        | ILLEGAL                                     | 3     |
|               | L   | L    | H    | L   | BA, A10     | PRE/PALL   | Terminate burst, precharging                |       |
|               | L   | L    | L    | H   | ×           | REF/SELF   | ILLEGAL                                     |       |
|               | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL                                     |       |
| Write         | H   | ×    | ×    | ×   | ×           | DESL       | Continue burst to end → Write recovering    |       |
|               | L   | H    | H    | H   | ×           | NOP        | Continue burst to end → Write recovering    |       |
|               | L   | H    | H    | L   | ×           | BST        | Burst stop → Row active                     |       |
|               | L   | H    | L    | H   | BA, CA, A10 | READ/READA | Terminate burst, start read : Determine AP  | 7, 8  |
|               | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | Terminate burst, new write : Determine AP   | 7     |
|               | L   | L    | H    | H   | BA, RA      | ACT        | ILLEGAL                                     | 3     |
|               | L   | L    | H    | L   | BA, A10     | PRE/PALL   | Terminate burst, precharging                | 9     |
|               | L   | L    | L    | H   | ×           | REF/SELF   | ILLEGAL                                     |       |
|               | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL                                     |       |

(2/3)

| Current state             | /CS | /RAS | /CAS | /WE | Address     | Command    | Action                                                       | Notes |
|---------------------------|-----|------|------|-----|-------------|------------|--------------------------------------------------------------|-------|
| Read with auto precharge  | H   | ×    | ×    | ×   | ×           | DESL       | Continue burst to end → Precharging                          |       |
|                           | L   | H    | H    | H   | ×           | NOP        | Continue burst to end → Precharging                          |       |
|                           | L   | H    | H    | L   | ×           | BST        | ILLEGAL                                                      |       |
|                           | L   | H    | L    | H   | BA, CA, A10 | READ/READA | ILLEGAL                                                      | 3     |
|                           | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | ILLEGAL                                                      | 3     |
|                           | L   | L    | H    | H   | BA, RA      | ACT        | ILLEGAL                                                      | 3     |
|                           | L   | L    | H    | L   | BA, A10     | PRE/PALL   | ILLEGAL                                                      | 3     |
|                           | L   | L    | L    | H   | ×           | REF/SELF   | ILLEGAL                                                      |       |
|                           | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL                                                      |       |
| Write with auto precharge | H   | ×    | ×    | ×   | ×           | DESL       | Continue burst to end → Write recovering with auto precharge |       |
|                           | L   | H    | H    | H   | ×           | NOP        | Continue burst to end → Write recovering with auto precharge |       |
|                           | L   | H    | H    | L   | ×           | BST        | ILLEGAL                                                      |       |
|                           | L   | H    | L    | H   | BA, CA, A10 | READ/READA | ILLEGAL                                                      | 3     |
|                           | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | ILLEGAL                                                      | 3     |
|                           | L   | L    | H    | H   | BA, RA      | ACT        | ILLEGAL                                                      | 3     |
|                           | L   | L    | H    | L   | BA, A10     | PRE/PALL   | ILLEGAL                                                      | 3     |
|                           | L   | L    | L    | H   | ×           | REF/SELF   | ILLEGAL                                                      |       |
|                           | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL                                                      |       |
| Precharging               | H   | ×    | ×    | ×   | ×           | DESL       | Nop → Enter idle after t <sub>RP</sub>                       |       |
|                           | L   | H    | H    | H   | ×           | NOP        | Nop → Enter idle after t <sub>RP</sub>                       |       |
|                           | L   | H    | H    | L   | ×           | BST        | ILLEGAL                                                      |       |
|                           | L   | H    | L    | H   | BA, CA, A10 | READ/READA | ILLEGAL                                                      | 3     |
|                           | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | ILLEGAL                                                      | 3     |
|                           | L   | L    | H    | H   | BA, RA      | ACT        | ILLEGAL                                                      | 3     |
|                           | L   | L    | H    | L   | BA, A10     | PRE/PALL   | Nop → Enter idle after t <sub>RP</sub>                       |       |
|                           | L   | L    | L    | H   | ×           | REF/SELF   | ILLEGAL                                                      |       |
|                           | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL                                                      |       |
| Row activating            | H   | ×    | ×    | ×   | ×           | DESL       | Nop → Enter bank active after t <sub>RCD</sub>               |       |
|                           | L   | H    | H    | H   | ×           | NOP        | Nop → Enter bank active after t <sub>RCD</sub>               |       |
|                           | L   | H    | H    | L   | ×           | BST        | ILLEGAL                                                      |       |
|                           | L   | H    | L    | H   | BA, CA, A10 | READ/READA | ILLEGAL                                                      | 3     |
|                           | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA | ILLEGAL                                                      | 3     |
|                           | L   | L    | H    | H   | BA, RA      | ACT        | ILLEGAL                                                      | 3, 10 |
|                           | L   | L    | H    | L   | BA, A10     | PRE/PALL   | ILLEGAL                                                      | 3     |
|                           | L   | L    | L    | H   | ×           | REF/SELF   | ILLEGAL                                                      |       |
|                           | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL                                                      |       |

(3/3)

| Current state                           | /CS | /RAS | /CAS | /WE | Address     | Command                       | Action                                        | Notes |
|-----------------------------------------|-----|------|------|-----|-------------|-------------------------------|-----------------------------------------------|-------|
| Write recovering                        | H   | ×    | ×    | ×   | ×           | DESL                          | Nop → Enter row active after t <sub>DPL</sub> |       |
|                                         | L   | H    | H    | H   | ×           | NOP                           | Nop → Enter row active after t <sub>DPL</sub> |       |
|                                         | L   | H    | H    | L   | ×           | BST                           | Nop → Enter row active after t <sub>DPL</sub> |       |
|                                         | L   | H    | L    | H   | BA, CA, A10 | READ/READA                    | Start read, Determine AP                      | 8     |
|                                         | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA                    | New write, Determine AP                       |       |
|                                         | L   | L    | H    | H   | BA, RA      | ACT                           | ILLEGAL                                       | 3     |
|                                         | L   | L    | H    | L   | BA, A10     | PRE/PALL                      | ILLEGAL                                       | 3     |
|                                         | L   | L    | L    | H   | ×           | REF/SELF                      | ILLEGAL                                       |       |
|                                         | L   | L    | L    | L   | Op-Code     | MRS                           | ILLEGAL                                       |       |
| Write recovering<br>with auto precharge | H   | ×    | ×    | ×   | ×           | DESL                          | Nop → Enter precharge after t <sub>DPL</sub>  |       |
|                                         | L   | H    | H    | H   | ×           | NOP                           | Nop → Enter precharge after t <sub>DPL</sub>  |       |
|                                         | L   | H    | H    | L   | ×           | BST                           | Nop → Enter precharge after t <sub>DPL</sub>  |       |
|                                         | L   | H    | L    | H   | BA, CA, A10 | READ/READA                    | ILLEGAL                                       | 3, 8  |
|                                         | L   | H    | L    | L   | BA, CA, A10 | WRIT/WRITA                    | ILLEGAL                                       | 3     |
|                                         | L   | L    | H    | H   | BA, RA      | ACT                           | ILLEGAL                                       | 3     |
|                                         | L   | L    | H    | L   | BA, A10     | PRE/PALL                      | ILLEGAL                                       |       |
|                                         | L   | L    | L    | H   | ×           | REF/SELF                      | ILLEGAL                                       |       |
|                                         | L   | L    | L    | L   | Op-Code     | MRS                           | ILLEGAL                                       |       |
| Refreshing                              | H   | ×    | ×    | ×   | ×           | DESL                          | Nop → Enter idle after t <sub>RC</sub>        |       |
|                                         | L   | H    | H    | ×   | ×           | NOP/BST                       | Nop → Enter idle after t <sub>RC</sub>        |       |
|                                         | L   | H    | L    | ×   | ×           | READ/WRIT                     | ILLEGAL                                       |       |
|                                         | L   | L    | H    | ×   | ×           | ACT/PRE/PALL                  | ILLEGAL                                       |       |
|                                         | L   | L    | L    | ×   | ×           | REF/SELF/MRS                  | ILLEGAL                                       |       |
| Mode register<br>accessing              | H   | ×    | ×    | ×   | ×           | DESL                          | Nop → Enter idle after t <sub>RSC</sub>       |       |
|                                         | L   | H    | H    | H   | ×           | NOP                           | Nop → Enter idle after t <sub>RSC</sub>       |       |
|                                         | L   | H    | H    | L   | ×           | BST                           | ILLEGAL                                       |       |
|                                         | L   | H    | L    | ×   | ×           | READ/WRIT                     | ILLEGAL                                       |       |
|                                         | L   | L    | ×    | ×   | ×           | ACT/PRE/PALL/<br>REF/SELF/MRS | ILLEGAL                                       |       |

- Notes**
1. All entries assume that CKE was active (High level) during the preceding clock cycle.
  2. If all banks are idle, and CKE is inactive (Low level), μPD45128xxx will enter Power down mode. All input buffers except CKE will be disabled.
  3. Illegal to bank in specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
  4. If all banks are idle, and CKE is inactive (Low level), μPD45128xxx will enter Self refresh mode. All input buffers except CKE will be disabled.
  5. Illegal if t<sub>RCD</sub> is not satisfied.
  6. Illegal if t<sub>RAS</sub> is not satisfied.
  7. Must satisfy burst interrupt condition.
  8. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
  9. Must mask preceding data which don't satisfy t<sub>DPL</sub>.
  10. Illegal if t<sub>RRD</sub> is not satisfied.

**Remark** H = High level, L = Low level, × = High or Low level (Don't care), V = Valid data

#### 4.5 Command Truth Table for CKE

| Current State                     | CKE   |   | /CS | /RAS | /CAS | /WE | Address | Action                                         | Notes |
|-----------------------------------|-------|---|-----|------|------|-----|---------|------------------------------------------------|-------|
|                                   | n – 1 | n |     |      |      |     |         |                                                |       |
| Self refresh                      | H     | × | ×   | ×    | ×    | ×   | ×       | INVALID, CLK (n – 1) would exit self refresh   |       |
|                                   | L     | H | H   | ×    | ×    | ×   | ×       | Self refresh recovery                          |       |
|                                   | L     | H | L   | H    | H    | ×   | ×       | Self refresh recovery                          |       |
|                                   | L     | H | L   | H    | L    | ×   | ×       | ILLEGAL                                        |       |
|                                   | L     | H | L   | L    | ×    | ×   | ×       | ILLEGAL                                        |       |
|                                   | L     | L | ×   | ×    | ×    | ×   | ×       | Maintain self refresh                          |       |
| Self refresh recovery             | H     | H | H   | ×    | ×    | ×   | ×       | Idle after t <sub>RC</sub>                     |       |
|                                   | H     | H | L   | H    | H    | ×   | ×       | Idle after t <sub>RC</sub>                     |       |
|                                   | H     | H | L   | H    | L    | ×   | ×       | ILLEGAL                                        |       |
|                                   | H     | H | L   | L    | ×    | ×   | ×       | ILLEGAL                                        |       |
|                                   | H     | L | H   | ×    | ×    | ×   | ×       | ILLEGAL                                        |       |
|                                   | H     | L | L   | H    | H    | ×   | ×       | ILLEGAL                                        |       |
|                                   | H     | L | L   | H    | L    | ×   | ×       | ILLEGAL                                        |       |
|                                   | H     | L | L   | L    | ×    | ×   | ×       | ILLEGAL                                        |       |
| Power down                        | H     | × | ×   | ×    | ×    | ×   |         | INVALID, CLK (n – 1) would exit power down     |       |
|                                   | L     | H | H   | ×    | ×    | ×   | ×       | EXIT power down → Idle                         |       |
|                                   | L     | H | L   | H    | H    | H   | ×       | EXIT power down → Idle                         |       |
|                                   | L     | L | ×   | ×    | ×    | ×   | ×       | Maintain power down mode                       |       |
| All banks idle                    | H     | H | H   | ×    | ×    | ×   |         | Refer to operations in Operative Command Table |       |
|                                   | H     | H | L   | H    | ×    | ×   |         | Refer to operations in Operative Command Table |       |
|                                   | H     | H | L   | L    | H    | ×   |         | Refer to operations in Operative Command Table |       |
|                                   | H     | H | L   | L    | L    | H   | ×       | CBR (auto) Refresh                             |       |
|                                   | H     | H | L   | L    | L    | L   | Op-Code | Refer to operations in Operative Command Table |       |
|                                   | H     | L | H   | ×    | ×    | ×   |         | Refer to operations in Operative Command Table |       |
|                                   | H     | L | L   | H    | ×    | ×   |         | Refer to operations in Operative Command Table |       |
|                                   | H     | L | L   | L    | H    | ×   |         | Refer to operations in Operative Command Table |       |
|                                   | H     | L | L   | L    | L    | H   | ×       | Self refresh                                   | 1     |
|                                   | H     | L | L   | L    | L    | L   | Op-Code | Refer to operations in Operative Command Table |       |
|                                   | L     | × | ×   | ×    | ×    | ×   | ×       | Power down                                     | 1     |
| Row active                        | H     | × | ×   | ×    | ×    | ×   | ×       | Refer to operations in Operative Command Table |       |
|                                   | L     | × | ×   | ×    | ×    | ×   | ×       | Power down                                     | 1     |
| Any state other than listed above | H     | H | ×   | ×    | ×    | ×   |         | Refer to operations in Operative Command Table |       |
|                                   | H     | L | ×   | ×    | ×    | ×   | ×       | Begin clock suspend next cycle                 | 2     |
|                                   | L     | H | ×   | ×    | ×    | ×   | ×       | Exit clock suspend next cycle                  |       |
|                                   | L     | L | ×   | ×    | ×    | ×   | ×       | Maintain clock suspend                         |       |

**Notes 1.** Self refresh can be entered only from the all banks idle state. Power down can be entered only from all banks idle or row active state.

**2.** Must be legal command as defined in Operative Command Table.

**Remark** H = High level, L = Low level, × = High or Low level (Don't care)

## 5. Initialization

The synchronous DRAM is initialized in the power-on sequence according to the following.

- (1) To stabilize internal circuits, when power is applied, a 100  $\mu$ s or longer pause must precede any signal toggling.
- (2) After the pause, all banks must be precharged using the Precharge command (The Precharge all banks command is convenient).
- (3) Once the precharge is completed and the minimum  $t_{RP}$  is satisfied, the mode register can be programmed. After the mode register set cycle,  $t_{RSC}$  (2 CLK minimum) pause must be satisfied as well.
- (4) Two or more CBR (Auto) refresh must be performed.

**Remarks** 1. The sequence of Mode register programming and Refresh above may be transposed.  
2. CKE and DQM must be held high until the Precharge command is issued to ensure data-bus Hi-Z.

## 6. Programming the Mode Register

The mode register is programmed by the Mode register set command using address bits A11 through A0, BA0(A13) and BA1(A12) as data inputs. The register retains data until it is reprogrammed or the device loses power.

The mode register has four fields;

Options : A11 through A7, BA0(A13), BA1(A12)  
 /CAS latency : A6 through A4  
 Wrap type : A3  
 Burst length : A2 through A0

Following mode register programming, no command can be issued before at least 2 CLK have elapsed.

### /CAS Latency

/CAS latency is the most critical of the parameters being set. It tells the device how many clocks must elapse before the data will be available.

The value is determined by the frequency of the clock and the speed grade of the device. **13.3 Relationship between Frequency and Latency** shows the relationship of /CAS latency to the clock period and the speed grade of the device.

### Burst Length

Burst Length is the number of words that will be output or input in a read or write cycle. After a read burst is completed, the output bus will become Hi-Z.

The burst length is programmable as 1, 2, 4, 8 or full page.

### Wrap Type (Burst Sequence)

The wrap type specifies the order in which the burst data will be addressed. This order is programmable as either "Sequential" or "Interleave". The method chosen will depend on the type of CPU in the system.

Some microprocessor cache systems are optimized for sequential addressing and others for interleaved addressing. **7.1 Burst Length and Sequence** shows the addressing sequence for each burst length using them. Both sequences support bursts of 1, 2, 4 and 8. Additionally, sequence supports the full page length.

## 7. Mode Register

| BA0<br>(A13) | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 |
|--------------|--------------|-----|-----|----|----|----|----|----|----|----|----|----|----|
| 0            | 0            | 0   | 0   | 0  | 0  | 1  |    |    |    |    |    |    |    |

JEDEC Standard Test Set (refresh counter test)

| BA0<br>(A13) | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5 | A4 | A3     | A2 | A1 | A0 |
|--------------|--------------|-----|-----|----|----|----|----|----|----|--------|----|----|----|
| x            | x            | x   | x   | 1  | 0  | 0  |    |    |    | LTMODE | WT |    | BL |

Burst Read and Single Write  
(for Write Through Cache)

| BA0<br>(A13) | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 |
|--------------|--------------|-----|-----|----|----|----|----|----|----|----|----|----|----|
|              |              |     |     |    | 1  | 0  |    |    |    |    |    |    |    |

Use in future

| BA0<br>(A13) | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5 | A4 | A3 | A2 | A1 | A0 |
|--------------|--------------|-----|-----|----|----|----|----|----|----|----|----|----|----|
| x            | x            | x   | x   | x  | 1  | 1  | V  | V  | V  | V  | V  | V  | V  |

Vender Specific

| BA0<br>(A13) | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5 | A4 | A3     | A2 | A1 | A0 |
|--------------|--------------|-----|-----|----|----|----|----|----|----|--------|----|----|----|
| 0            | 0            | 0   | 0   | 0  | 0  | 0  |    |    |    | LTMODE | WT |    | BL |

Mode Register Set

V = Valid  
x = Don't care

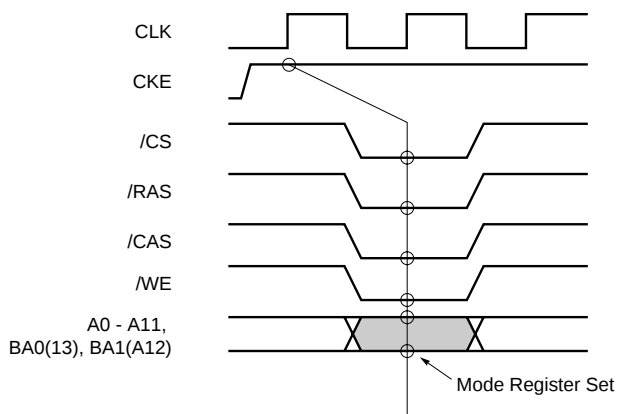
| Burst length | Bits2-0 | WT = 0    | WT = 1 |
|--------------|---------|-----------|--------|
|              | 000     | 1         | 1      |
|              | 001     | 2         | 2      |
|              | 010     | 4         | 4      |
|              | 011     | 8         | 8      |
|              | 100     | R         | R      |
|              | 101     | R         | R      |
|              | 110     | R         | R      |
|              | 111     | Full page | R      |

| Wrap type | 0 | Sequential |
|-----------|---|------------|
|           | 1 | Interleave |

| Latency mode | Bits6-4 | /CAS latency |
|--------------|---------|--------------|
|              | 000     | R            |
|              | 001     | R            |
|              | 010     | 2            |
|              | 011     | 3            |
|              | 100     | R            |
|              | 101     | R            |
|              | 110     | R            |
|              | 111     | R            |

Remark R : Reserved

### Mode Register Set Timing



## 7.1 Burst Length and Sequence

### [Burst of Two]

| Starting address<br>(column address A0, binary) | Sequential addressing sequence<br>(decimal) | Interleave addressing sequence<br>(decimal) |
|-------------------------------------------------|---------------------------------------------|---------------------------------------------|
| 0                                               | 0, 1                                        | 0, 1                                        |
| 1                                               | 1, 0                                        | 1, 0                                        |

### [Burst of Four]

| Starting address<br>(column address A1 - A0, binary) | Sequential addressing sequence<br>(decimal) | Interleave addressing sequence<br>(decimal) |
|------------------------------------------------------|---------------------------------------------|---------------------------------------------|
| 00                                                   | 0, 1, 2, 3                                  | 0, 1, 2, 3                                  |
| 01                                                   | 1, 2, 3, 0                                  | 1, 0, 3, 2                                  |
| 10                                                   | 2, 3, 0, 1                                  | 2, 3, 0, 1                                  |
| 11                                                   | 3, 0, 1, 2                                  | 3, 2, 1, 0                                  |

### [Burst of Eight]

| Starting address<br>(column address A2 - A0, binary) | Sequential addressing sequence<br>(decimal) | Interleave addressing sequence<br>(decimal) |
|------------------------------------------------------|---------------------------------------------|---------------------------------------------|
| 000                                                  | 0, 1, 2, 3, 4, 5, 6, 7                      | 0, 1, 2, 3, 4, 5, 6, 7                      |
| 001                                                  | 1, 2, 3, 4, 5, 6, 7, 0                      | 1, 0, 3, 2, 5, 4, 7, 6                      |
| 010                                                  | 2, 3, 4, 5, 6, 7, 0, 1                      | 2, 3, 0, 1, 6, 7, 4, 5                      |
| 011                                                  | 3, 4, 5, 6, 7, 0, 1, 2                      | 3, 2, 1, 0, 7, 6, 5, 4                      |
| 100                                                  | 4, 5, 6, 7, 0, 1, 2, 3                      | 4, 5, 6, 7, 0, 1, 2, 3                      |
| 101                                                  | 5, 6, 7, 0, 1, 2, 3, 4                      | 5, 4, 7, 6, 1, 0, 3, 2                      |
| 110                                                  | 6, 7, 0, 1, 2, 3, 4, 5                      | 6, 7, 4, 5, 2, 3, 0, 1                      |
| 111                                                  | 7, 0, 1, 2, 3, 4, 5, 6                      | 7, 6, 5, 4, 3, 2, 1, 0                      |

Full page burst is an extension of the above tables of sequential addressing, with the length being 2,048 (for 32M ×4 device), 1,024 (for 16M ×8 device), and 512 (for 8M ×16 device).

## 8. Address Bits of Bank-Select and Precharge

|                    |    |    |    |    |    |    |    |    |    |    |     |     |              |              |          |          |                                     |
|--------------------|----|----|----|----|----|----|----|----|----|----|-----|-----|--------------|--------------|----------|----------|-------------------------------------|
| Row                | A0 | A1 | A2 | A3 | A4 | A5 | A6 | A7 | A8 | A9 | A10 | A11 | BA1<br>(A12) | BA0<br>(A13) | BA1(A12) | BA0(A13) | Result                              |
| (Activate command) |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 0        | 0        | Select Bank A<br>"Activate" command |
|                    |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 0        | 1        | Select Bank B<br>"Activate" command |
|                    |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 1        | 0        | Select Bank C<br>"Activate" command |
|                    |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 1        | 1        | Select Bank D<br>"Activate" command |

|                     |    |    |    |    |    |    |    |    |    |    |     |     |              |              |     |          |          |                     |
|---------------------|----|----|----|----|----|----|----|----|----|----|-----|-----|--------------|--------------|-----|----------|----------|---------------------|
|                     | A0 | A1 | A2 | A3 | A4 | A5 | A6 | A7 | A8 | A9 | A10 | A11 | BA1<br>(A12) | BA0<br>(A13) | A10 | BA1(A12) | BA0(A13) | Result              |
| (Precharge command) |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 0   | 0        | 0        | Precharge Bank A    |
|                     |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 0   | 0        | 1        | Precharge Bank B    |
|                     |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 0   | 1        | 0        | Precharge Bank C    |
|                     |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 0   | 1        | 1        | Precharge Bank D    |
|                     |    |    |    |    |    |    |    |    |    |    |     |     |              |              | 1   | x        | x        | Precharge All Banks |

x : Don't care

|                |    |    |    |    |    |    |    |    |    |    |     |   |              |              |   |                                           |
|----------------|----|----|----|----|----|----|----|----|----|----|-----|---|--------------|--------------|---|-------------------------------------------|
| Col.           | A0 | A1 | A2 | A3 | A4 | A5 | A6 | A7 | A8 | A9 | A10 | x | BA1<br>(A12) | BA0<br>(A13) | 0 | disables Auto-Precharge<br>(End of Burst) |
| (/CAS strobes) |    |    |    |    |    |    |    |    |    |    |     |   |              |              | 1 | enables Auto-Precharge<br>(End of Burst)  |

|          |          |                                           |
|----------|----------|-------------------------------------------|
| BA1(A12) | BA0(A13) | Result                                    |
| 0        | 0        | enables Read/Write<br>commands for Bank A |
| 0        | 1        | enables Read/Write<br>commands for Bank B |
| 1        | 0        | enables Read/Write<br>commands for Bank C |
| 1        | 1        | enables Read/Write<br>commands for Bank D |

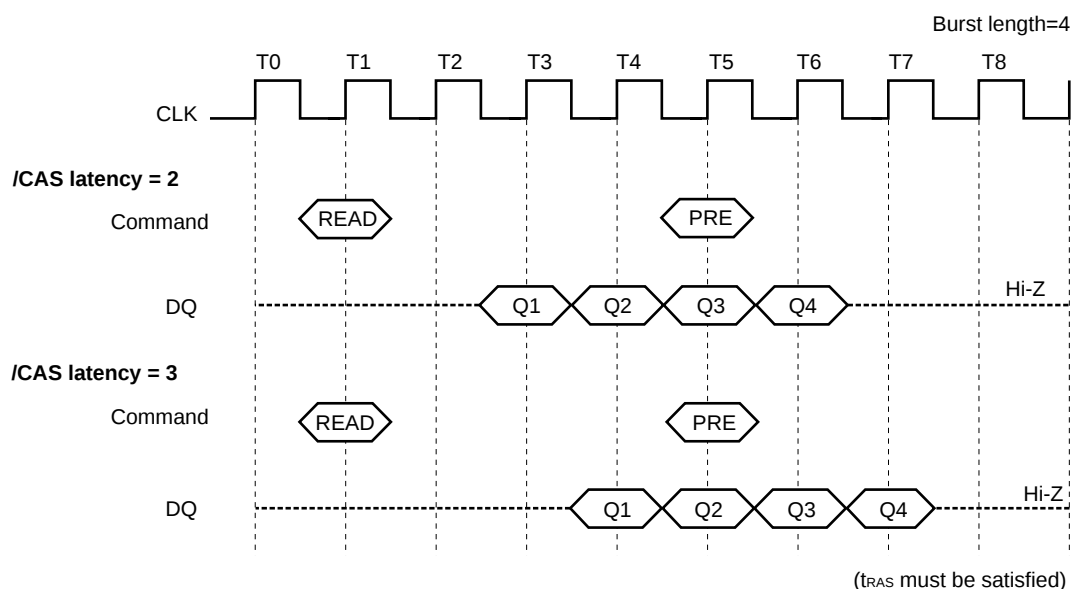
## 9. Precharge

The precharge command can be issued anytime after  $t_{RAS} (MIN.)$  is satisfied.

Soon after the precharge command is issued, precharge operation performed and the synchronous DRAM enters the idle state after  $t_{RP}$  is satisfied. The parameter  $t_{RP}$  is the time required to perform the precharge.

The earliest timing in a read cycle that a precharge command can be issued without losing any data in the burst is as follows.

It is depending on the /CAS latency and clock cycle time.



In order to write all data to the memory cell correctly, the asynchronous parameter “ $t_{DPL}$ ” must be satisfied. The  $t_{DPL} (MIN.)$  specification defines the earliest time that a precharge command can be issued. Minimum number of clocks is calculated by dividing  $t_{DPL} (MIN.)$  with clock cycle time.

In summary, the precharge command can be issued relative to reference clock that indicates the last data word is valid. In the following table, minus means clocks before the reference; plus means time after the reference.

| /CAS latency | Read | Write              |
|--------------|------|--------------------|
| 2            | -1   | + $t_{DPL} (MIN.)$ |
| 3            | -2   | + $t_{DPL} (MIN.)$ |

## 10. Auto Precharge

During a read or write command cycle, A10 controls whether auto precharge is selected. A10 high in the Read or Write command (Read with Auto precharge command or Write with Auto precharge command), auto precharge is selected and begins automatically.

The  $t_{RAS}$  must be satisfied with a read with auto precharge or a write with auto precharge operation. In addition, the next activate command to the bank being precharged cannot be executed until the precharge cycle ends.

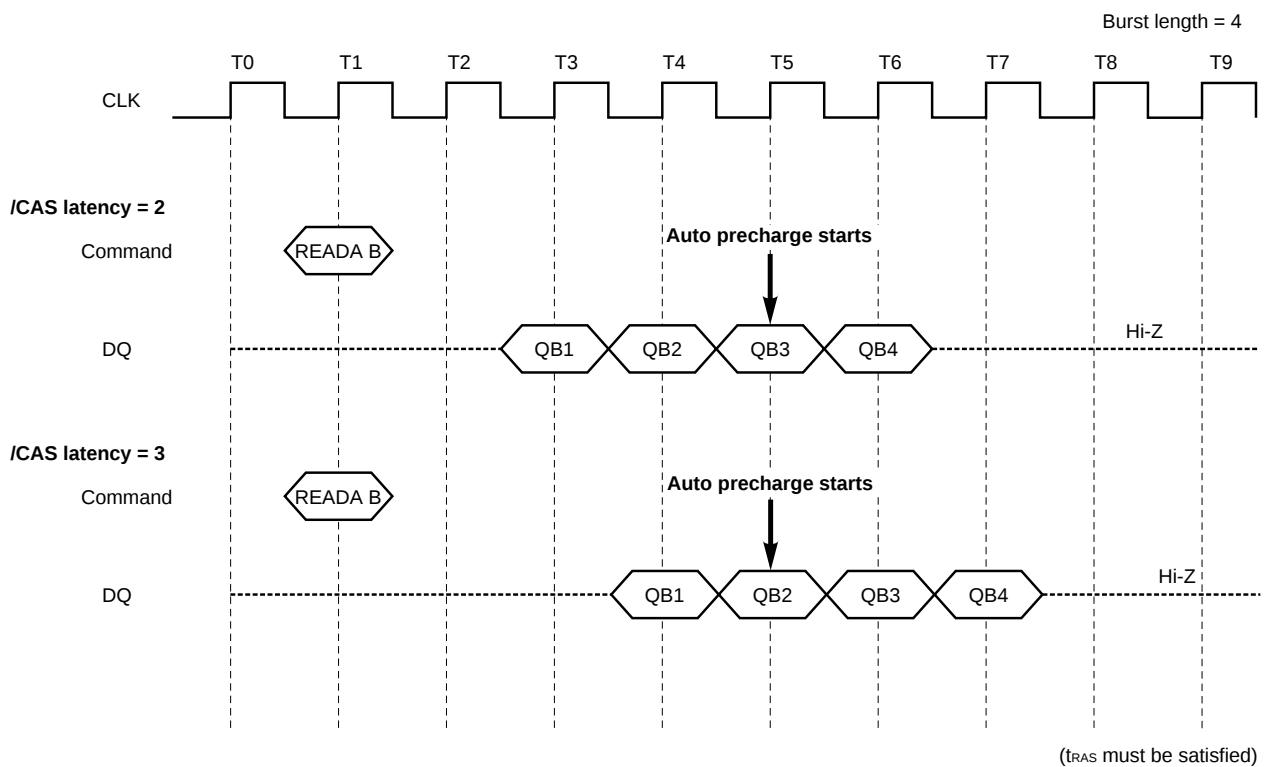
In read cycle, once auto precharge has started, an activate command to the bank can be issued after  $t_{RP}$  has been satisfied.

In write cycle, the  $t_{DAL}$  must be satisfied to issue the next activate command to the bank being precharged.

The timing that begins the auto precharge cycle depends on both the /CAS latency programmed into the mode register and whether read or write cycle.

### 10.1 Read with Auto Precharge

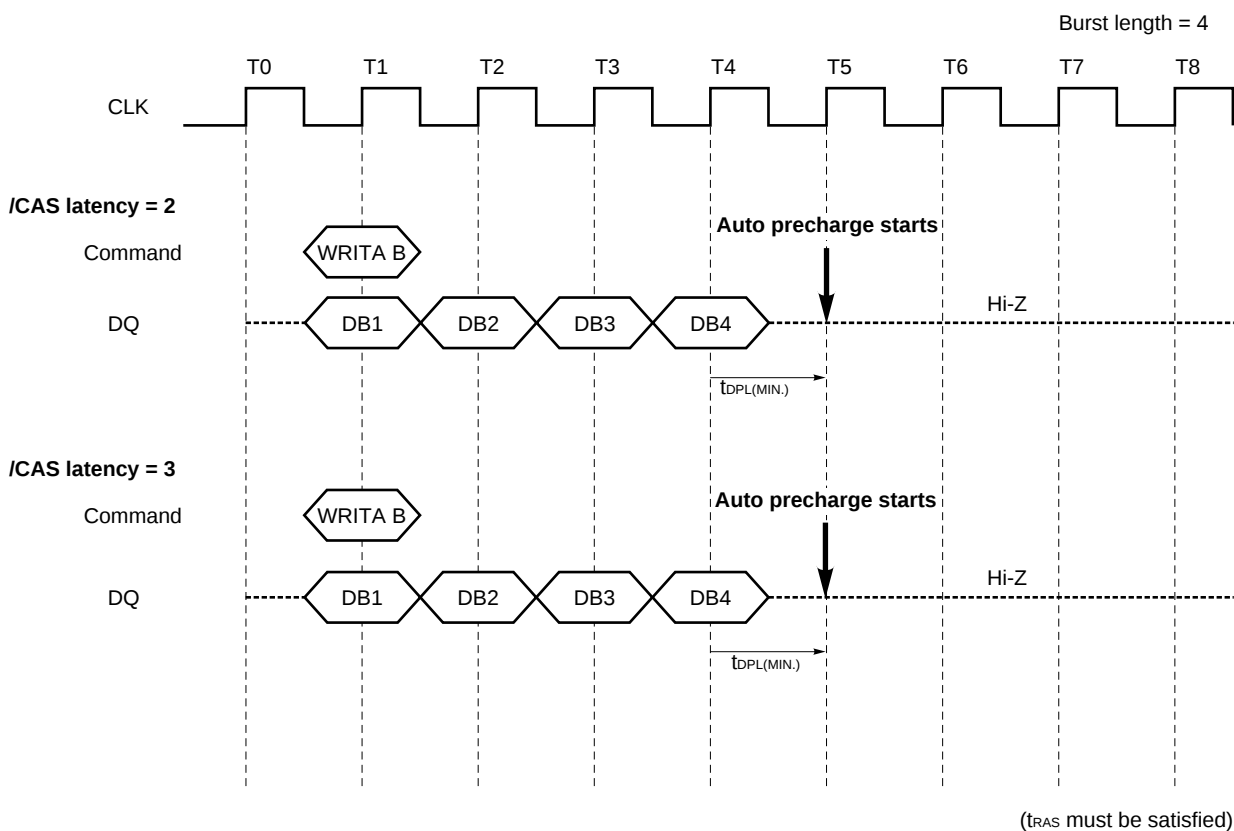
During a read cycle, the auto precharge begins one clock earlier (/CAS latency of 2) or two clocks earlier (/CAS latency of 3) the last data word output.



**Remark** READA means Read with Auto precharge

## 10.2 Write with Auto Precharge

During a write cycle, the auto precharge starts at the timing that is equal to the value of the  $t_{DPL} (MIN.)$  after the last data word input to the device.



**Remark** WRITA means Write with Auto Precharge

In summary, the auto precharge begins relative to a reference clock that indicates the last data word is valid. In the table below, minus means clocks before the reference; plus means after the reference.

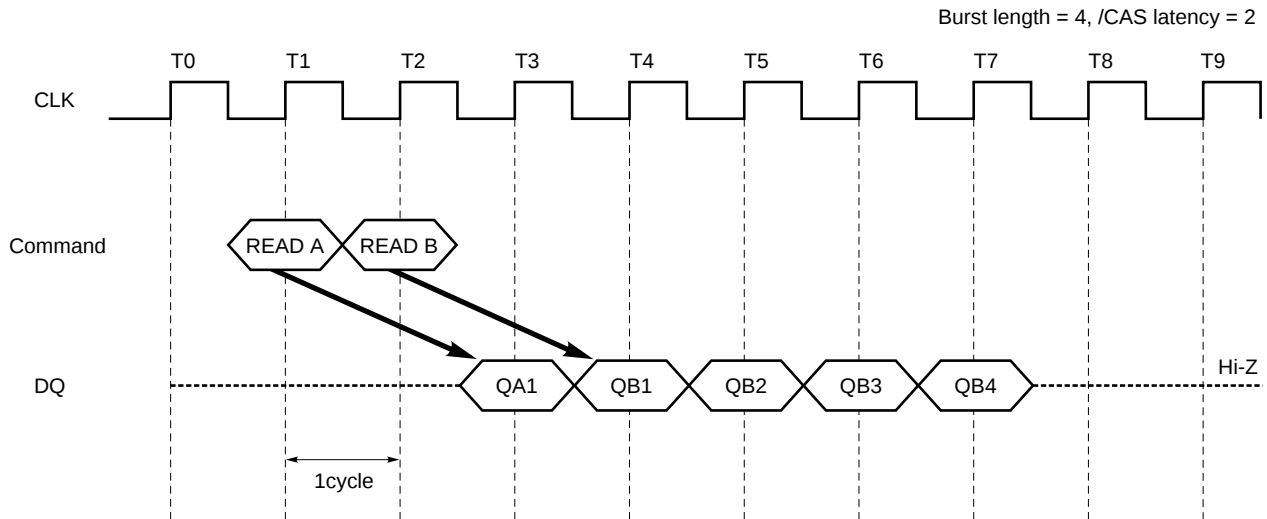
| /CAS latency | Read | Write             |
|--------------|------|-------------------|
| 2            | -1   | $+t_{DPL} (MIN.)$ |
| 3            | -2   | $+t_{DPL} (MIN.)$ |

## 11. Read / Write Command Interval

### 11.1 Read to Read Command Interval

During a read cycle, when new Read command is issued, it will be effective after /CAS latency, even if the previous read operation does not completed. READ will be interrupted by another READ.

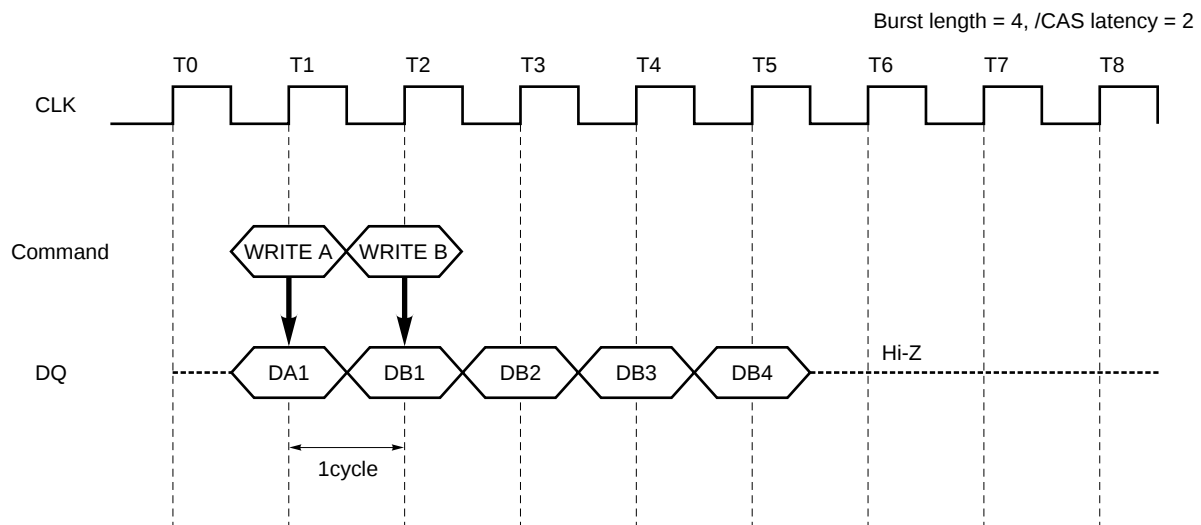
The interval between the commands is 1 cycle minimum. Each Read command can be issued in every clock without any restriction.



### 11.2 Write to Write Command Interval

During a write cycle, when a new Write command is issued, the previous burst will terminate and the new burst will begin with a new Write command. WRITE will be interrupted by another WRITE.

The interval between the commands is minimum 1 cycle. Each Write command can be issued in every clock without any restriction.

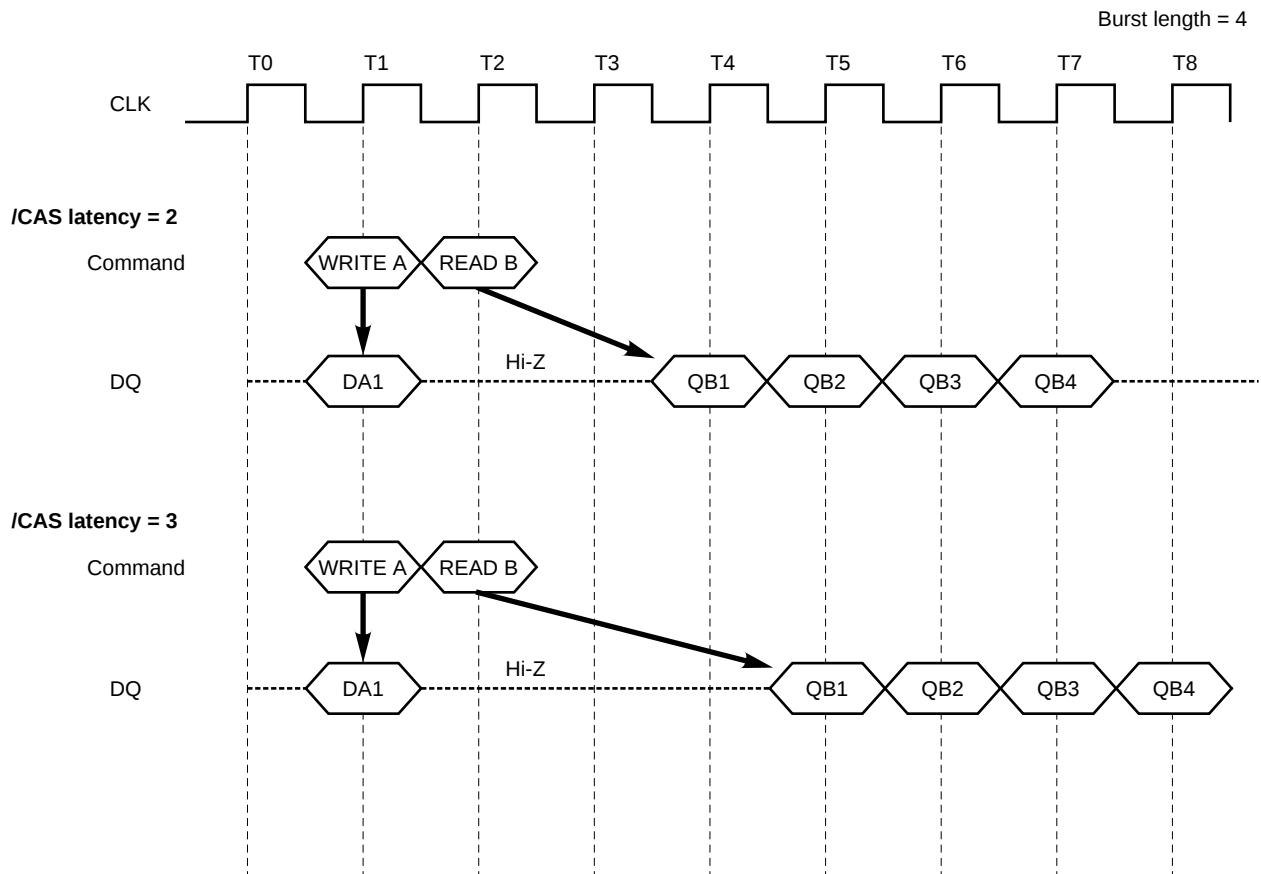


### 11.3 Write to Read Command Interval

Write command and Read command interval is also 1 cycle.

Only the write data before Read command will be written.

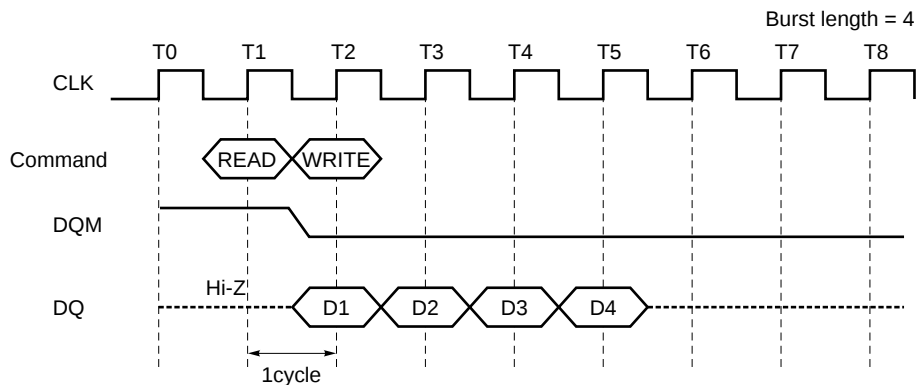
The data bus must be Hi-Z at least one cycle prior to the first D<sub>OUT</sub>.



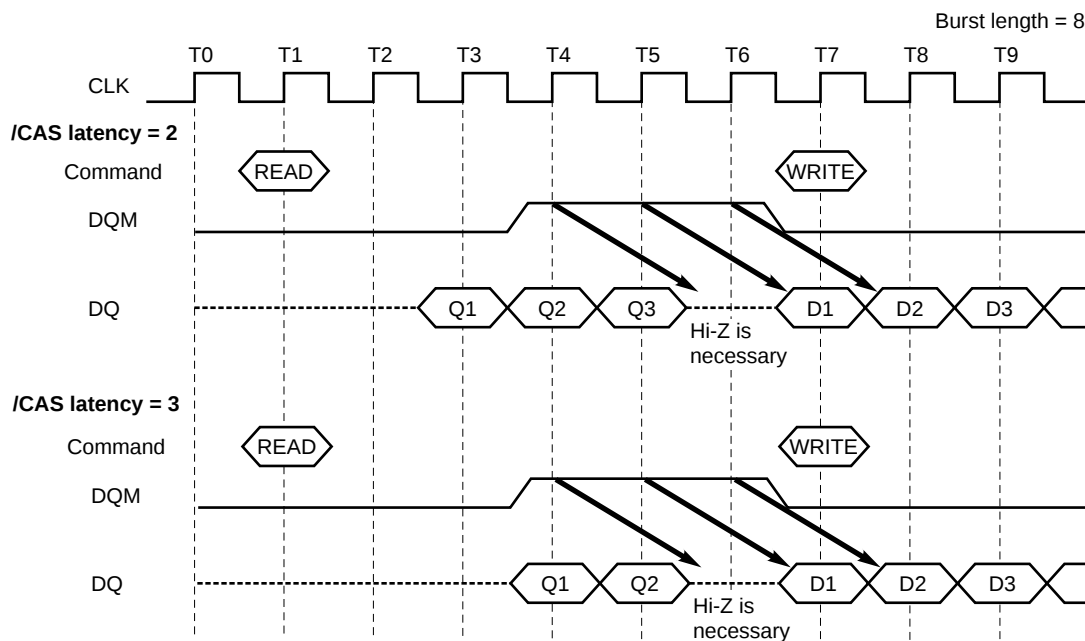
#### 11.4 Read to Write Command Interval

During a read cycle, READ can be interrupted by WRITE.

The Read and Write command interval is 1 cycle minimum. There is a restriction to avoid data conflict. The Data bus must be Hi-Z using DQM before WRITE.



READ can be interrupted by WRITE. DQM must be High at least 3 clocks prior to the Write command.

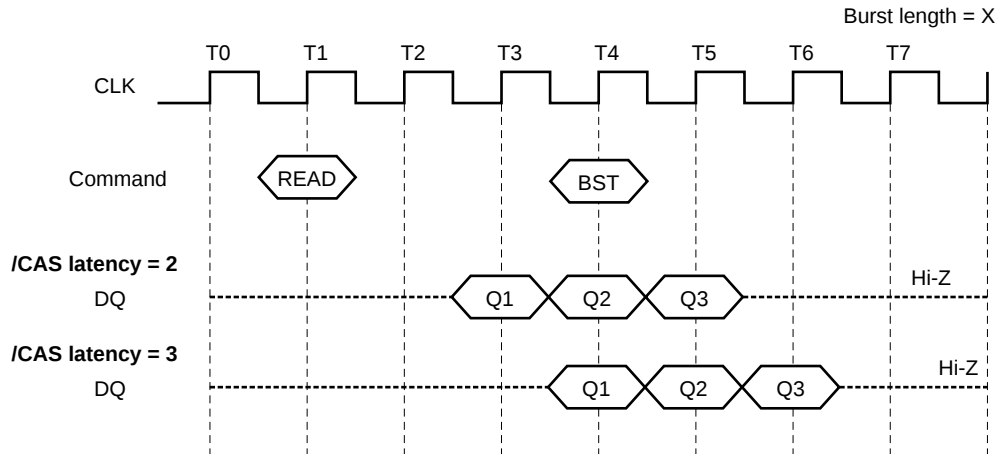


## 12. Burst Termination

There are two methods to terminate a burst operation other than using a Read or a Write command. One is the burst stop command and the other is the precharge command.

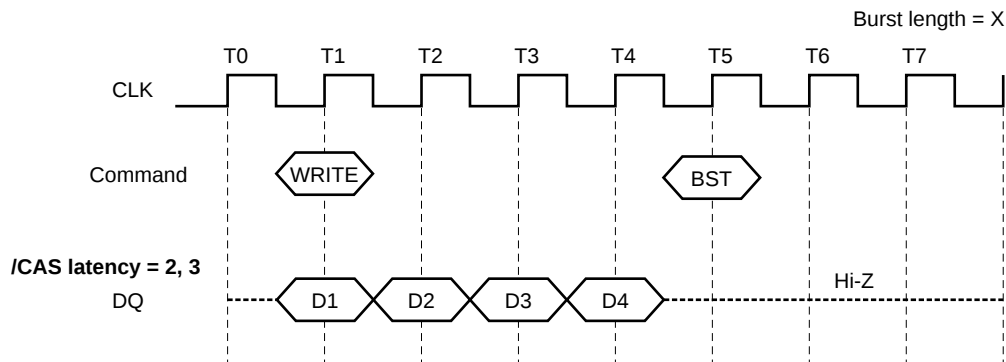
### 12.1 Burst Stop Command

During a read cycle, when the burst stop command is issued, the burst read data are terminated and the data bus goes to Hi-Z after the /CAS latency from the burst stop command.



**Remark** BST: Burst stop command

During a write cycle, when the burst stop command is issued, the burst write data are terminated and data bus goes to Hi-Z at the same clock with the burst stop command.



**Remark** BST: Burst stop command

## 12.2 Precharge Termination

### 12.2.1 Precharge Termination in READ Cycle

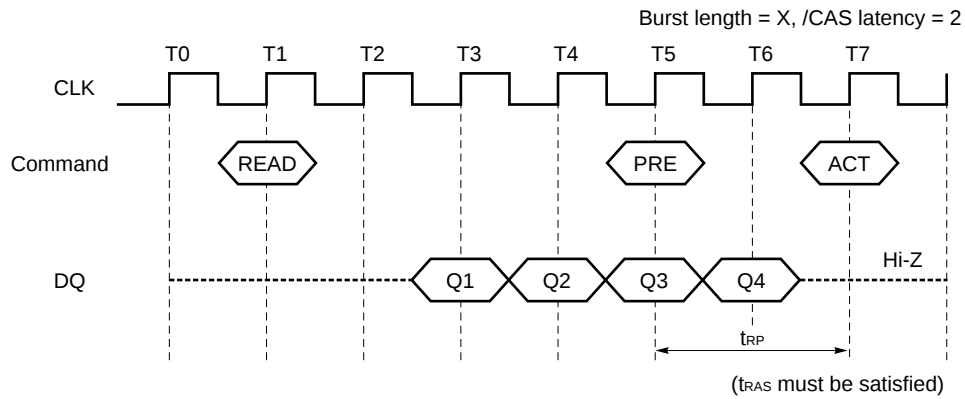
During a read cycle, the burst read operation is terminated by a precharge command.

When the precharge command is issued, the burst read operation is terminated and precharge starts.

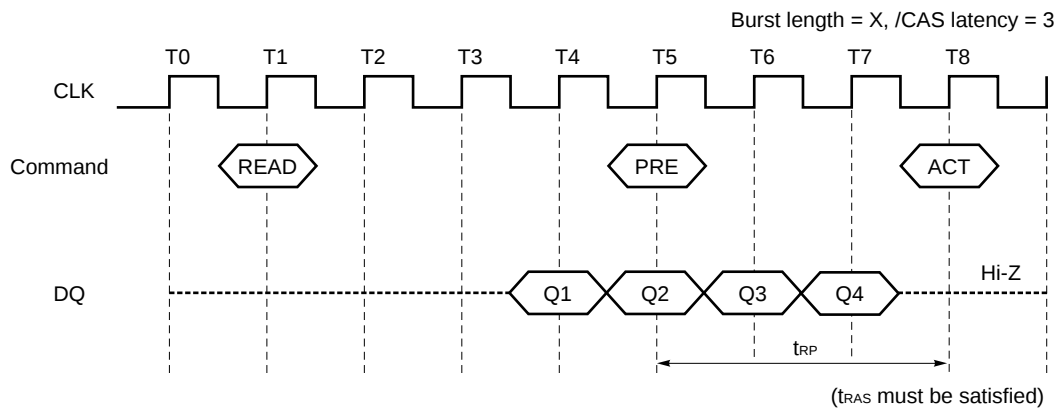
The same bank can be activated again after  $t_{RP}$  from the precharge command.

To issue a precharge command,  $t_{RAS}$  must be satisfied.

When /CAS latency is 2, the read data will remain valid until one clock after the precharge command.



When /CAS latency is 3, the read data will remain valid until two clocks after the precharge command.



### 12.2.2 Precharge Termination in WRITE Cycle

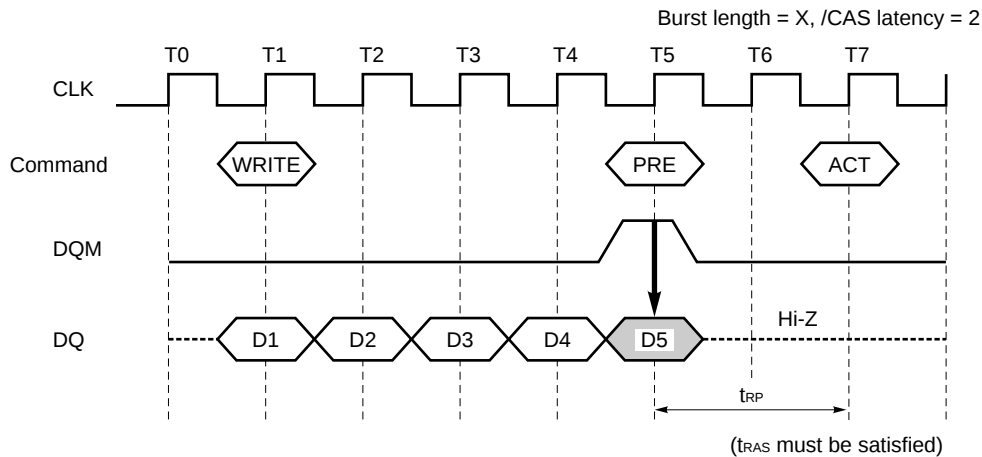
During a write cycle, the burst write operation is terminated by a precharge command.

When the precharge command is issued, the burst write operation is terminated and precharge starts.

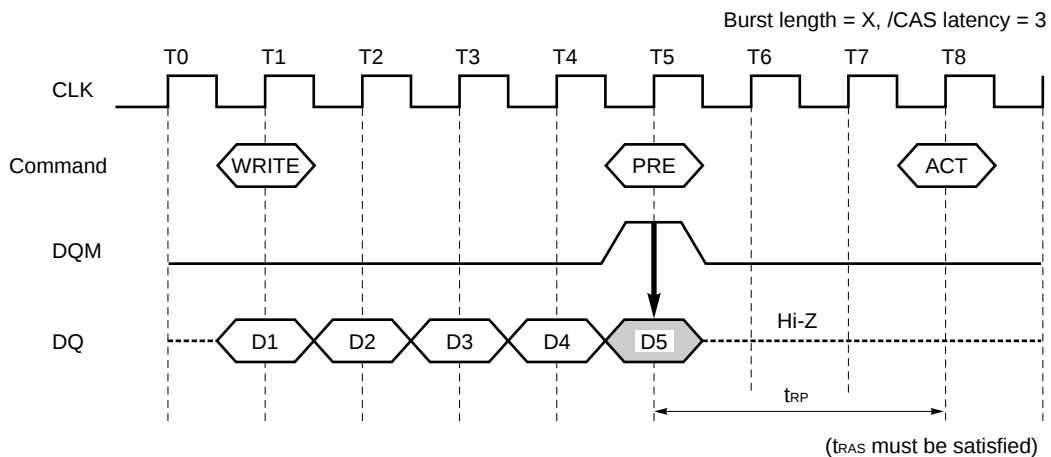
The same bank can be activated again after  $t_{RP}$  from the precharge command.

To issue a precharge command,  $t_{RAS}$  must be satisfied.

When /CAS latency is 2, the write data written prior to the precharge command will be correctly stored. However, invalid data may be written at the same clock as the precharge command. To prevent this from happening, DQM must be high at the same clock as the precharge command. This will mask the invalid data.



When /CAS latency is 3, the write data written prior to the precharge command will be correctly stored. However, invalid data may be written at the same clock as the precharge command. To prevent this from happening, DQM must be high at the same clock as the precharge command. This will mask the invalid data.



### 13. Electrical Specifications

- All voltages are referenced to V<sub>SS</sub> (GND).
- After power up, wait more than 100 μs and then, execute **Power on sequence and CBR (auto) Refresh** before proper device operation is achieved.

#### Absolute Maximum Ratings

| Parameter                                   | Symbol                             | Condition | Rating       | Unit |
|---------------------------------------------|------------------------------------|-----------|--------------|------|
| Voltage on power supply pin relative to GND | V <sub>CC</sub> , V <sub>CCQ</sub> |           | −0.5 to +4.6 | V    |
| Voltage on any pin relative to GND          | V <sub>T</sub>                     |           | −0.5 to +4.6 | V    |
| Short circuit output current                | I <sub>O</sub>                     |           | 50           | mA   |
| Power dissipation                           | P <sub>D</sub>                     |           | 1            | W    |
| Operating ambient temperature               | T <sub>A</sub>                     |           | 0 to 70      | °C   |
| Storage temperature                         | T <sub>stg</sub>                   |           | −55 to + 125 | °C   |

**Caution** Exposing the device to stress above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

#### Recommended Operating Conditions

| Parameter                     | Symbol                             | Condition | MIN.                  | TYP. | MAX.                                  | Unit |
|-------------------------------|------------------------------------|-----------|-----------------------|------|---------------------------------------|------|
| Supply voltage                | V <sub>CC</sub> , V <sub>CCQ</sub> |           | 3.0                   | 3.3  | 3.6                                   | V    |
| High level input voltage      | V <sub>IH</sub>                    |           | 2.0                   |      | V <sub>CC</sub> +0.3 <sup>Note1</sup> | V    |
| Low level input voltage       | V <sub>IL</sub>                    |           | −0.3 <sup>Note2</sup> |      | +0.8                                  | V    |
| Operating ambient temperature | T <sub>A</sub>                     |           | 0                     |      | 70                                    | °C   |

**Notes** 1. V<sub>IH</sub> (MAX.) = V<sub>CC</sub> + 1.5 V (Pulse width ≤ 5 ns)

2. V<sub>IL</sub> (MIN.) = −1.5 V (Pulse width ≤ 5 ns)

#### Pin Capacitance (T<sub>A</sub> = 25 °C, f = 1 MHz)

| Parameter                       | Symbol           | Condition                                                                | MIN. | TYP. | MAX. | Unit |
|---------------------------------|------------------|--------------------------------------------------------------------------|------|------|------|------|
| Input capacitance               | C <sub>I1</sub>  | CLK                                                                      | 2.5  |      | 3.5  | pF   |
|                                 | C <sub>I2</sub>  | A0 - A11, BA0(A13), BA1(A12), CKE, /CS, /RAS, /CAS, /WE, DQM, UDQM, LDQM | 2.5  |      | 3.8  |      |
| Data input / output capacitance | C <sub>I/O</sub> | DQ0 - DQ15                                                               | 4    |      | 6.5  | pF   |

DC Characteristics 1 (Recommended Operating Conditions unless otherwise noted)

| Parameter                                           | Symbol             | Test condition                                                                                                                             | /CAS<br>latency | Grade | Maximum |     |     | Unit | Notes |
|-----------------------------------------------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------|-----------------|-------|---------|-----|-----|------|-------|
|                                                     |                    |                                                                                                                                            |                 |       | ×4      | ×8  | ×16 |      |       |
| Operating current                                   | I <sub>CC1</sub>   | Burst length = 1,<br>t <sub>RC</sub> ≥ t <sub>RC (MIN.)</sub> , I <sub>O</sub> = 0 mA,<br>One bank active                                  | CL = 2          | -A75  | 100     | 100 | 110 | mA   | 1     |
|                                                     |                    |                                                                                                                                            |                 | -A80  | 100     | 100 | 110 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10  | 100     | 100 | 110 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10B | 90      | 100 | 110 |      |       |
|                                                     |                    |                                                                                                                                            | CL = 3          | -A75  | 105     | 105 | 115 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A80  | 100     | 100 | 110 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10  | 100     | 100 | 110 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10B | 95      | 100 | 110 |      |       |
| Precharge standby current<br>in power down mode     | I <sub>CC2P</sub>  | CKE ≤ V <sub>IL (MAX.)</sub> , t <sub>CK</sub> = 15 ns                                                                                     |                 |       | 1       | 1   | 1   | mA   |       |
|                                                     | I <sub>CC2PS</sub> | CKE ≤ V <sub>IL (MAX.)</sub> , t <sub>CK</sub> = ∞                                                                                         |                 |       | 1       | 1   | 1   |      |       |
| Precharge standby current<br>in non power down mode | I <sub>CC2N</sub>  | CKE ≥ V <sub>IH (MIN.)</sub> , t <sub>CK</sub> = 15 ns, /CS ≥ V <sub>IH (MIN.)</sub> ,<br>Input signals are changed one time during 30 ns. |                 |       | 20      | 20  | 20  | mA   |       |
|                                                     | I <sub>CC2NS</sub> | CKE ≥ V <sub>IH (MIN.)</sub> , t <sub>CK</sub> = ∞,<br>Input signals are stable.                                                           |                 |       | 8       | 8   | 8   |      |       |
| Active standby current<br>in power down mode        | I <sub>CC3P</sub>  | CKE ≤ V <sub>IL (MAX.)</sub> , t <sub>CK</sub> = 15 ns                                                                                     |                 |       | 5       | 5   | 5   | mA   |       |
|                                                     | I <sub>CC3PS</sub> | CKE ≤ V <sub>IL (MAX.)</sub> , t <sub>CK</sub> = ∞                                                                                         |                 |       | 4       | 4   | 4   |      |       |
| Active standby current<br>in non power down mode    | I <sub>CC3N</sub>  | CKE ≥ V <sub>IH (MIN.)</sub> , t <sub>CK</sub> = 15 ns, /CS ≥ V <sub>IH (MIN.)</sub> ,<br>Input signals are changed one time during 30 ns. |                 |       | 30      | 30  | 30  | mA   |       |
|                                                     | I <sub>CC3NS</sub> | CKE ≥ V <sub>IH (MIN.)</sub> , t <sub>CK</sub> = ∞ ,<br>Input signals are stable.                                                          |                 |       | 20      | 20  | 20  |      |       |
| Operating current<br>(Burst mode)                   | I <sub>CC4</sub>   | t <sub>CK</sub> ≥ t <sub>CK (MIN.)</sub> , I <sub>O</sub> = 0 mA,<br>All banks active                                                      | CL = 2          | -A75  | 105     | 120 | 145 | mA   | 2     |
|                                                     |                    |                                                                                                                                            |                 | -A80  | 105     | 120 | 145 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10  | 85      | 95  | 110 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10B | 75      | 85  | 100 |      |       |
|                                                     |                    |                                                                                                                                            | CL = 3          | -A75  | 140     | 155 | 185 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A80  | 130     | 145 | 175 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10  | 110     | 125 | 140 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10B | 110     | 125 | 140 |      |       |
| CBR (auto) refresh current                          | I <sub>CC5</sub>   | t <sub>RC</sub> ≥ t <sub>RC (MIN.)</sub>                                                                                                   | CL = 2          | -A75  | 230     | 230 | 230 | mA   | 3     |
|                                                     |                    |                                                                                                                                            |                 | -A80  | 230     | 230 | 230 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10  | 230     | 230 | 230 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10B | 220     | 220 | 220 |      |       |
|                                                     |                    |                                                                                                                                            | CL = 3          | -A75  | 240     | 240 | 240 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A80  | 230     | 230 | 230 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10  | 230     | 230 | 230 |      |       |
|                                                     |                    |                                                                                                                                            |                 | -A10B | 220     | 220 | 220 |      |       |
| Self refresh current                                | I <sub>CC6</sub>   | CKE ≤ 0.2 V                                                                                                                                |                 |       | 2       | 2   | 2   | mA   |       |

- Notes**
1. I<sub>CC1</sub> depends on output loading and cycle rates. Specified values are obtained with the output open. In addition to this, I<sub>CC1</sub> is measured condition that addresses are changed only one time during t<sub>CK</sub> (MIN.).
  2. I<sub>CC4</sub> depends on output loading and cycle rates. Specified values are obtained with the output open. In addition to this, I<sub>CC4</sub> is measured condition that addresses are changed only one time during t<sub>CK</sub> (MIN.).
  3. I<sub>CC5</sub> is measured on condition that addresses are changed only one time during t<sub>CK</sub> (MIN.).

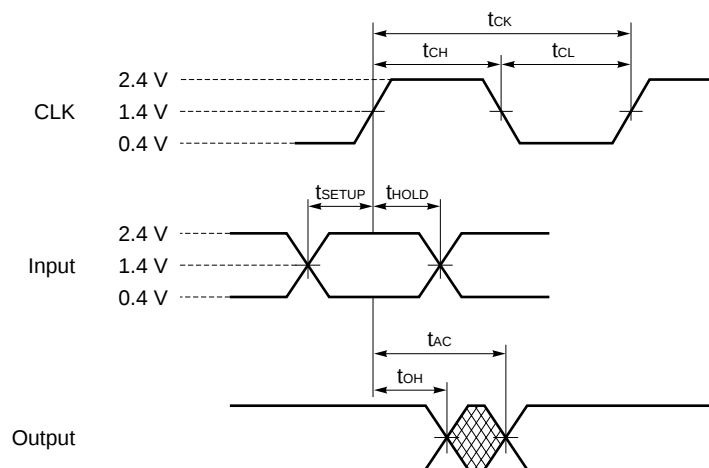
**DC Characteristics 2 (Recommended Operating Conditions unless otherwise noted)**

| Parameter                 | Symbol     | Test condition                                                                        | MIN. | TYP. | MAX. | Unit | Note |
|---------------------------|------------|---------------------------------------------------------------------------------------|------|------|------|------|------|
| Input leakage current     | $I_{I(L)}$ | $0 \leq V_i \leq V_{CCQ}$ , $V_{CCQ} = V_{CC}$<br>All other pins not under test = 0 V | -1.0 |      | +1.0 | μA   |      |
| Output leakage current    | $I_{O(L)}$ | $0 \leq V_o \leq V_{CCQ}$ , $D_{OUT}$ is disabled                                     | -1.5 |      | +1.5 | μA   |      |
| High level output voltage | $V_{OH}$   | $I_o = -4$ mA                                                                         | 2.4  |      |      | V    |      |
| Low level output voltage  | $V_{OL}$   | $I_o = +4$ mA                                                                         |      |      | 0.4  | V    |      |

**AC Characteristics (Recommended Operating Conditions unless otherwise noted)**

**Test Conditions**

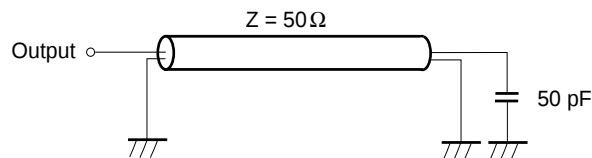
| Parameter                                             | Value     | Unit |
|-------------------------------------------------------|-----------|------|
| AC high level input voltage / low level input voltage | 2.4 / 0.4 | V    |
| Input timing measurement reference level              | 1.4       | V    |
| Transition time (Input rise and fall time)            | 1         | ns   |
| Output timing measurement reference level             | 1.4       | V    |



# Synchronous Characteristics

| Parameter                                      |                  | Symbol            | -A75 |           | -A80 |           | -A10 |           | -A10B |           | Unit | Note |
|------------------------------------------------|------------------|-------------------|------|-----------|------|-----------|------|-----------|-------|-----------|------|------|
|                                                |                  |                   | MIN. | MAX.      | MIN. | MAX.      | MIN. | MAX.      | MIN.  | MAX.      |      |      |
| Clock cycle time                               | /CAS latency = 3 | t <sub>CK3</sub>  | 7.5  | (133 MHz) | 8    | (125 MHz) | 10   | (100 MHz) | 10    | (100 MHz) | ns   |      |
|                                                | /CAS latency = 2 | t <sub>CK2</sub>  | 10   | (100 MHz) | 10   | (100 MHz) | 13   | (77 MHz)  | 15    | (67 MHz)  | ns   |      |
| Access time from CLK                           | /CAS latency = 3 | t <sub>AC3</sub>  |      | 5.4       |      | 6         |      | 6         |       | 7         | ns   | 1    |
|                                                | /CAS latency = 2 | t <sub>AC2</sub>  |      | 6         |      | 6         |      | 7         |       | 8         | ns   | 1    |
| CLK high level width                           |                  | t <sub>CH</sub>   | 2.5  |           | 3    |           | 3    |           | 3.5   |           | ns   |      |
| CLK low level width                            |                  | t <sub>CL</sub>   | 2.5  |           | 3    |           | 3    |           | 3.5   |           | ns   |      |
| Data-out hold time                             |                  | t <sub>OH</sub>   | 3    |           | 3    |           | 3    |           | 3     |           | ns   | 1    |
| Data-out low-impedance time                    |                  | t <sub>LZ</sub>   | 0    |           | 0    |           | 0    |           | 0     |           | ns   |      |
| Data-out high-impedance time                   | /CAS latency = 3 | t <sub>HZ3</sub>  | 3    | 5.4       | 3    | 6         | 3    | 6         | 3     | 7         | ns   |      |
|                                                | /CAS latency = 2 | t <sub>HZ2</sub>  | 3    | 6         | 3    | 6         | 3    | 7         | 3     | 8         | ns   |      |
| Data-in setup time                             |                  | t <sub>DS</sub>   | 1.5  |           | 2    |           | 2    |           | 2.5   |           | ns   |      |
| Data-in hold time                              |                  | t <sub>DH</sub>   | 0.8  |           | 1    |           | 1    |           | 1     |           | ns   |      |
| Address setup time                             |                  | t <sub>AS</sub>   | 1.5  |           | 2    |           | 2    |           | 2.5   |           | ns   |      |
| Address hold time                              |                  | t <sub>AH</sub>   | 0.8  |           | 1    |           | 1    |           | 1     |           | ns   |      |
| CKE setup time                                 |                  | t <sub>CKS</sub>  | 1.5  |           | 2    |           | 2    |           | 2.5   |           | ns   |      |
| CKE hold time                                  |                  | t <sub>CKH</sub>  | 0.8  |           | 1    |           | 1    |           | 1     |           | ns   |      |
| CKE setup time (Power down exit)               |                  | t <sub>CKSP</sub> | 1.5  |           | 2    |           | 2    |           | 2.5   |           | ns   |      |
| Command (/CS, /RAS, /CAS, /WE, DQM) setup time |                  | t <sub>CMS</sub>  | 1.5  |           | 2    |           | 2    |           | 2.5   |           | ns   |      |
| Command (/CS, /RAS, /CAS, /WE, DQM) hold time  |                  | t <sub>CMH</sub>  | 0.8  |           | 1    |           | 1    |           | 1     |           | ns   |      |

**Note 1.** Output load

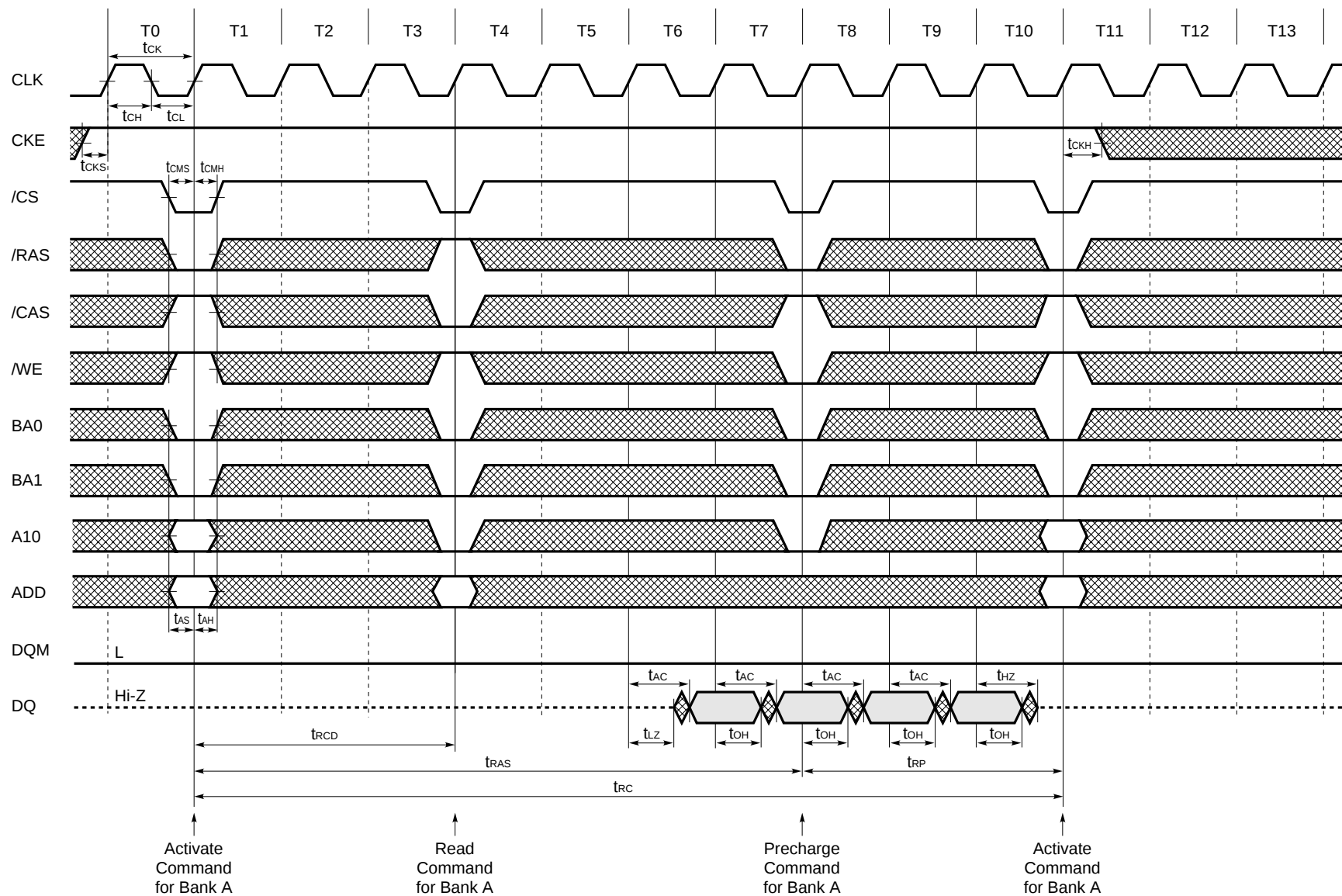


# Asynchronous Characteristics

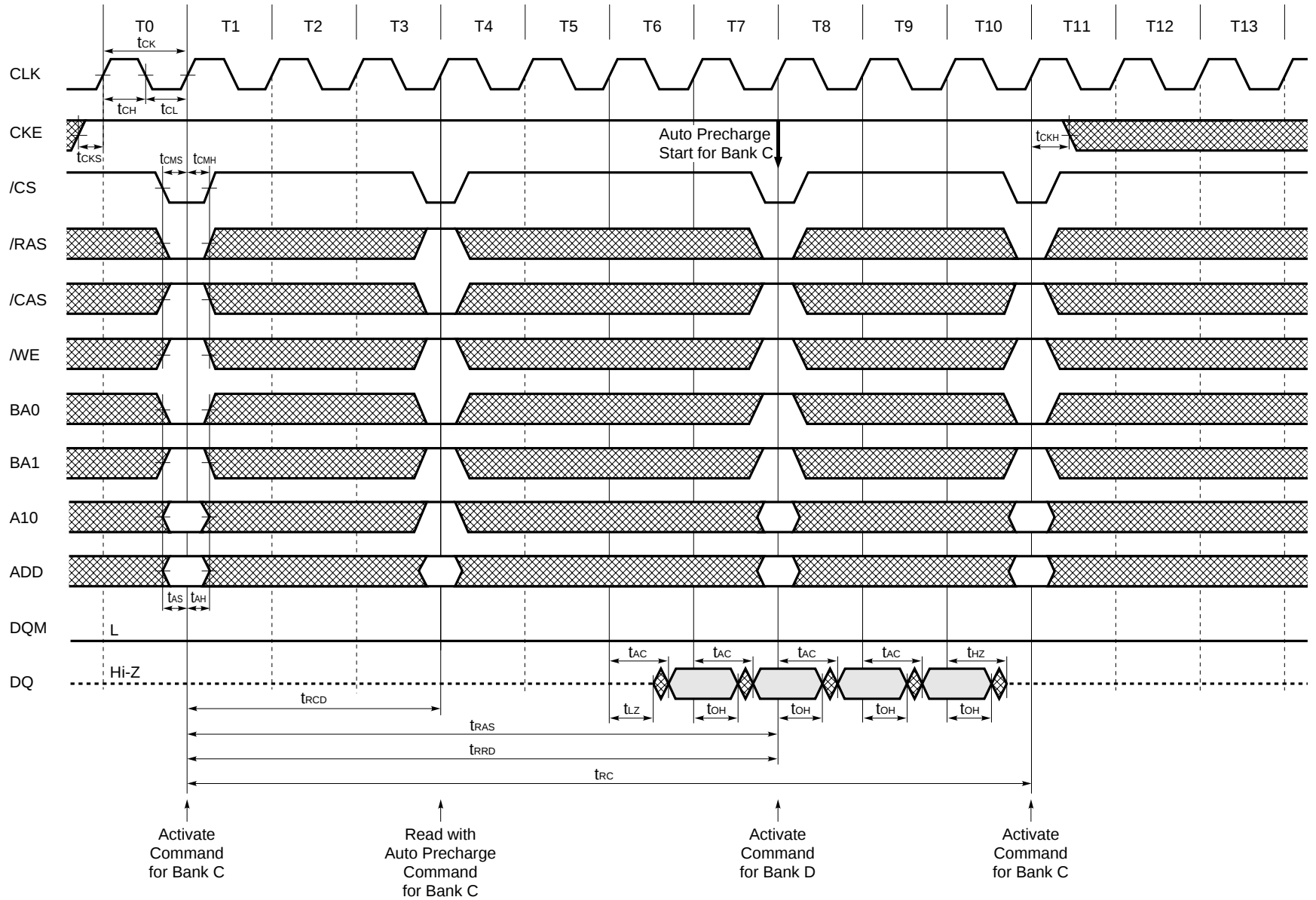
| Parameter                                            | Symbol           | -A75              |            | -A80     |         | -A10     |         | -A10B    |         | Unit | Note |
|------------------------------------------------------|------------------|-------------------|------------|----------|---------|----------|---------|----------|---------|------|------|
|                                                      |                  | MIN.              | MAX.       | MIN.     | MAX.    | MIN.     | MAX.    | MIN.     | MAX.    |      |      |
| ACT to REF/ACT command period (operation)            | t <sub>RC</sub>  | 67.5              |            | 70       |         | 70       |         | 90       |         | ns   |      |
| REF to REF/ACT command period (refresh)              | t <sub>RC1</sub> | 67.5              |            | 70       |         | 70       |         | 90       |         | ns   |      |
| ACT to PRE command period                            | t <sub>RAS</sub> | 45                | 120,000    | 48       | 120,000 | 50       | 120,000 | 60       | 120,000 | ns   |      |
| PRE to ACT command period                            | t <sub>RP</sub>  | 20                |            | 20       |         | 20       |         | 30       |         | ns   |      |
| Delay time ACT to READ/WRITE command                 | t <sub>RCD</sub> | 20                |            | 20       |         | 20       |         | 30       |         | ns   |      |
| ACT (one) to ACT (another) command period            | t <sub>RRD</sub> | 15                |            | 16       |         | 20       |         | 20       |         | ns   |      |
| Data-in to PRE command period                        | t <sub>DPL</sub> | 8                 |            | 8        |         | 10       |         | 10       |         | ns   |      |
| Data-in to ACT (REF) command period (Auto precharge) | /CAS latency = 3 | t <sub>DAL3</sub> | 1CLK +22.5 | 1CLK +20 |         | 1CLK +20 |         | 1CLK +30 |         | ns   | 1    |
|                                                      | /CAS latency = 2 | t <sub>DAL2</sub> | 1CLK +20   | 1CLK +20 |         | 1CLK +20 |         | 1CLK +30 |         | ns   |      |
| Mode register set cycle time                         | t <sub>RSC</sub> | 2                 |            | 2        |         | 2        |         | 2        |         | CLK  |      |
| Transition time                                      | t <sub>T</sub>   | 0.5               | 30         | 0.5      | 30      | 1        | 30      | 1        | 30      | ns   |      |
| Refresh time (4,096 refresh cycles)                  | t <sub>REF</sub> |                   | 64         |          | 64      |          | 64      |          | 64      | ms   |      |

**Note 1.** The -A75 grade device can satisfy the t<sub>DAL3</sub> spec of 1CLK+20 ns for up to and including 125MHz operation.

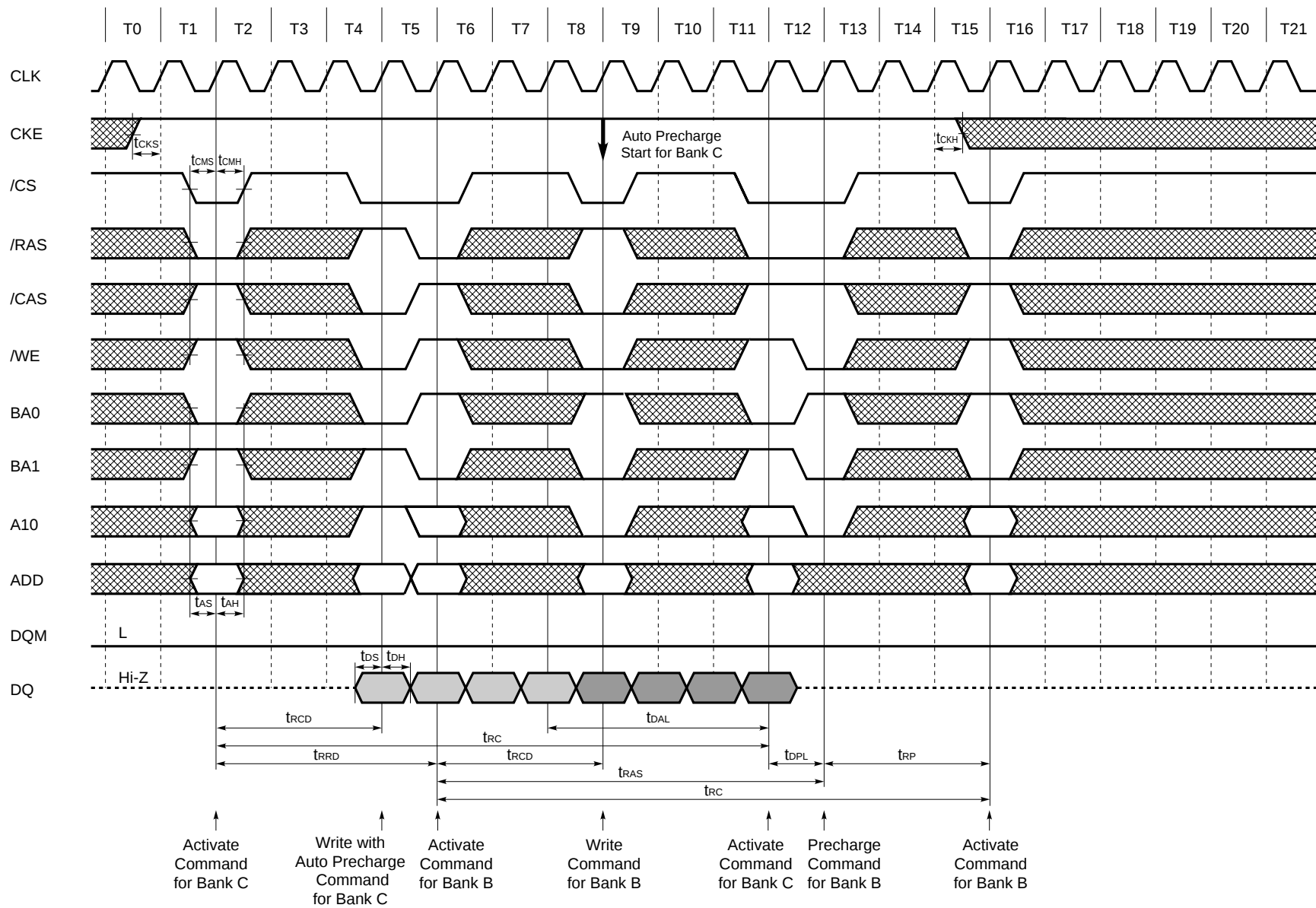
### 13.1 AC Parameters for Read Timing (Manual Precharge, Burst Length = 4, /CAS Latency = 3)



AC Parameters for Read Timing (Auto Precharge, Burst Length = 4, /CAS Latency = 3)



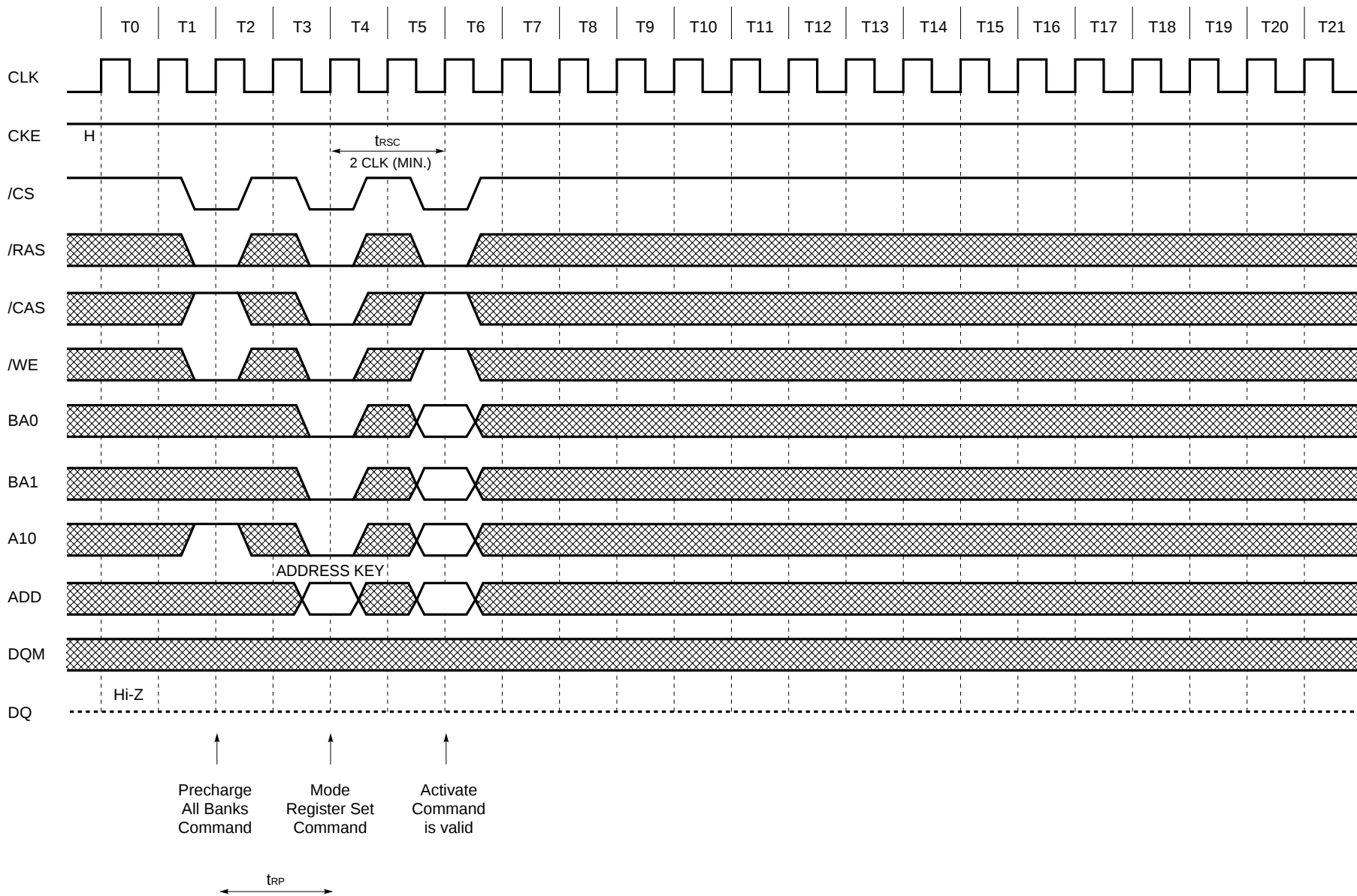
### 13.2 AC Parameters for Write Timing (Burst Length = 4, /CAS Latency = 3)



### 13.3 Relationship between Frequency and Latency

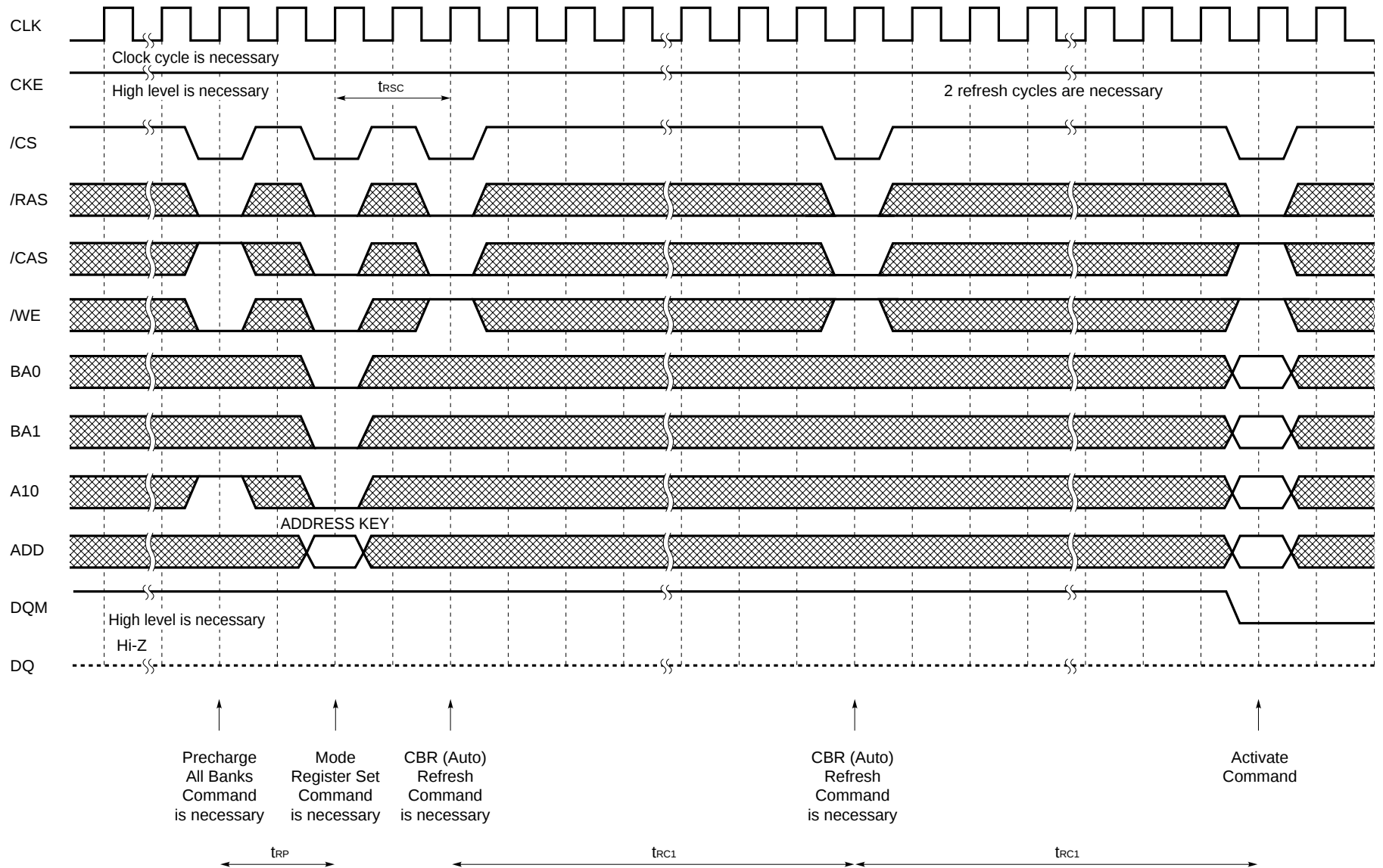
| Speed version                        | -75 |     | -80 |     | -10 |    | -10B |    |
|--------------------------------------|-----|-----|-----|-----|-----|----|------|----|
| Clock cycle time [ns]                | 7.5 | 10  | 8   | 10  | 10  | 13 | 10   | 15 |
| Frequency [MHz]                      | 133 | 100 | 125 | 100 | 100 | 77 | 100  | 67 |
| /CAS latency                         | 3   | 2   | 3   | 2   | 3   | 2  | 3    | 2  |
| [trcd]                               | 3   | 2   | 3   | 2   | 2   | 2  | 3    | 2  |
| /RAS latency (/CAS latency + [trcd]) | 6   | 4   | 6   | 4   | 5   | 4  | 6    | 4  |
| [trc]                                | 9   | 7   | 9   | 7   | 7   | 6  | 9    | 6  |
| [trc1]                               | 9   | 7   | 9   | 7   | 8   | 6  | 9    | 6  |
| [tras]                               | 6   | 5   | 6   | 5   | 5   | 4  | 6    | 4  |
| [trrd]                               | 2   | 2   | 2   | 2   | 2   | 2  | 2    | 2  |
| [trp]                                | 3   | 2   | 3   | 2   | 2   | 2  | 3    | 2  |
| [tdpl]                               | 2   | 1   | 1   | 1   | 1   | 1  | 1    | 1  |
| [tdal]                               | 4   | 3   | 4   | 3   | 3   | 3  | 4    | 3  |
| [trsc]                               | 2   | 2   | 2   | 2   | 2   | 2  | 2    | 2  |

### 13.4 Mode Register Set (Burst Length = 4, /CAS Latency = 2)



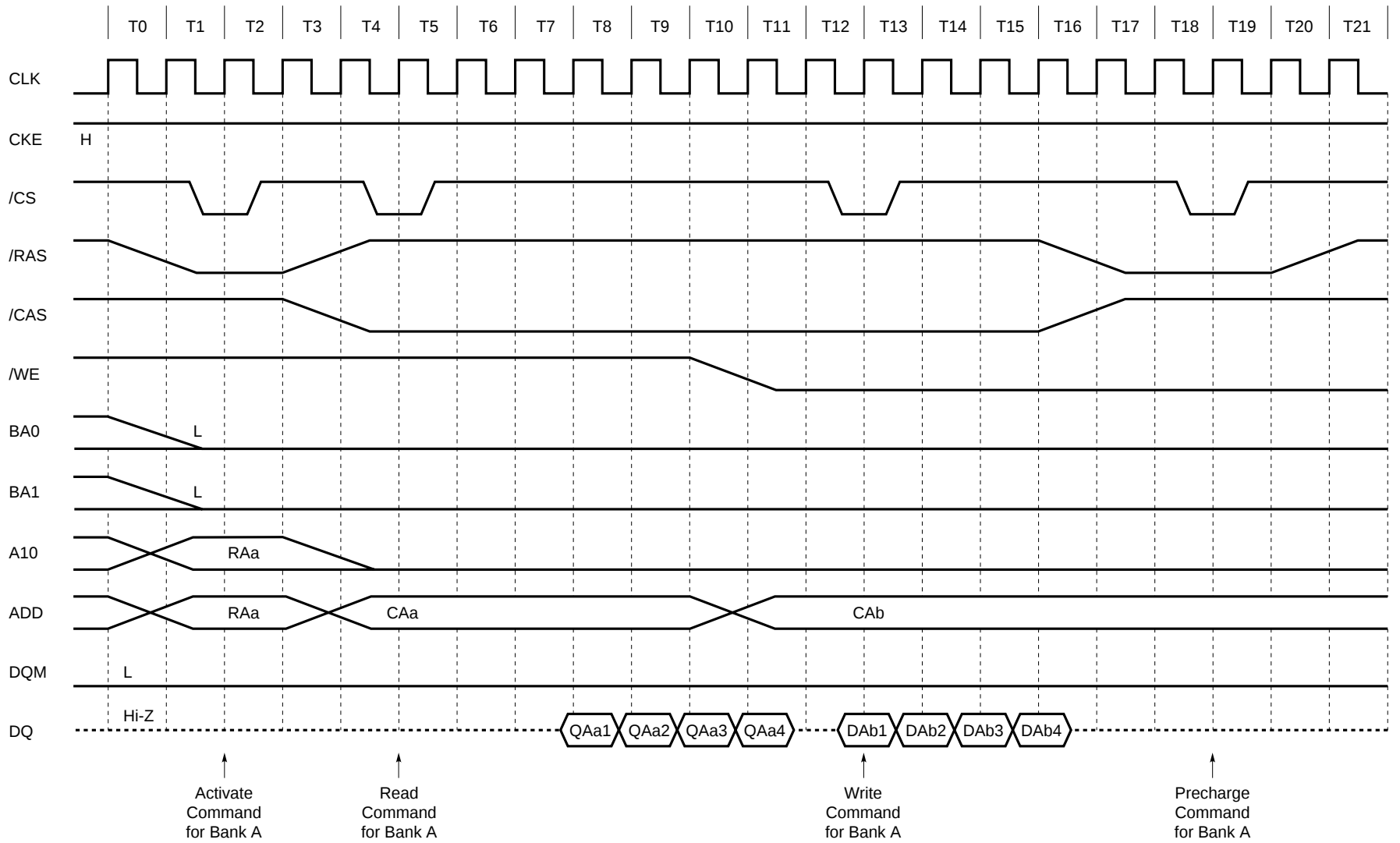
#### 44 13.5 Power On Sequence and CBR (Auto) Refresh

Data Sheet M12650EJBY0DS00

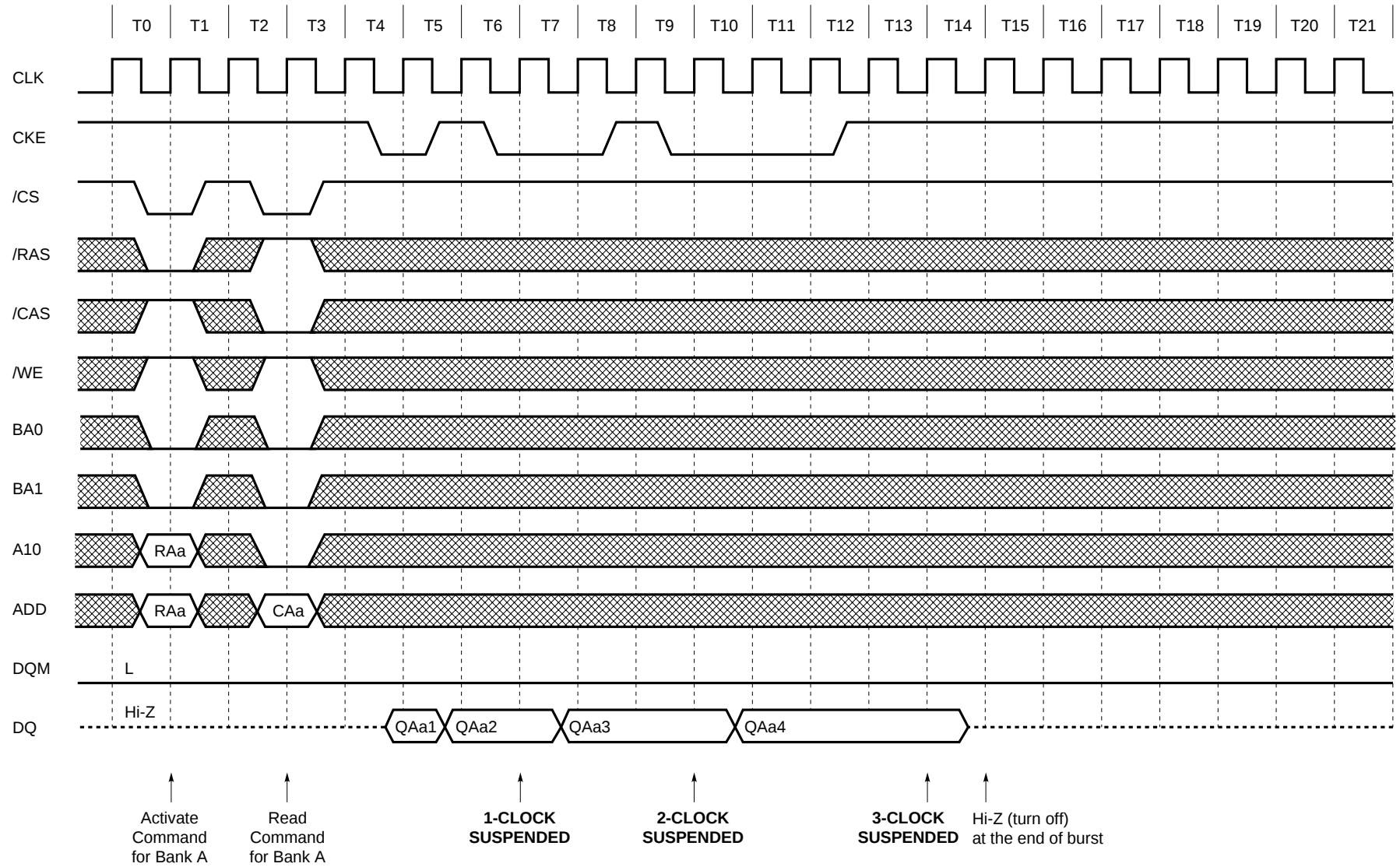


### 13.6 /CS Function (Burst Length = 4, /CAS Latency = 3)

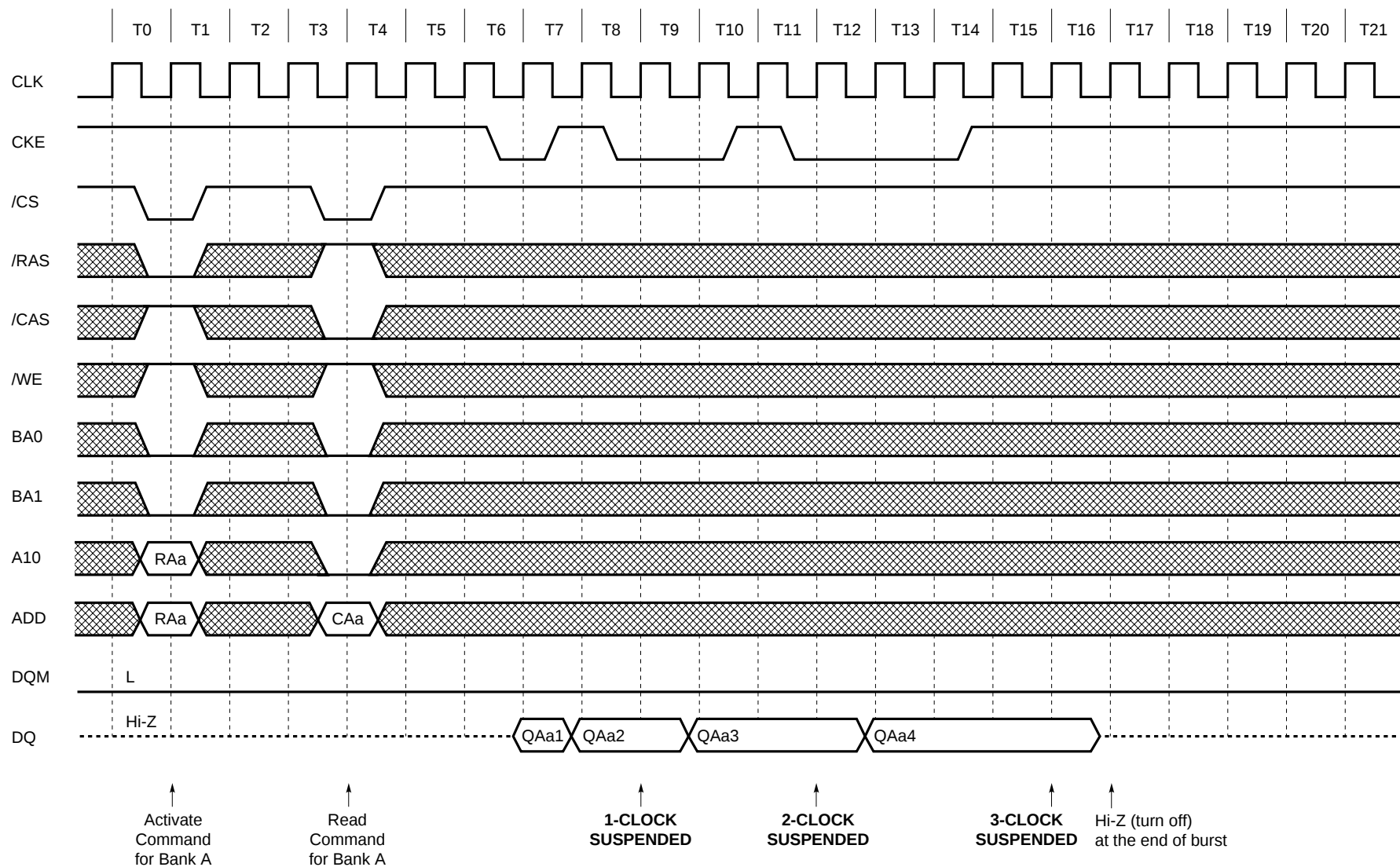
Only /CS signal needs to be issued at minimum rate



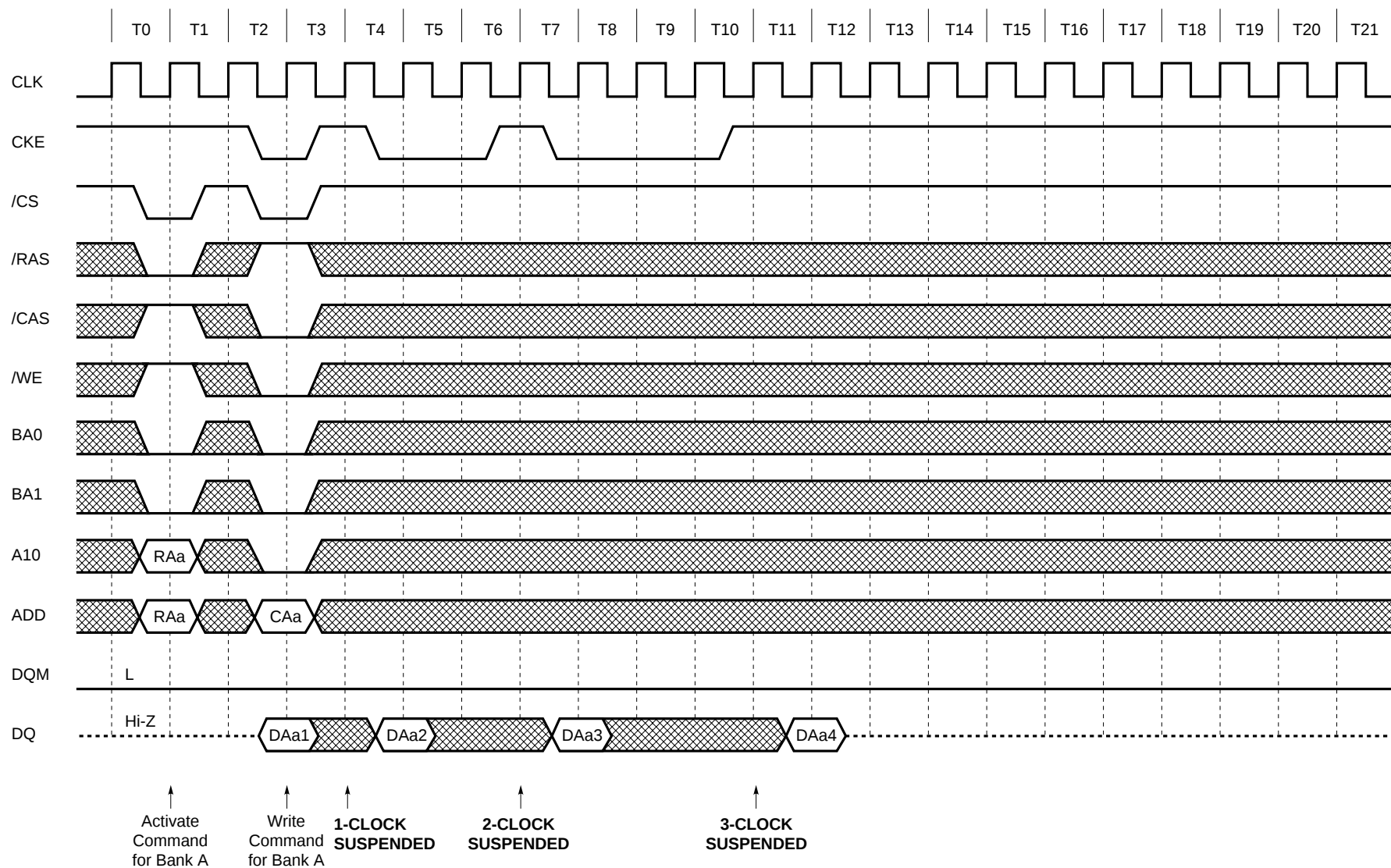
### 13.7 Clock Suspension during Burst Read (using CKE Function) (1/2) (Burst Length = 4, /CAS Latency = 2)



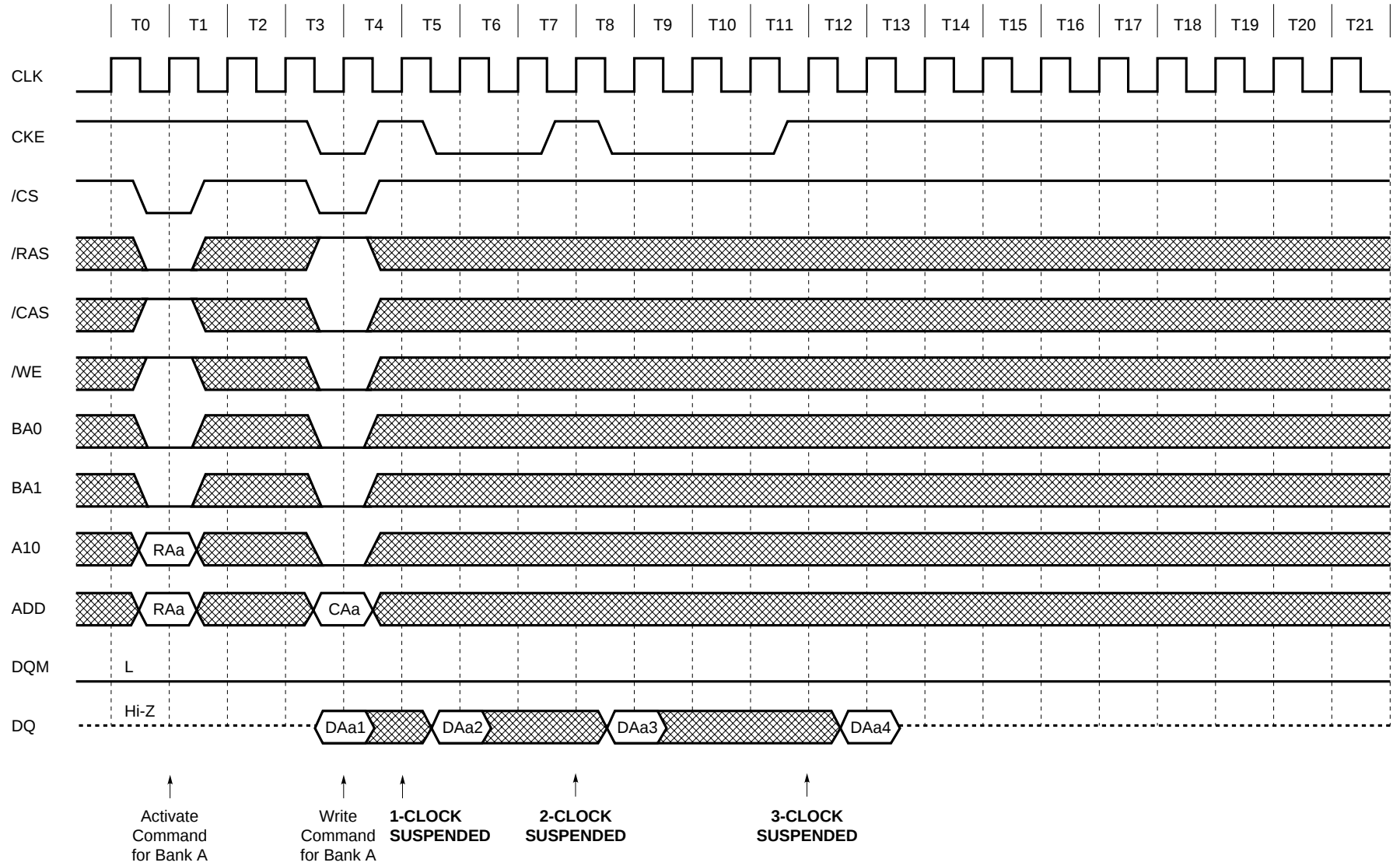
Clock Suspension during Burst Read (using CKE Function) (2/2) (Burst Length = 4, /CAS Latency = 3)



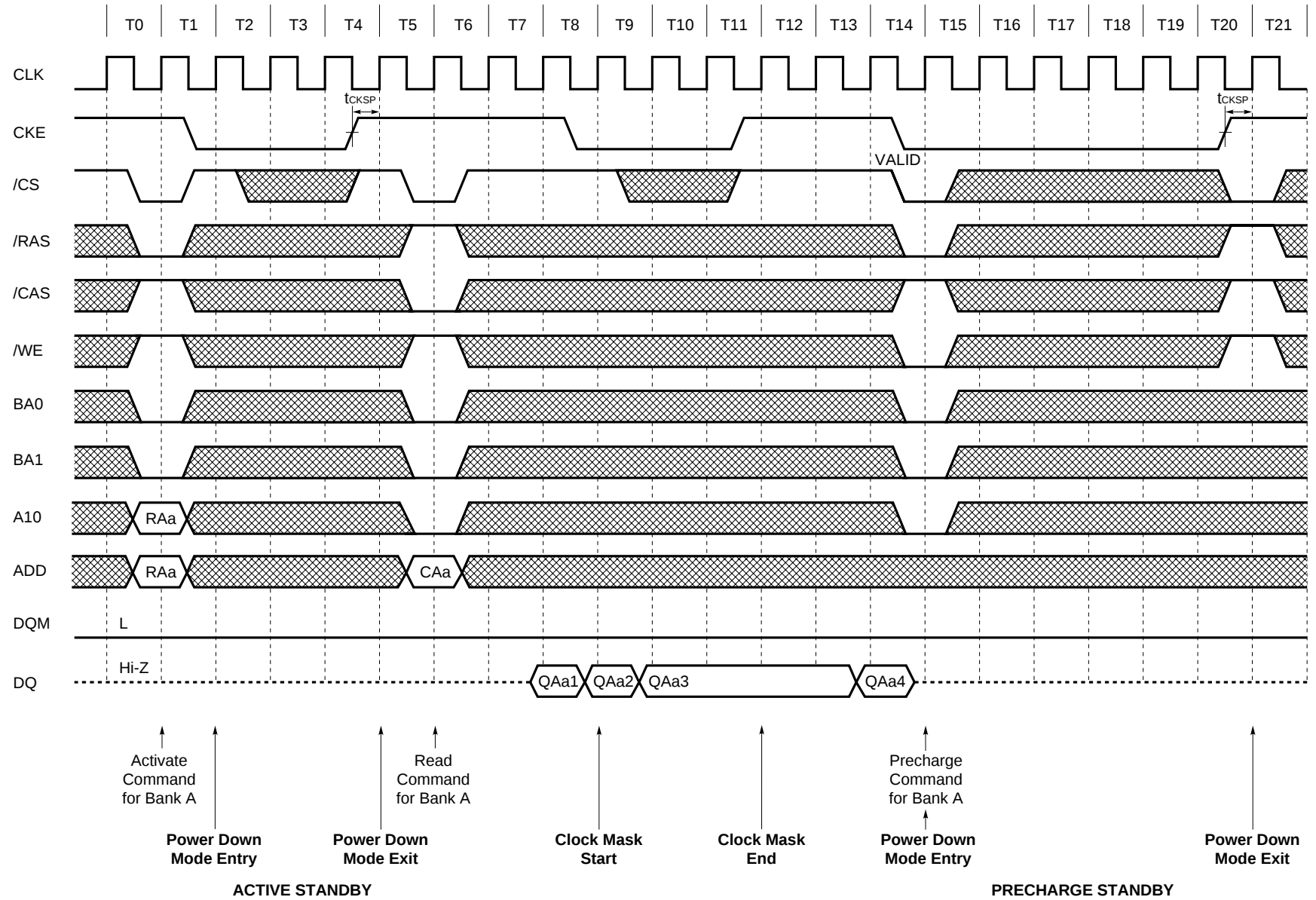
### 13.8 Clock Suspension during Burst Write (using CKE Function) (1/2) (Burst Length = 4, /CAS Latency = 2)



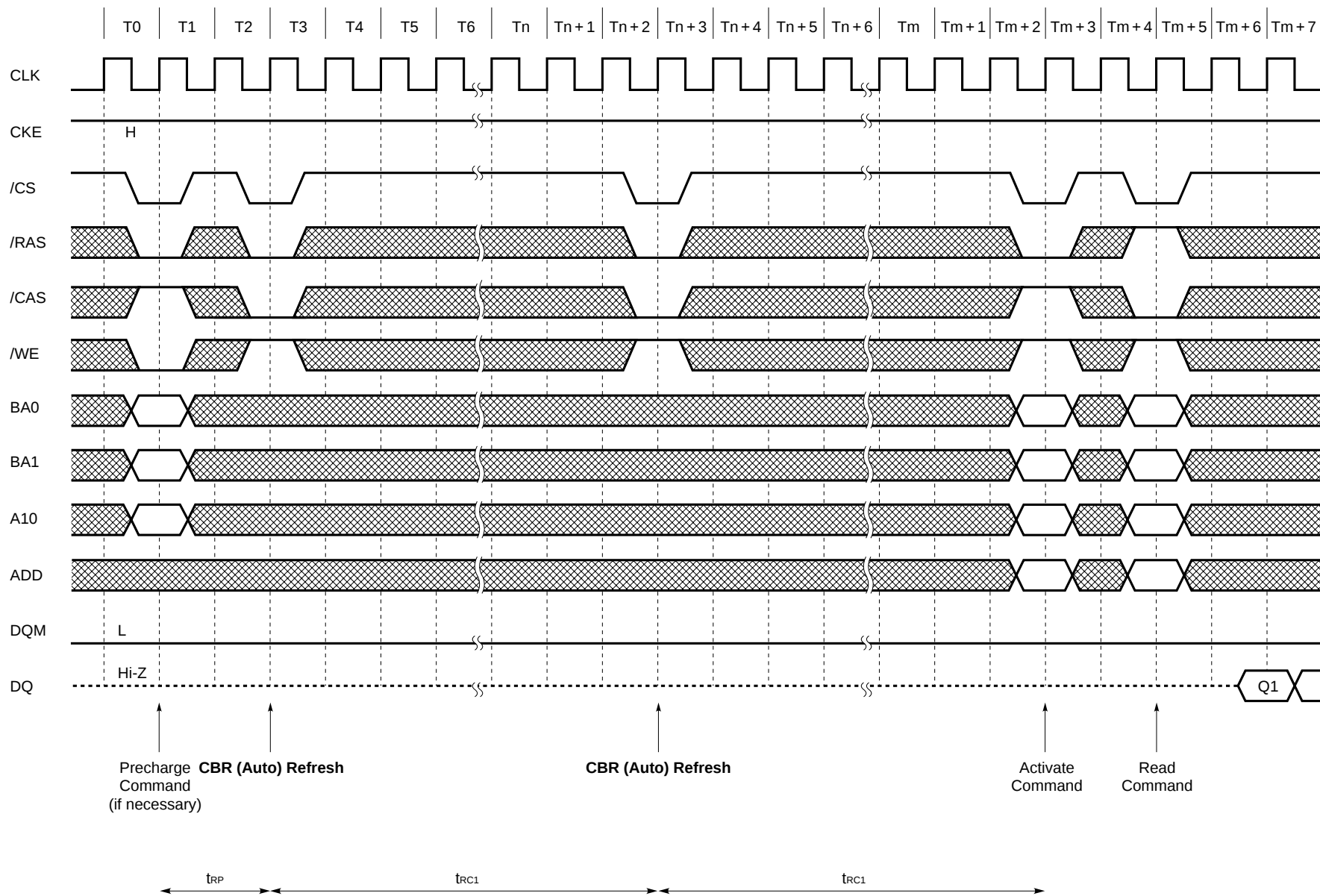
Clock Suspension during Burst Write (using CKE Function) (2/2) (Burst Length = 4, /CAS Latency = 3)



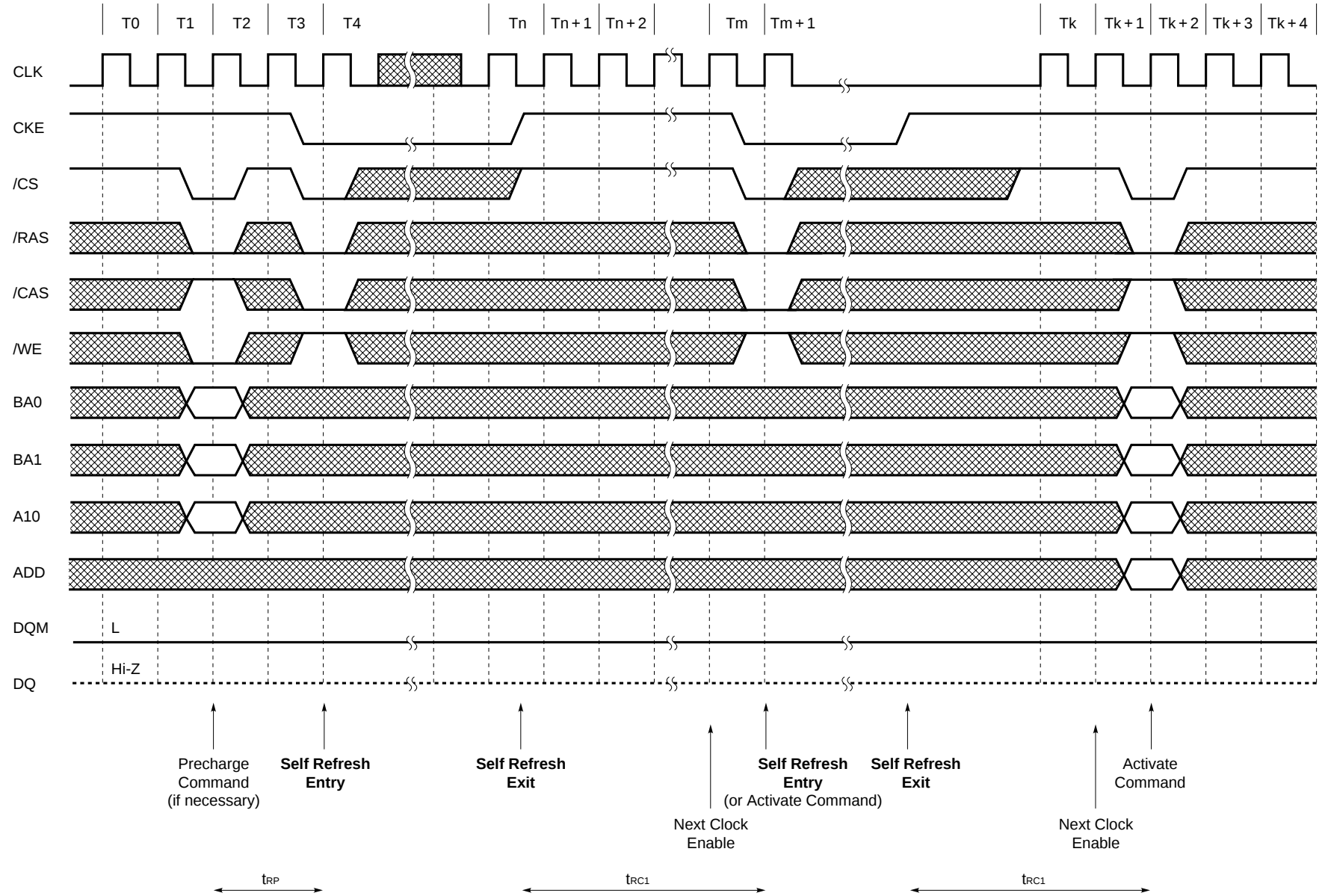
### 13.9 Power Down Mode and Clock Mask (Burst Length = 4, /CAS Latency = 2)



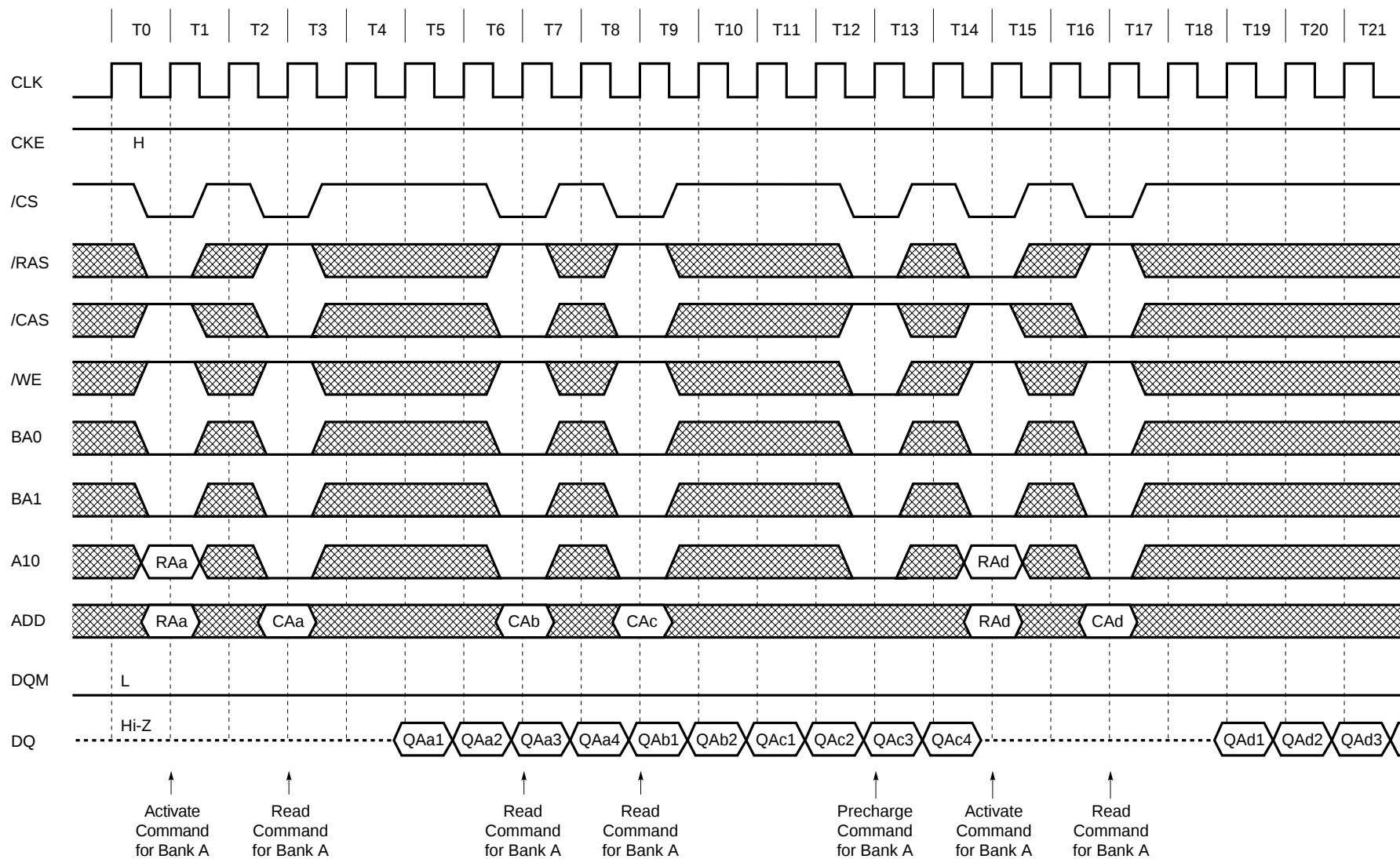
### 13.10 CBR (Auto) Refresh



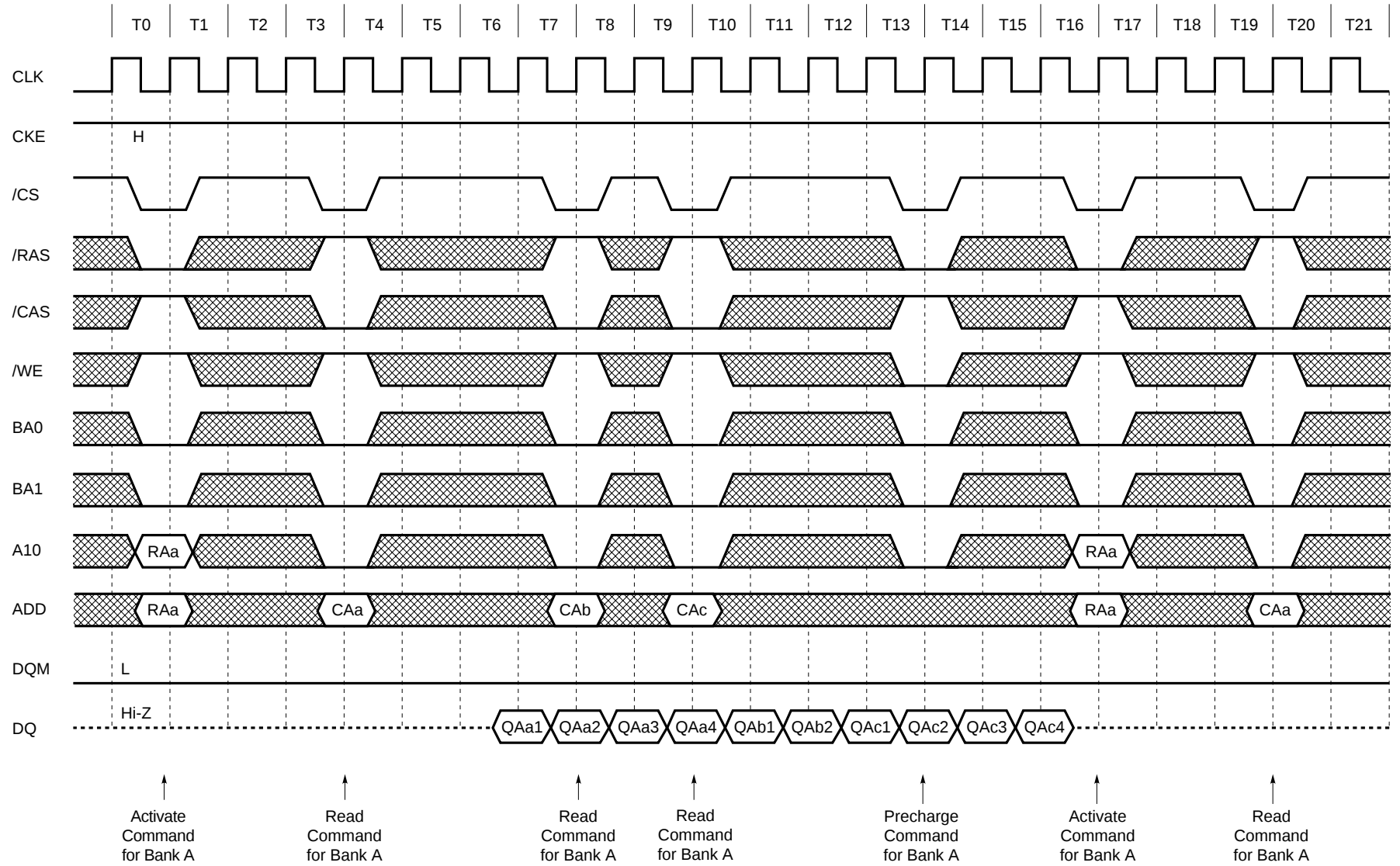
### 13.11 Self Refresh (Entry and Exit)



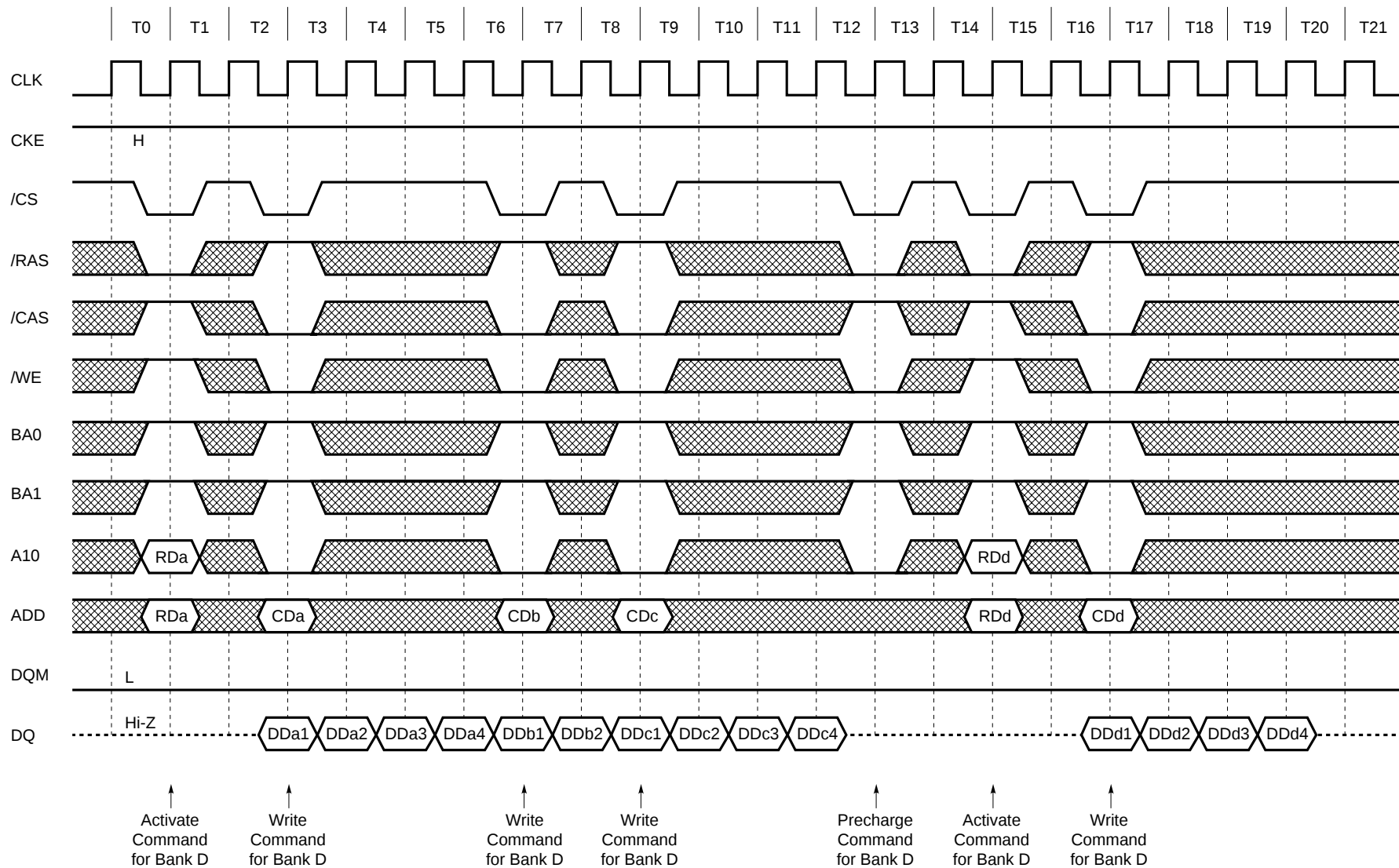
13.12 Random Column Read (Page with Same Bank) (1/2) (Burst Length = 4, /CAS Latency = 2)



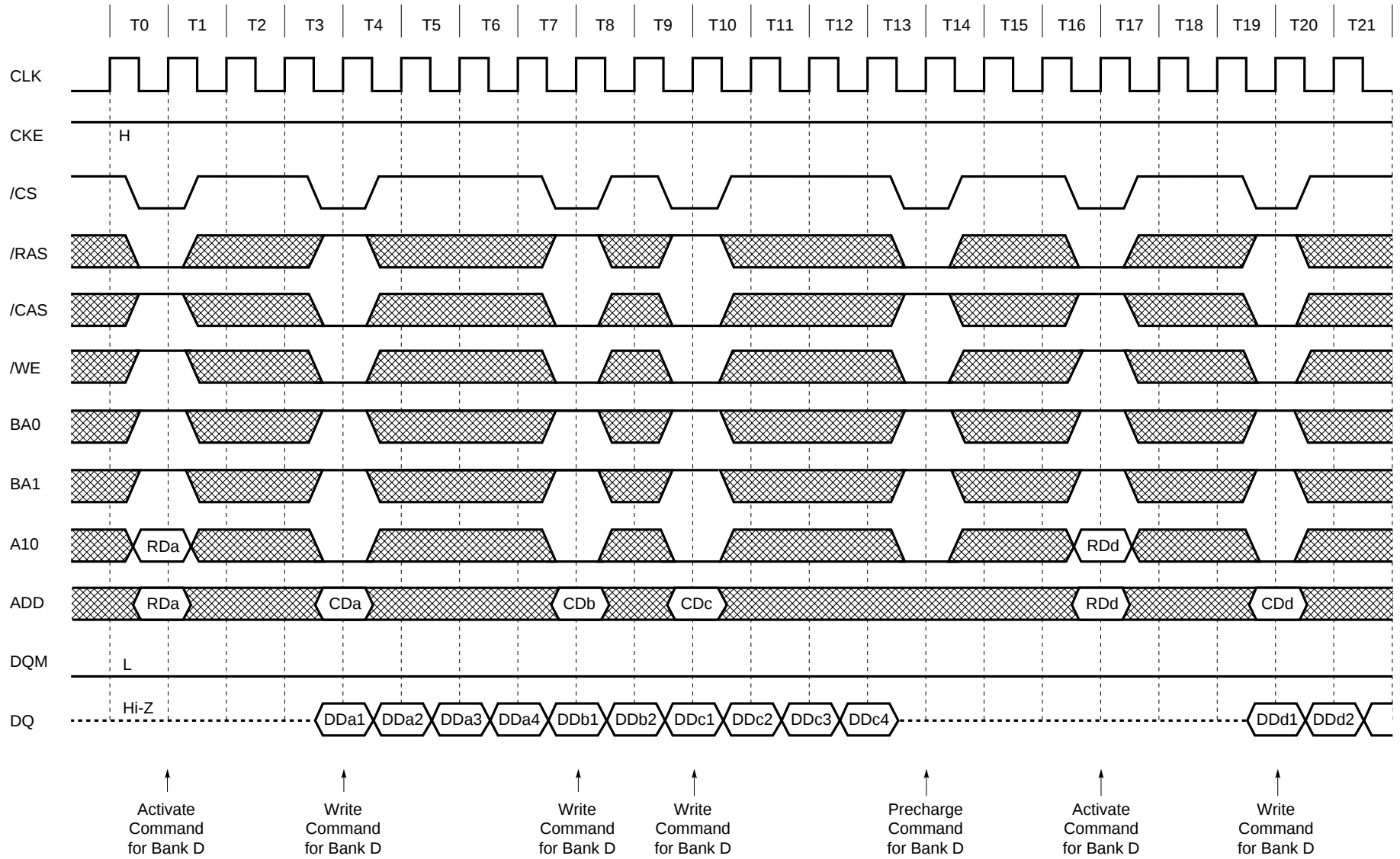
Random Column Read (Page with Same Bank) (2/2) (Burst Length = 4, /CAS Latency = 3)



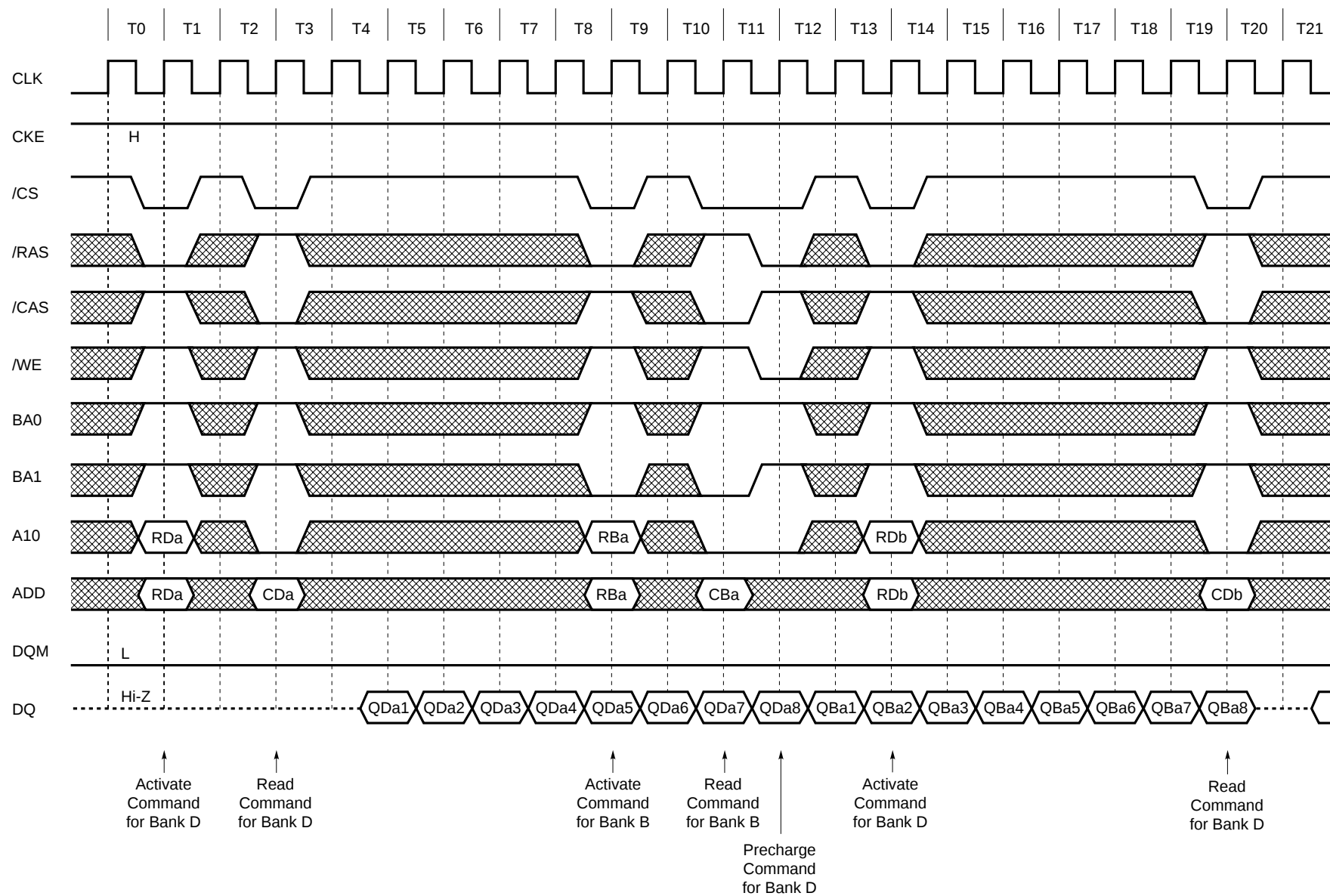
### 13.13 Random Column Write (Page with Same Bank) (1/2) (Burst Length = 4, /CAS Latency = 2)



Random Column Write (Page with Same Bank) (2/2) (Burst Length = 4, /CAS Latency = 3)

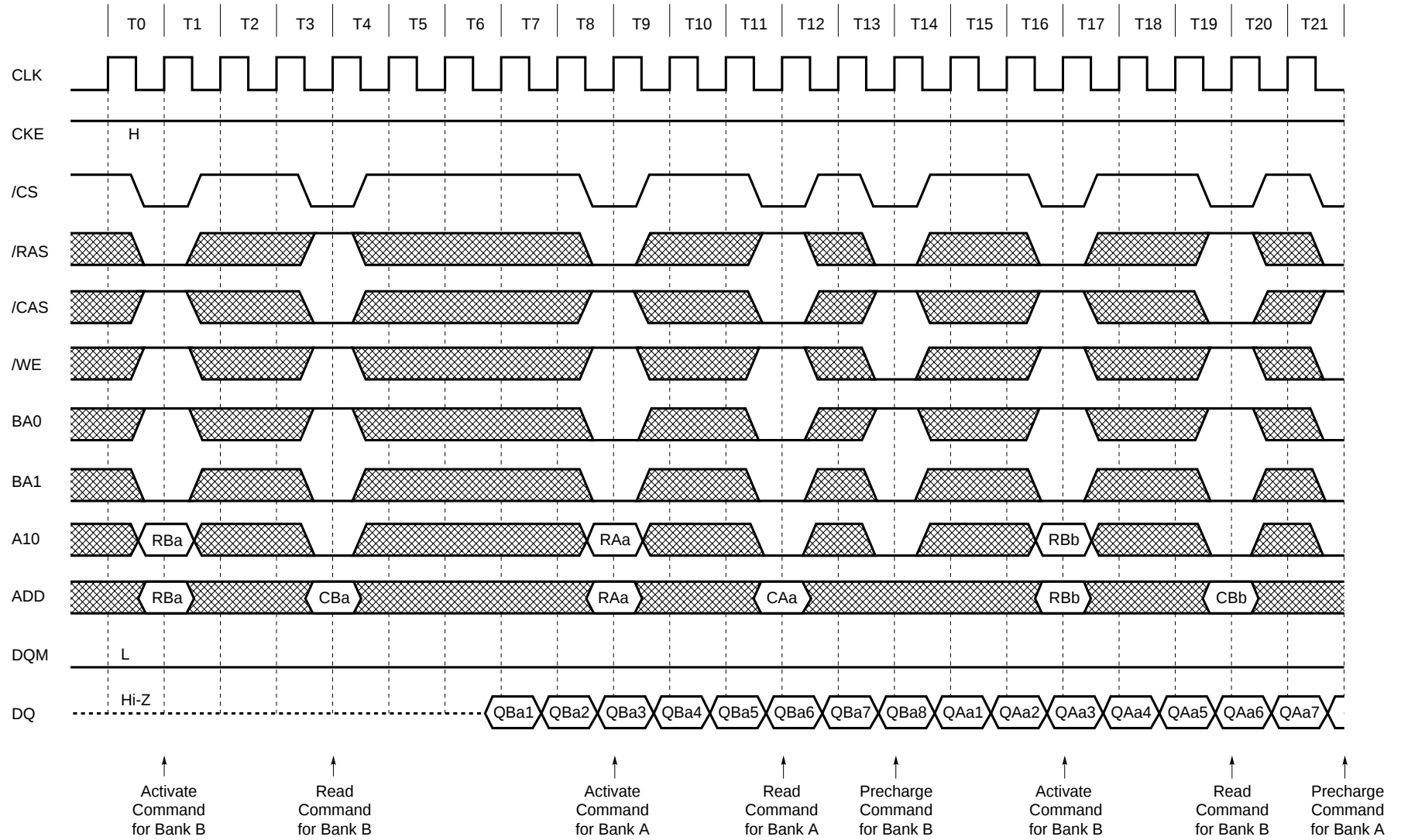


### 13.14 Random Row Read (Ping-Pong Banks) (1/2) (Burst Length = 8, /CAS Latency = 2)

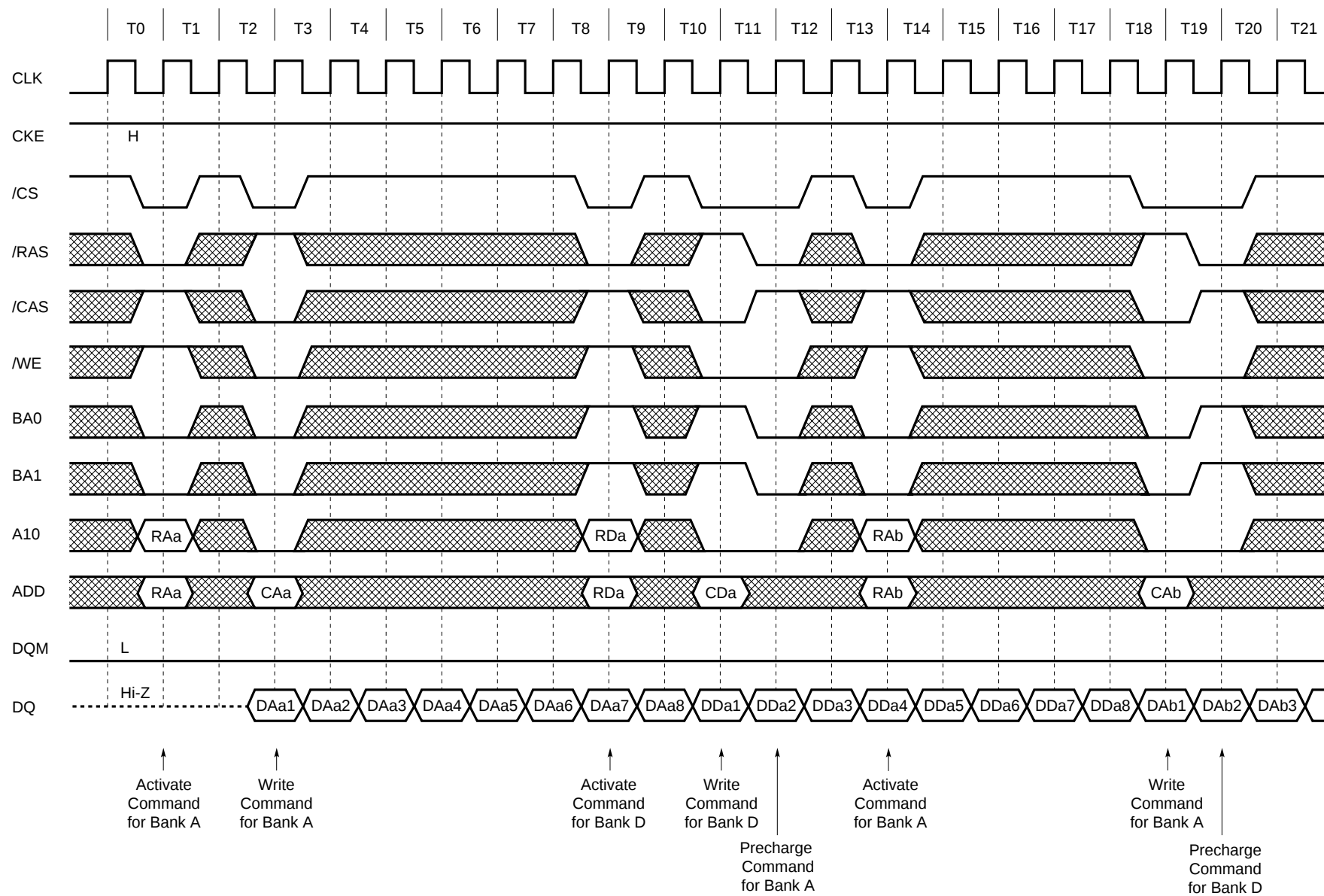


Random Row Read (Ping-Pong Banks) (2/2) (Burst Length = 8, /CAS Latency = 3)

Data Sheet M12650EJBV0DS00

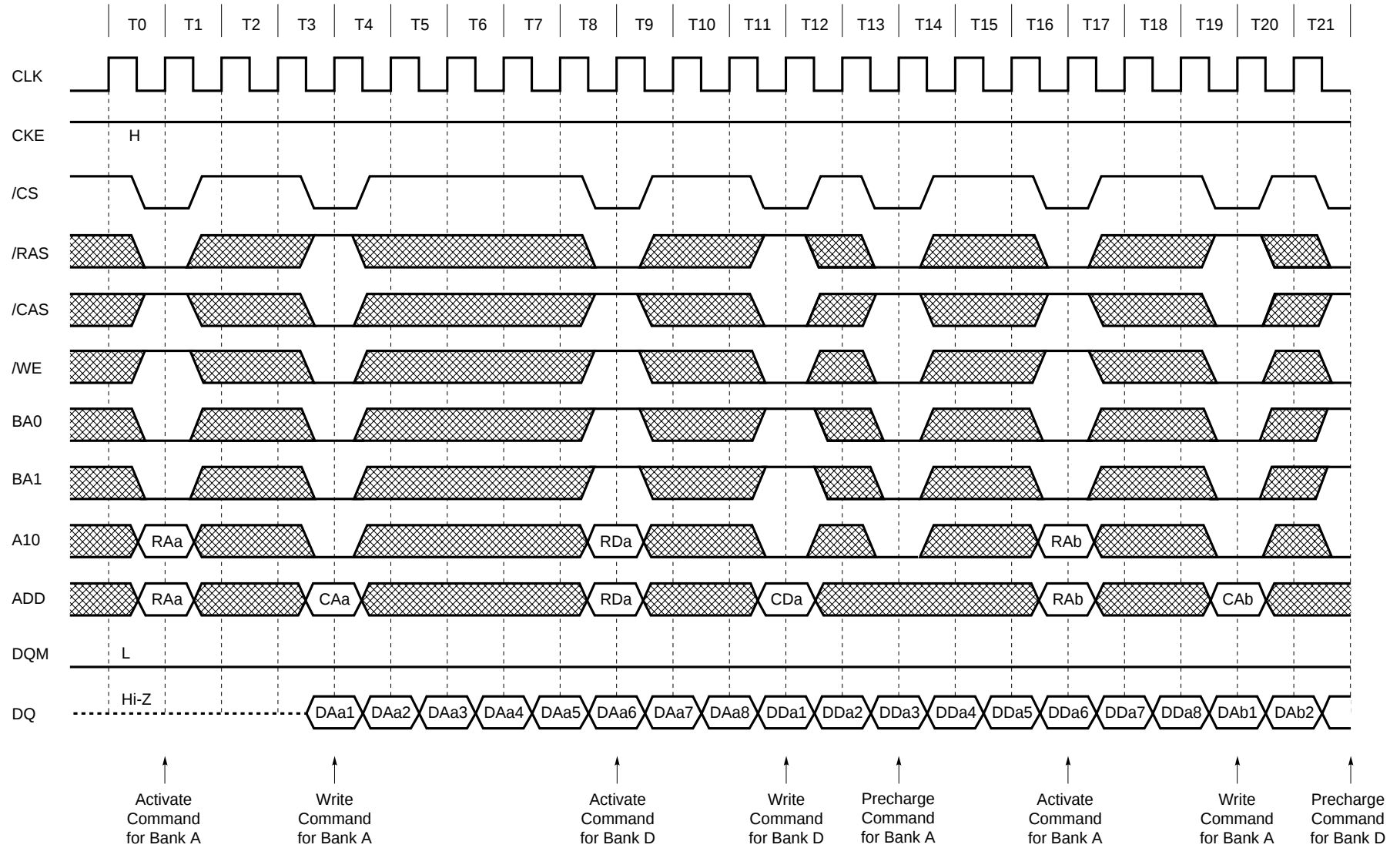


### 13.15 Random Row Write (Ping-Pong Banks) (1/2) (Burst Length = 8, /CAS Latency = 2)

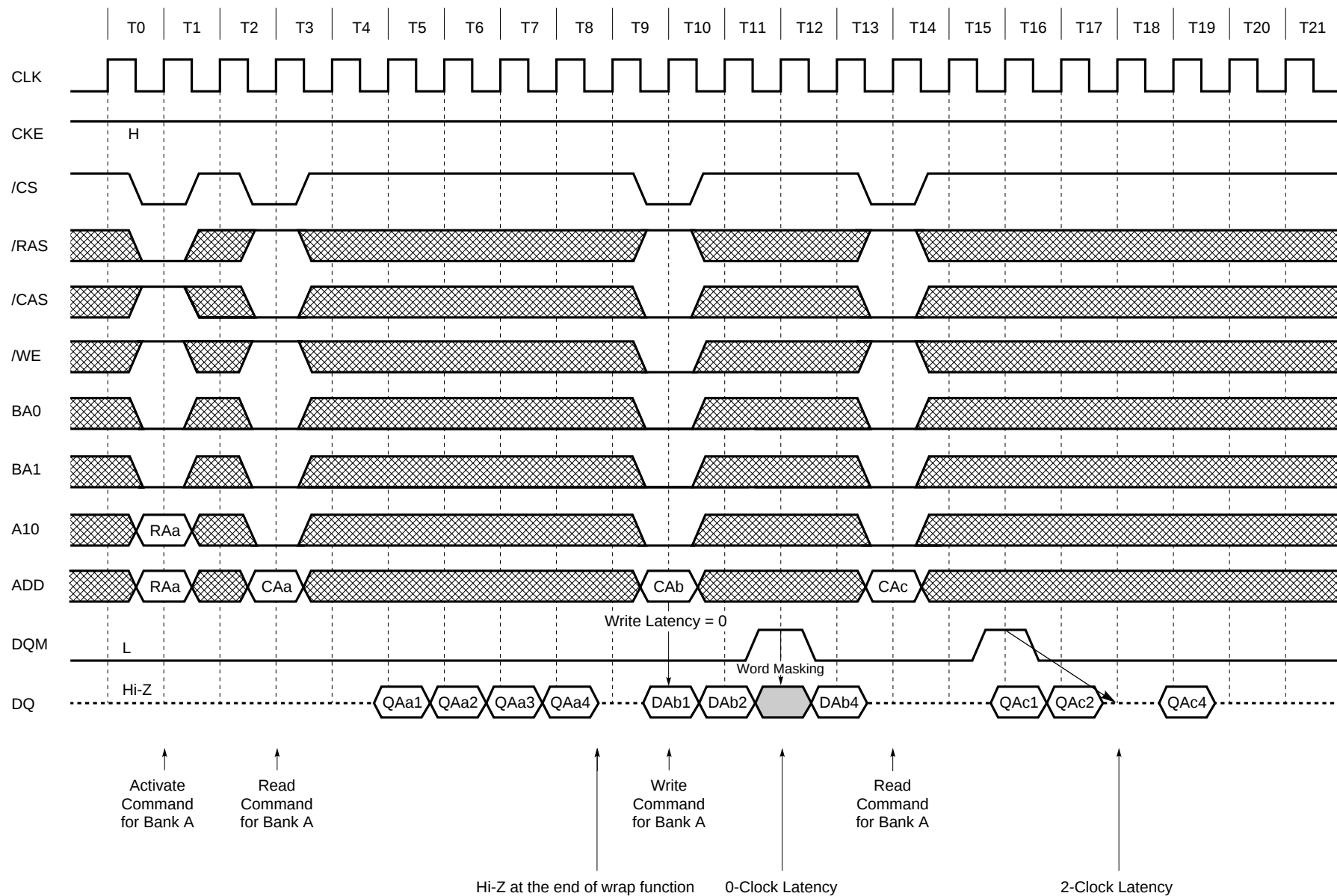


60 Random Row Write (Ping-Pong Banks) (2/2) (Burst Length = 8, /CAS Latency = 3)

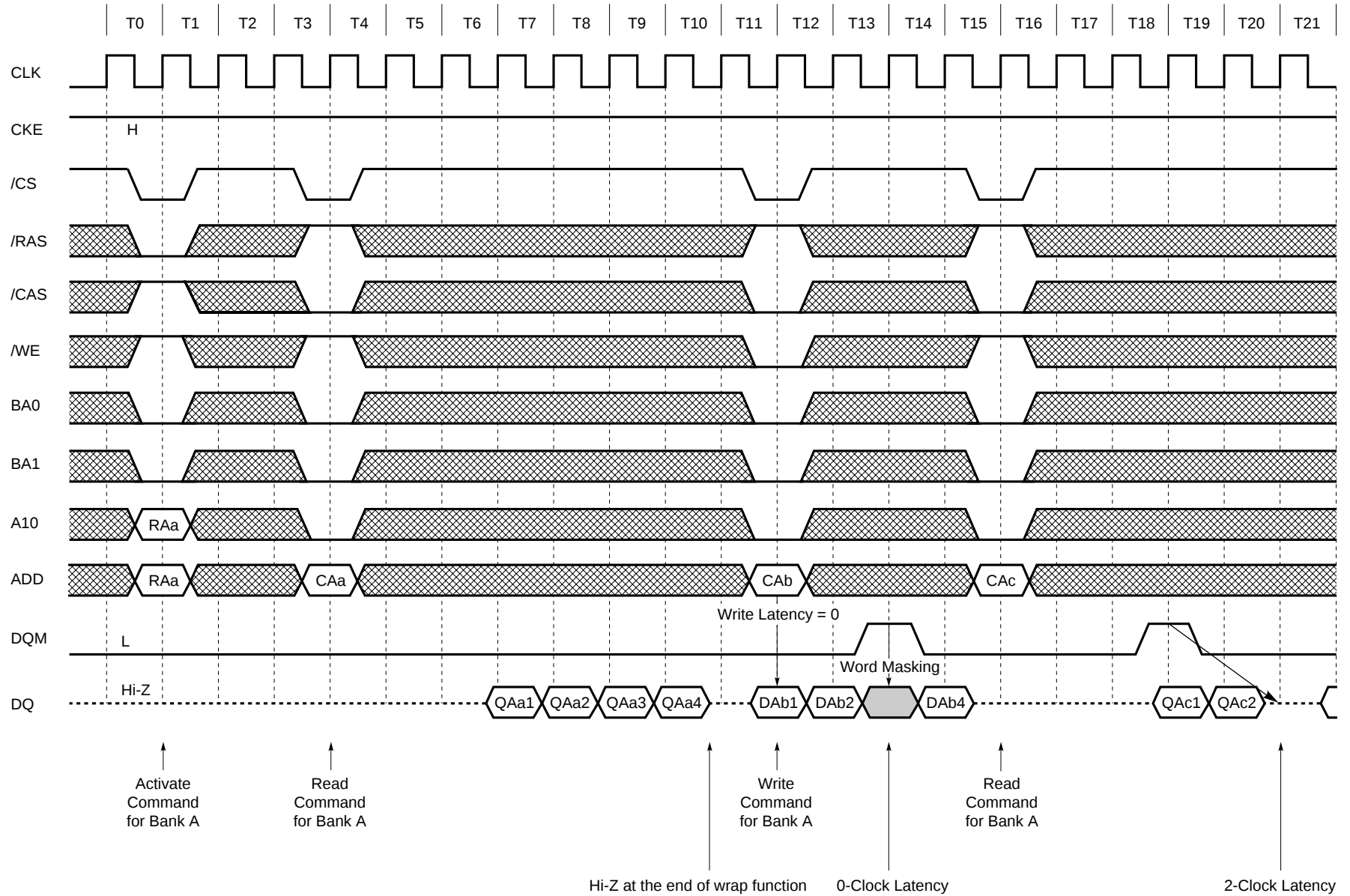
Data Sheet M12650EJBY0DS00



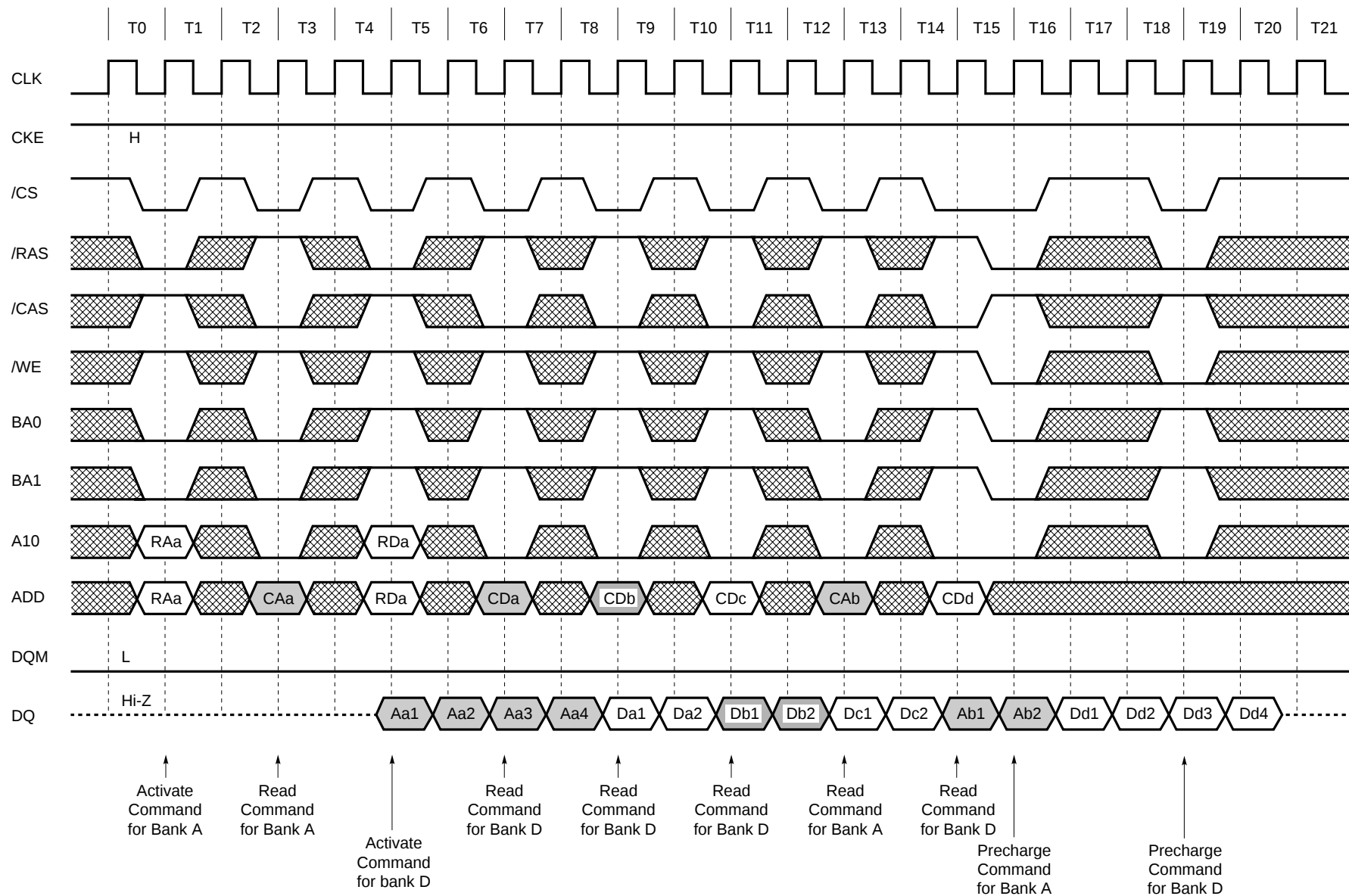
### 13.16 Read and Write (1/2) (Burst Length = 4, /CAS Latency = 2)



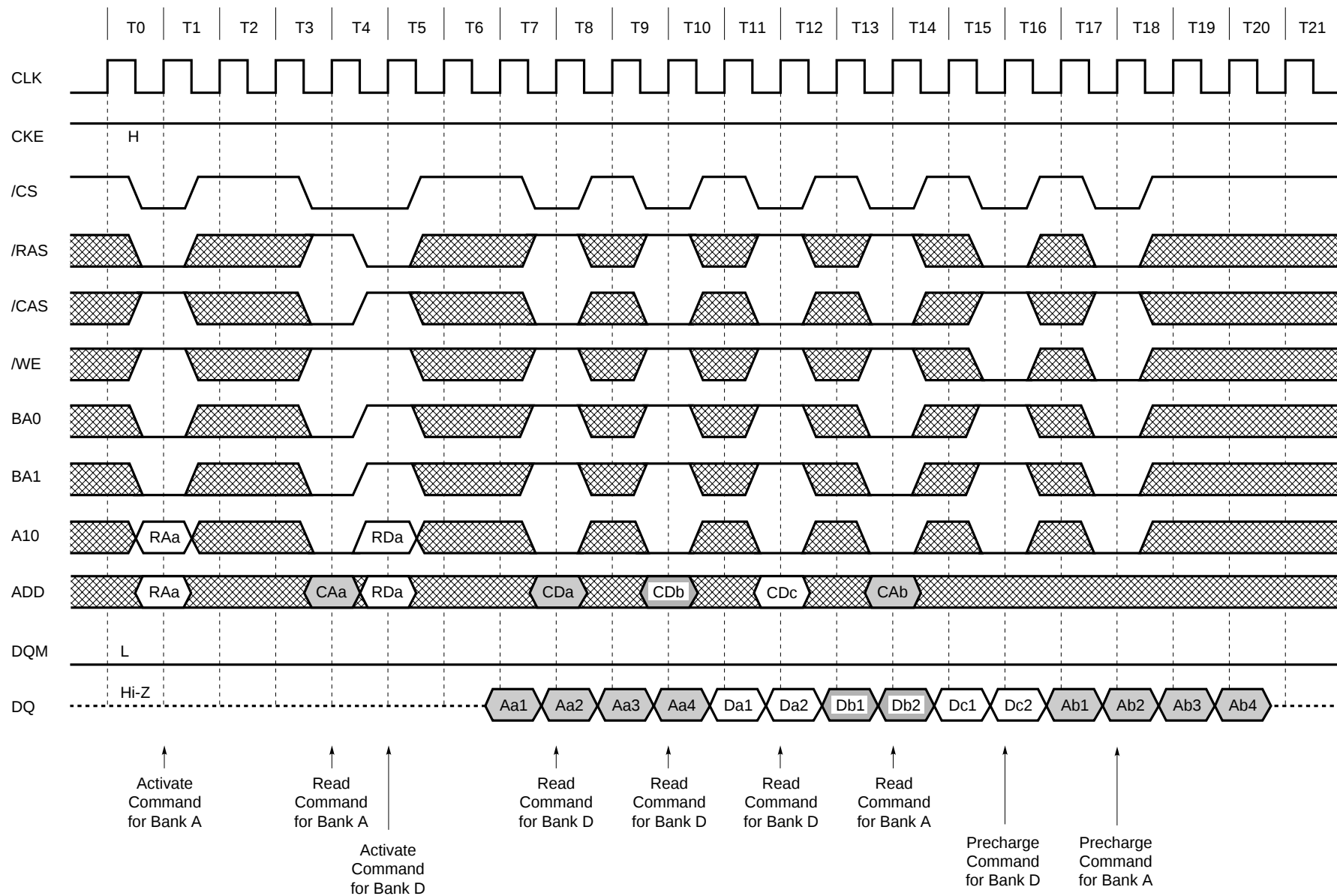
Read and Write (2/2) (Burst Length = 4, /CAS Latency = 3)



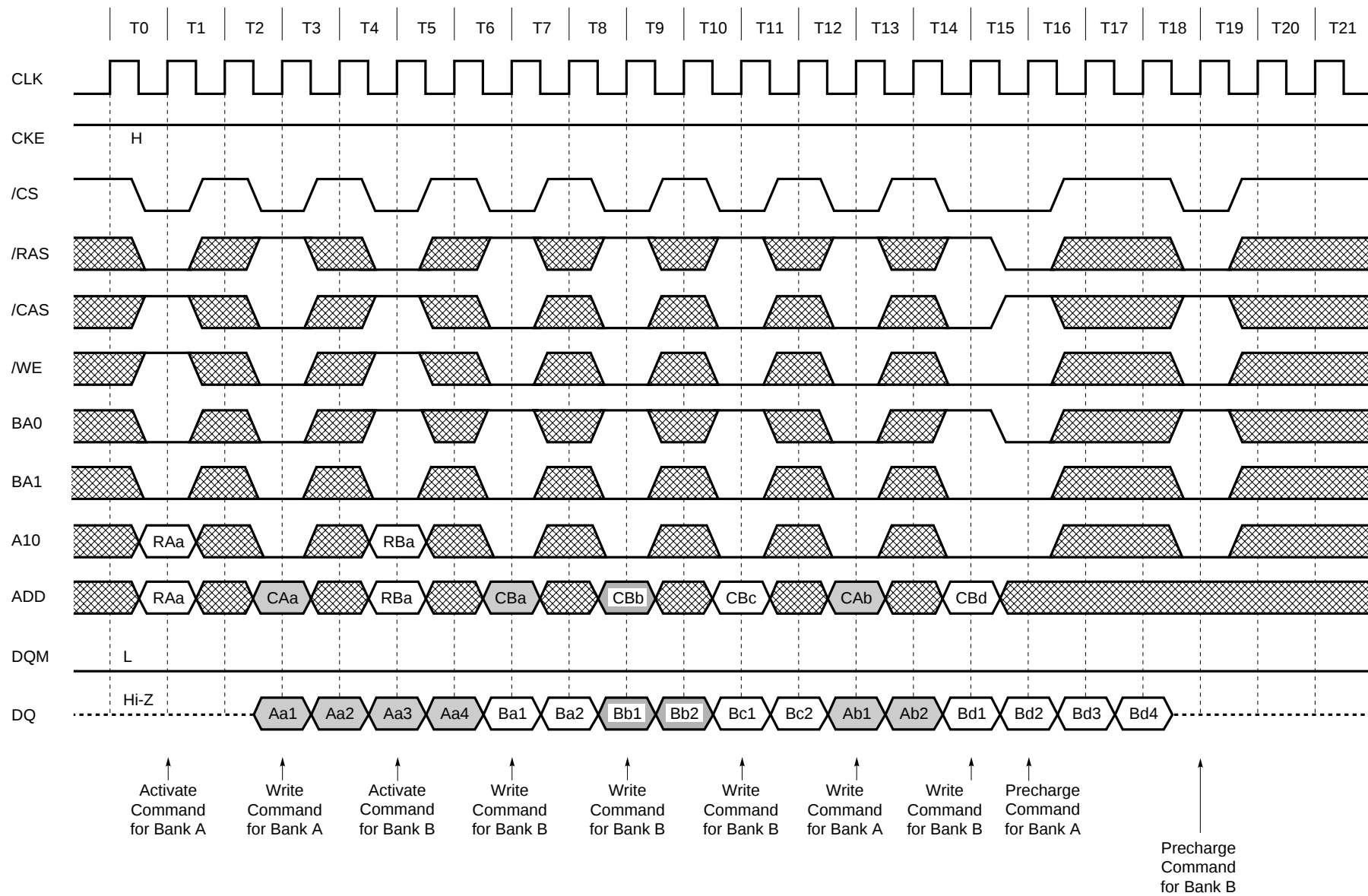
13.17 Interleaved Column Read Cycle (1/2) (Burst Length = 4, /CAS Latency = 2)



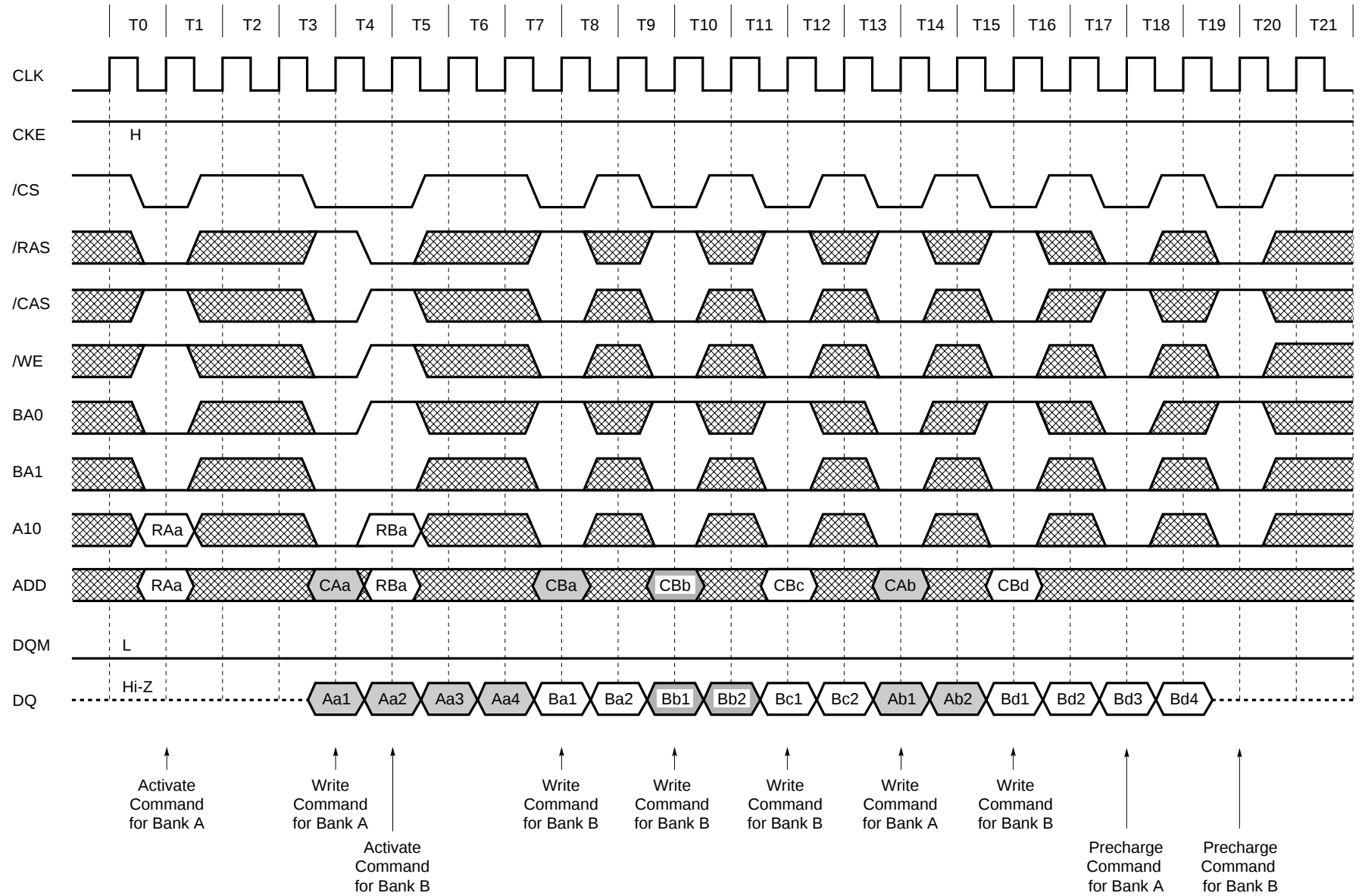
Interleaved Column Read Cycle (2/2) (Burst Length = 4, /CAS Latency = 3)



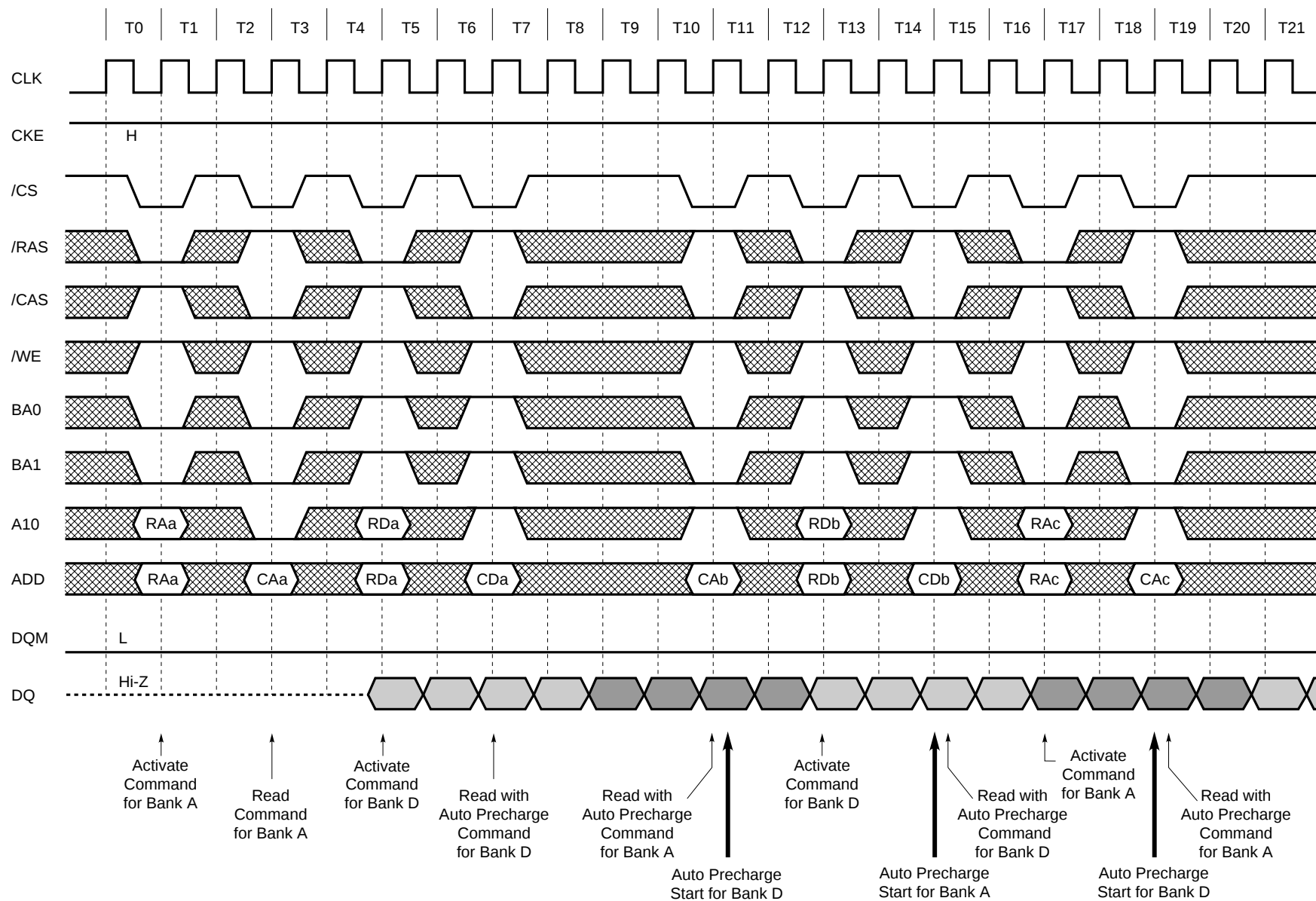
### 13.18 Interleaved Column Write Cycle (1/2) (Burst Length = 4, /CAS Latency = 2)



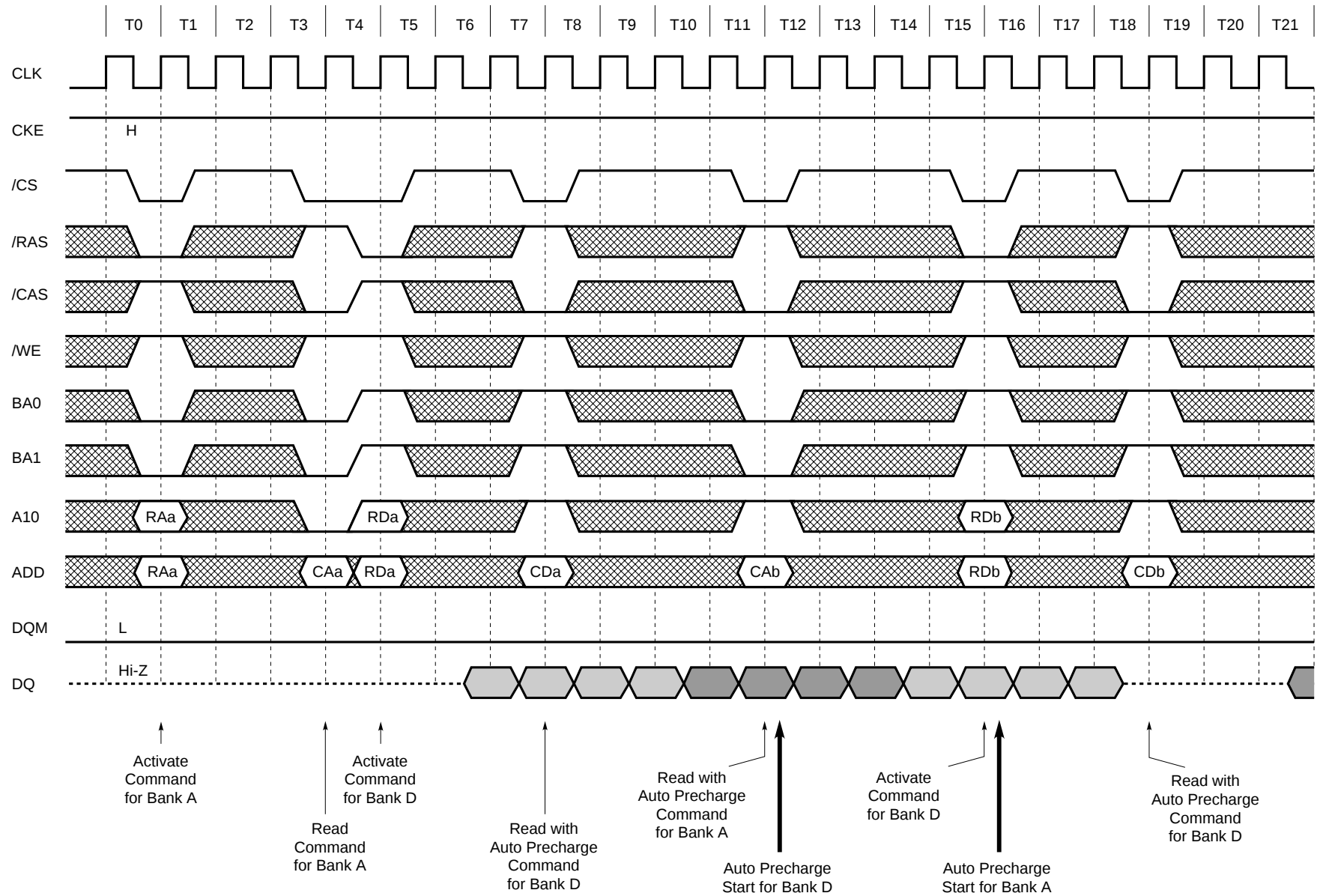
Interleaved Column Write Cycle (2/2) (Burst Length = 4, /CAS Latency = 3)



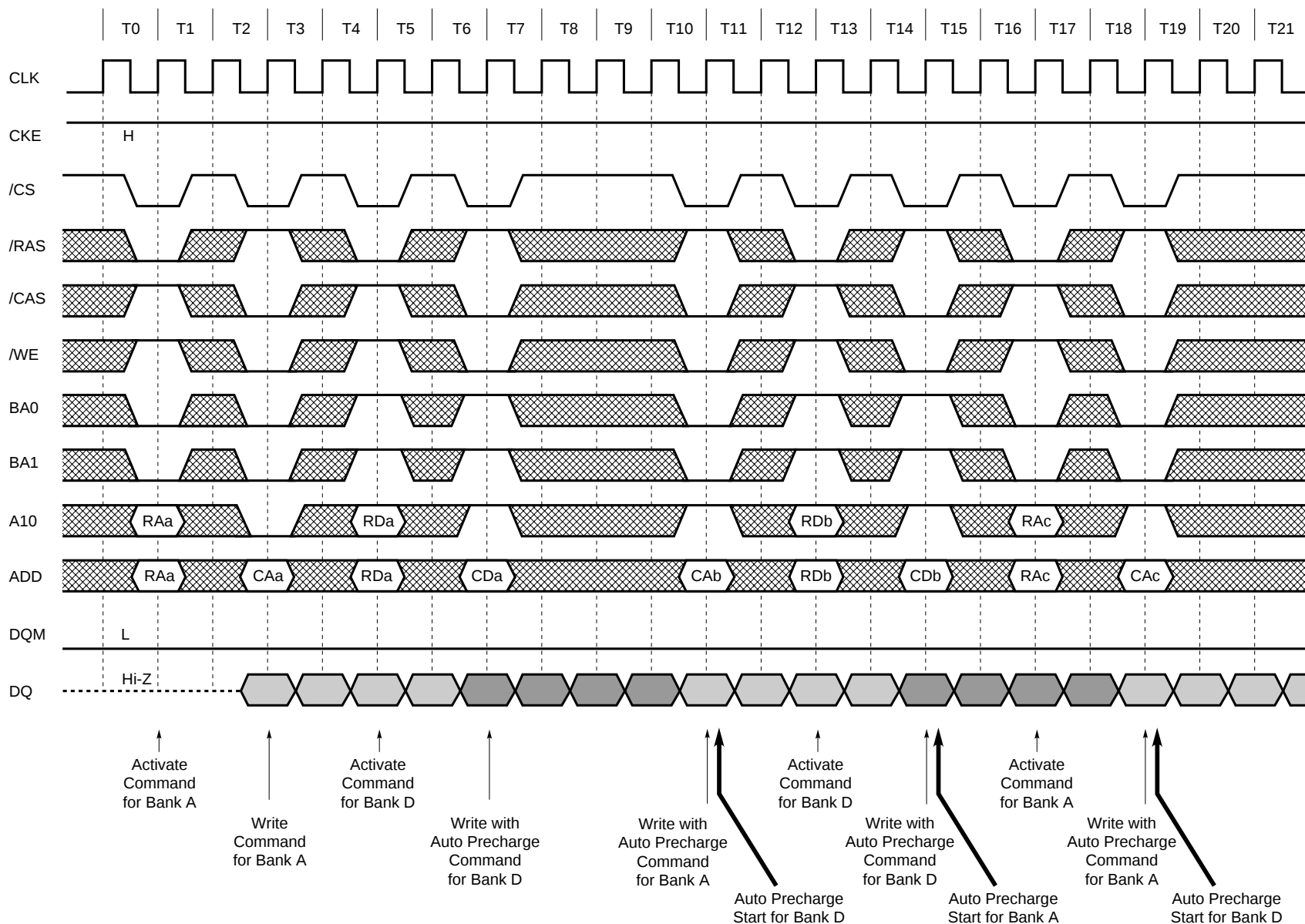
### 13.19 Auto Precharge after Read Burst (1/2) (Burst Length = 4, /CAS Latency = 2)



Auto Precharge after Read Burst (2/2) (Burst Length = 4, /CAS Latency = 3)

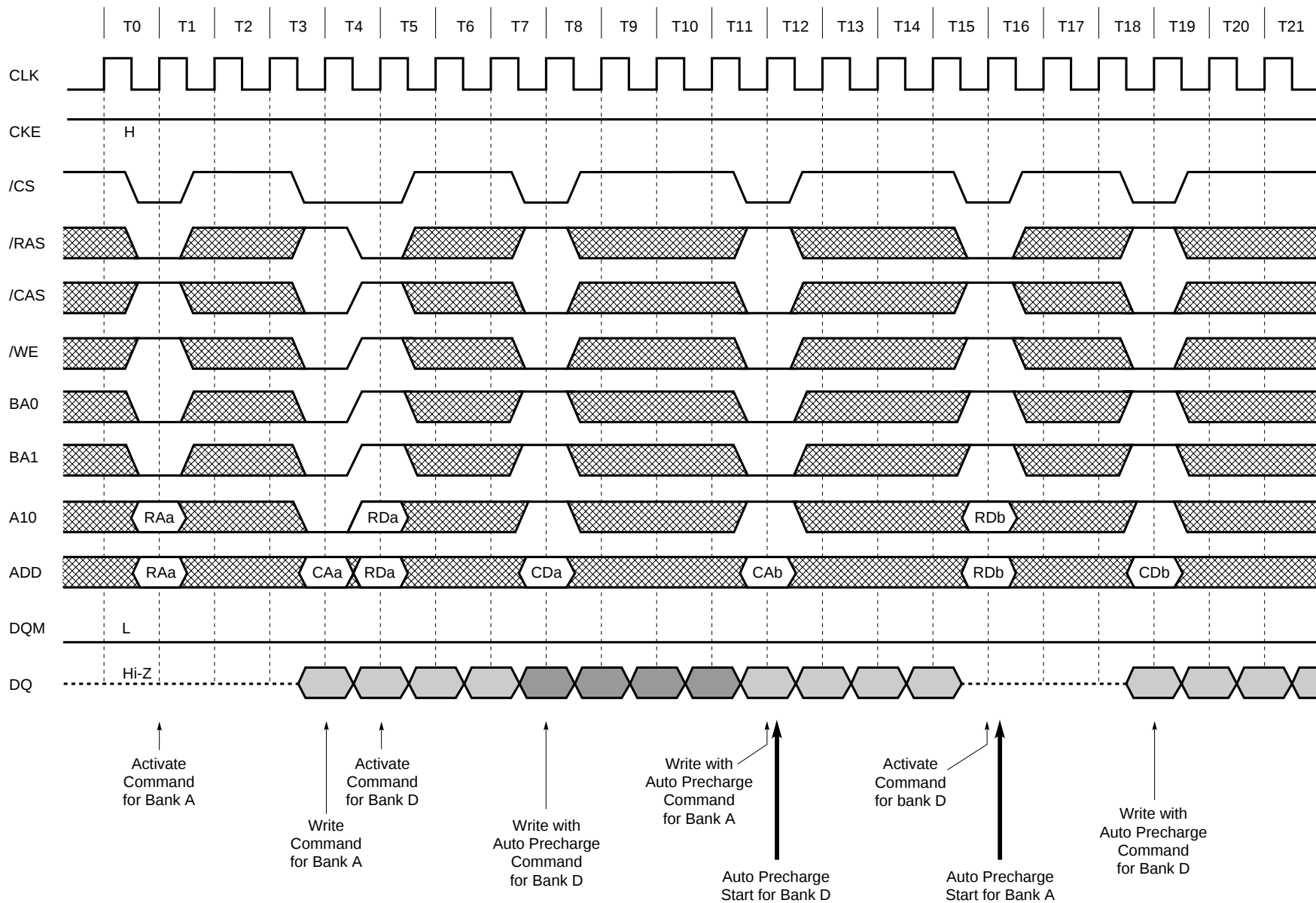


### 13.20 Auto Precharge after Write Burst (1/2) (Burst Length = 4, /CAS Latency = 2)

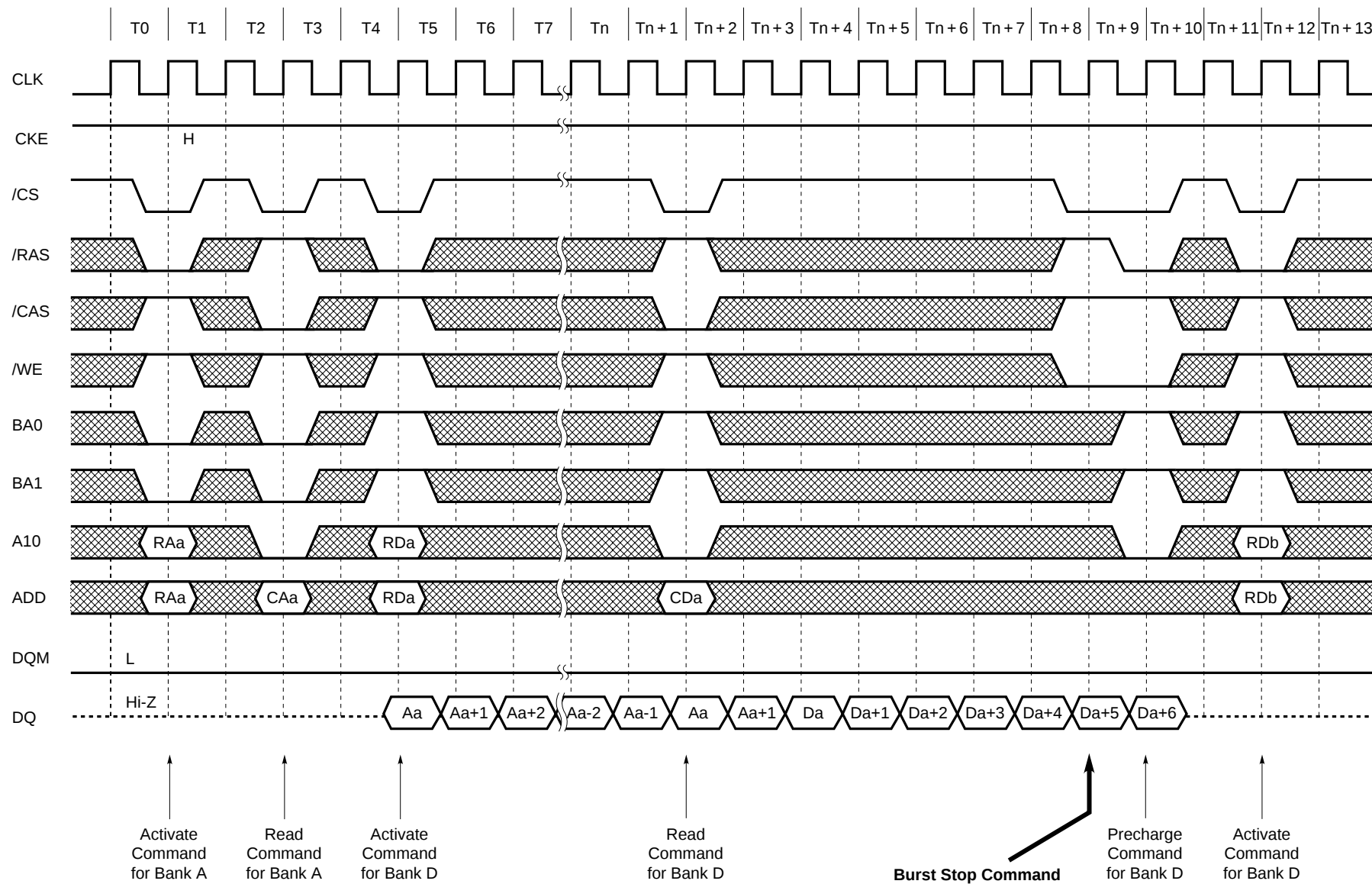


Auto Precharge after Write Burst (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet M12650EJ8V0DS00

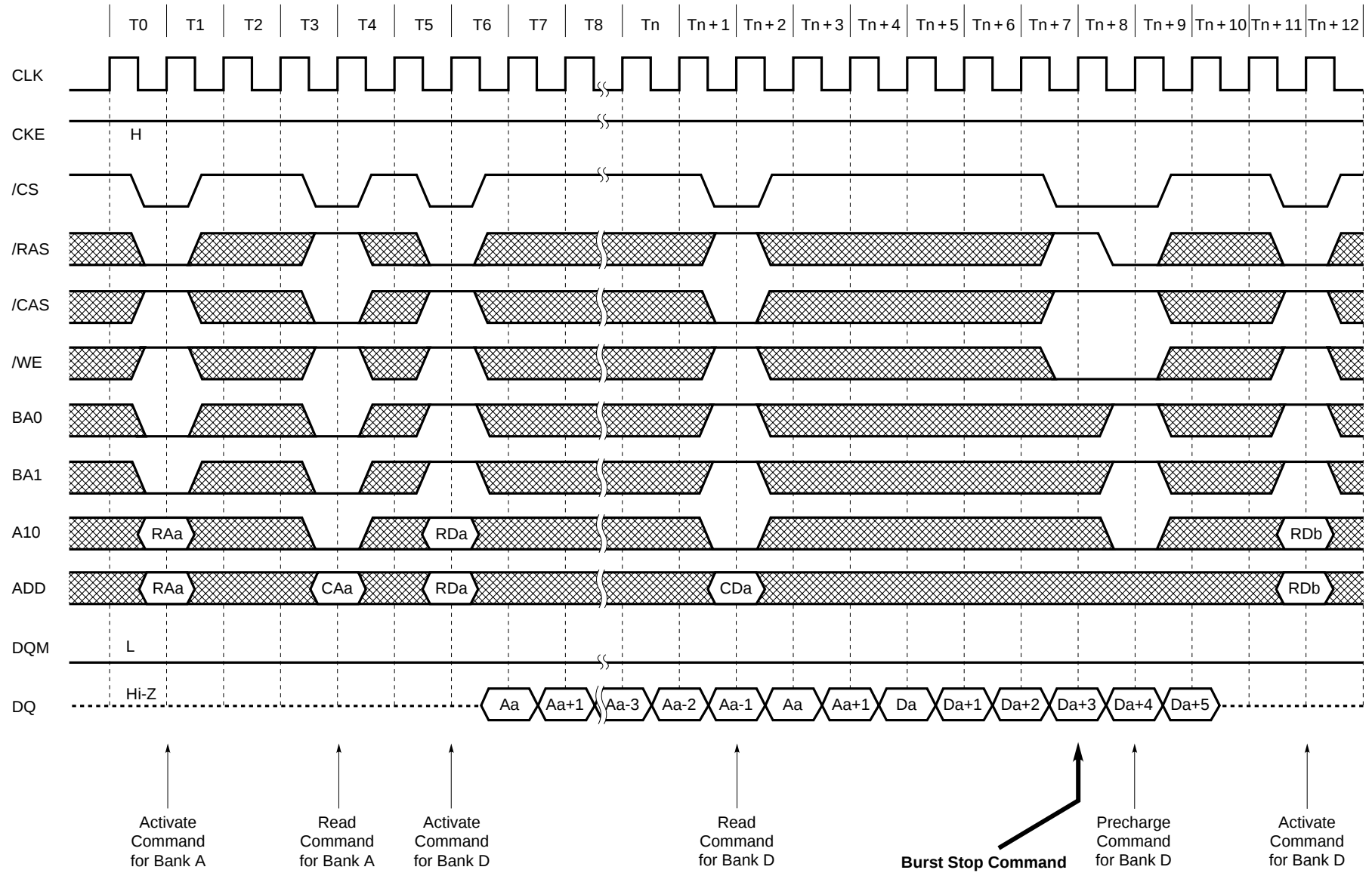


### 13.21 Full Page Read Cycle (1/2) (/CAS Latency = 2)

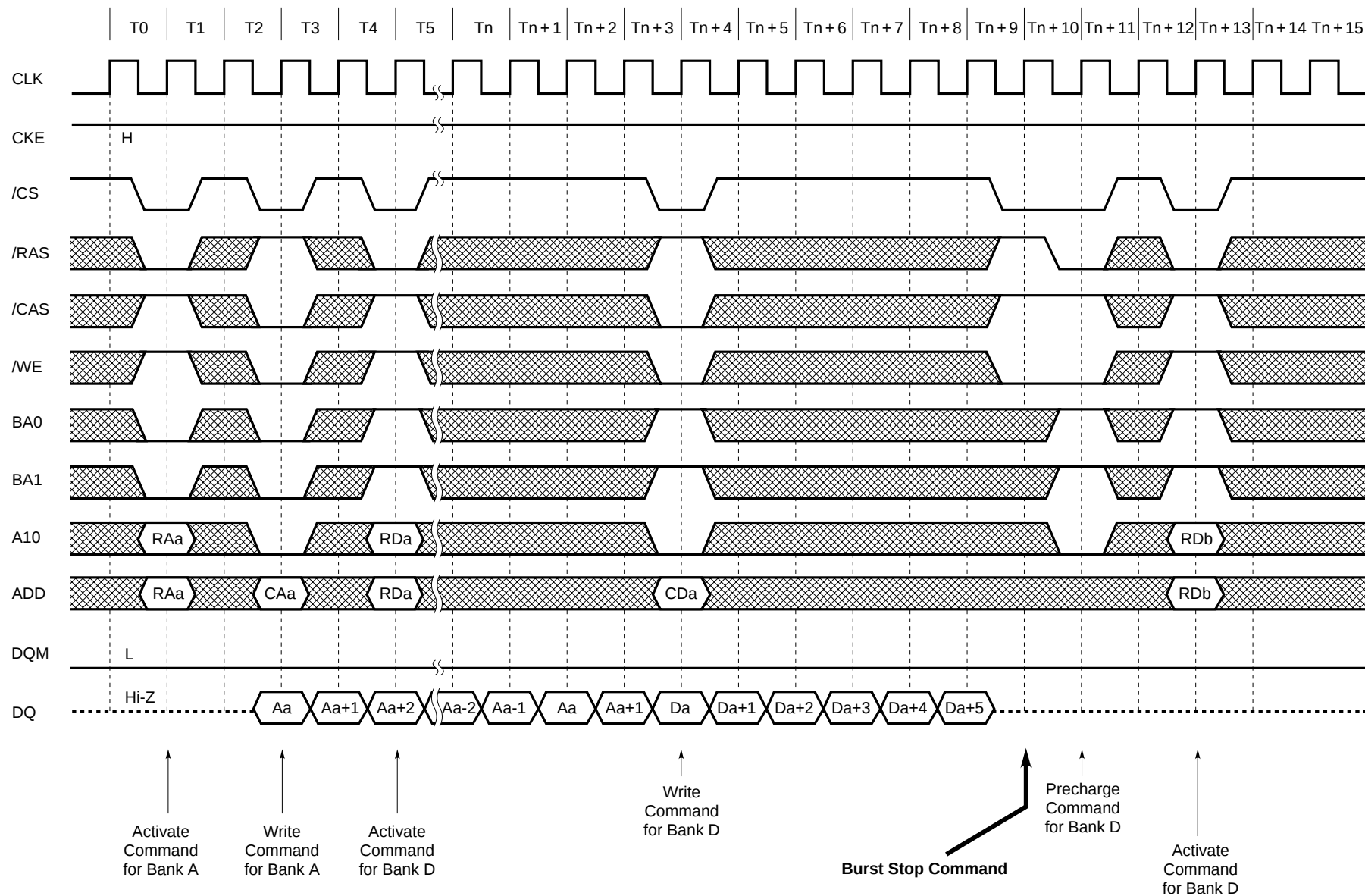


72 Full Page Read Cycle (2/2) (/CAS latency = 3)

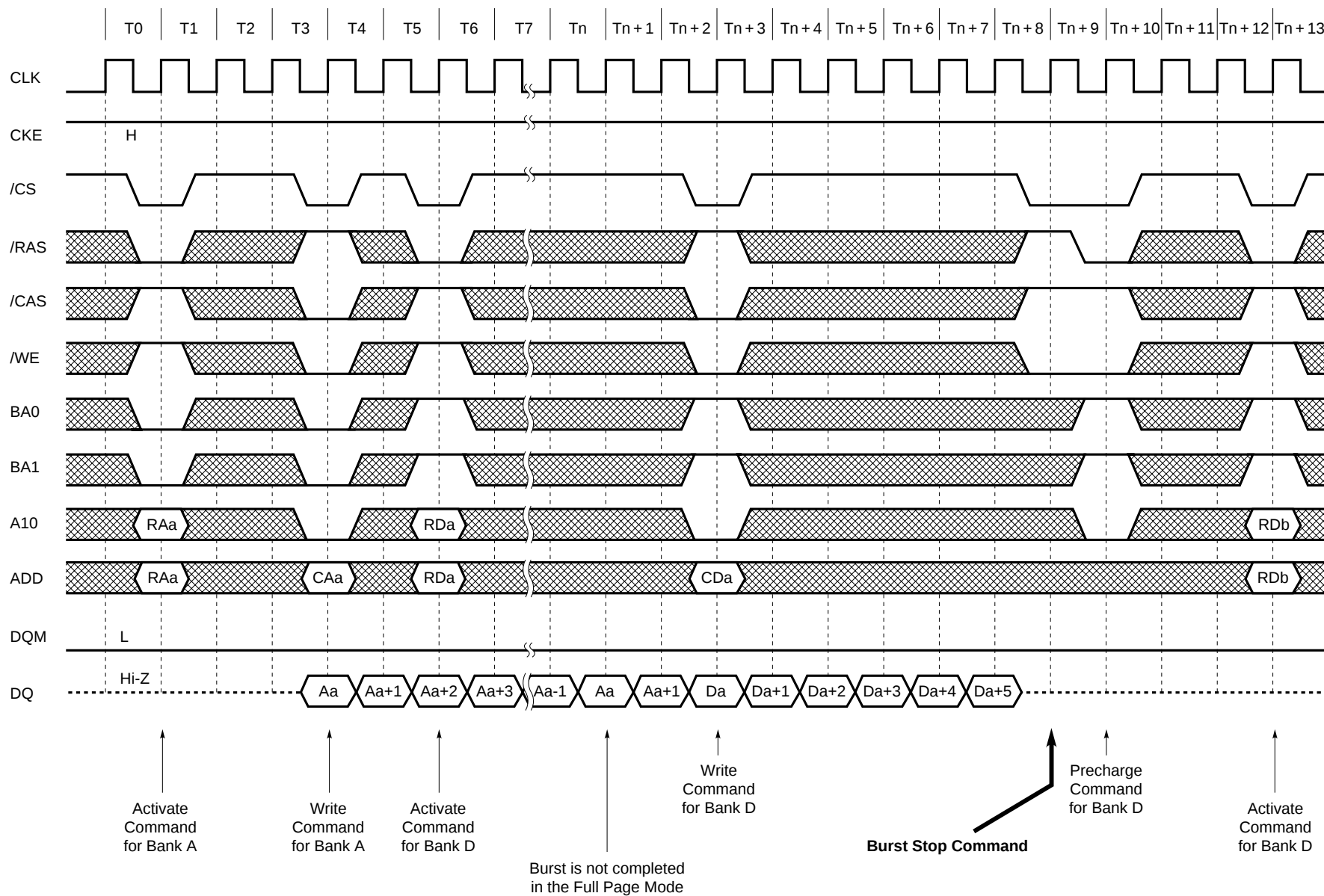
Data Sheet M12650EJ8V0DS00



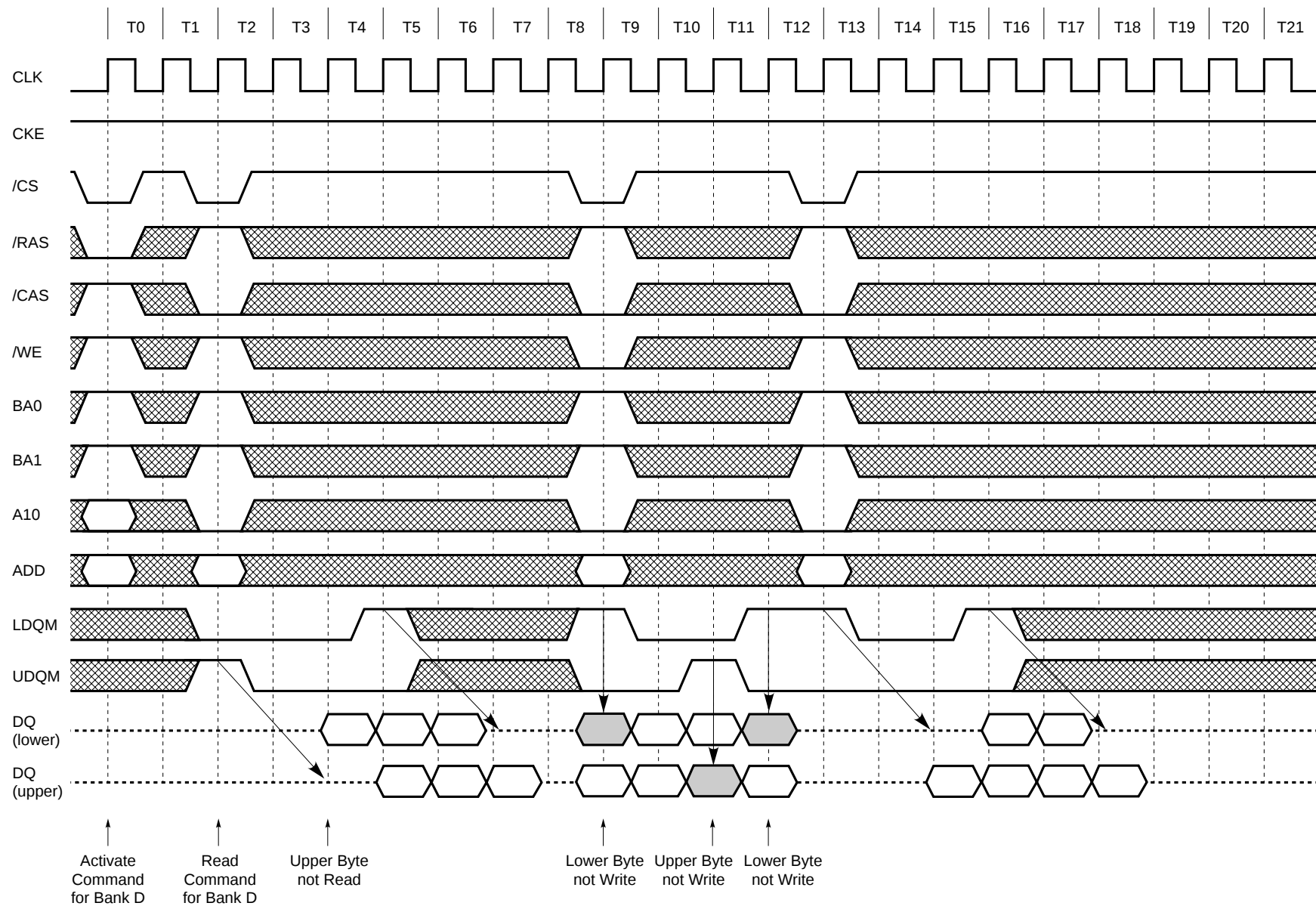
### 13.22 Full Page Write Cycle (1/2) (/CAS latency = 2)



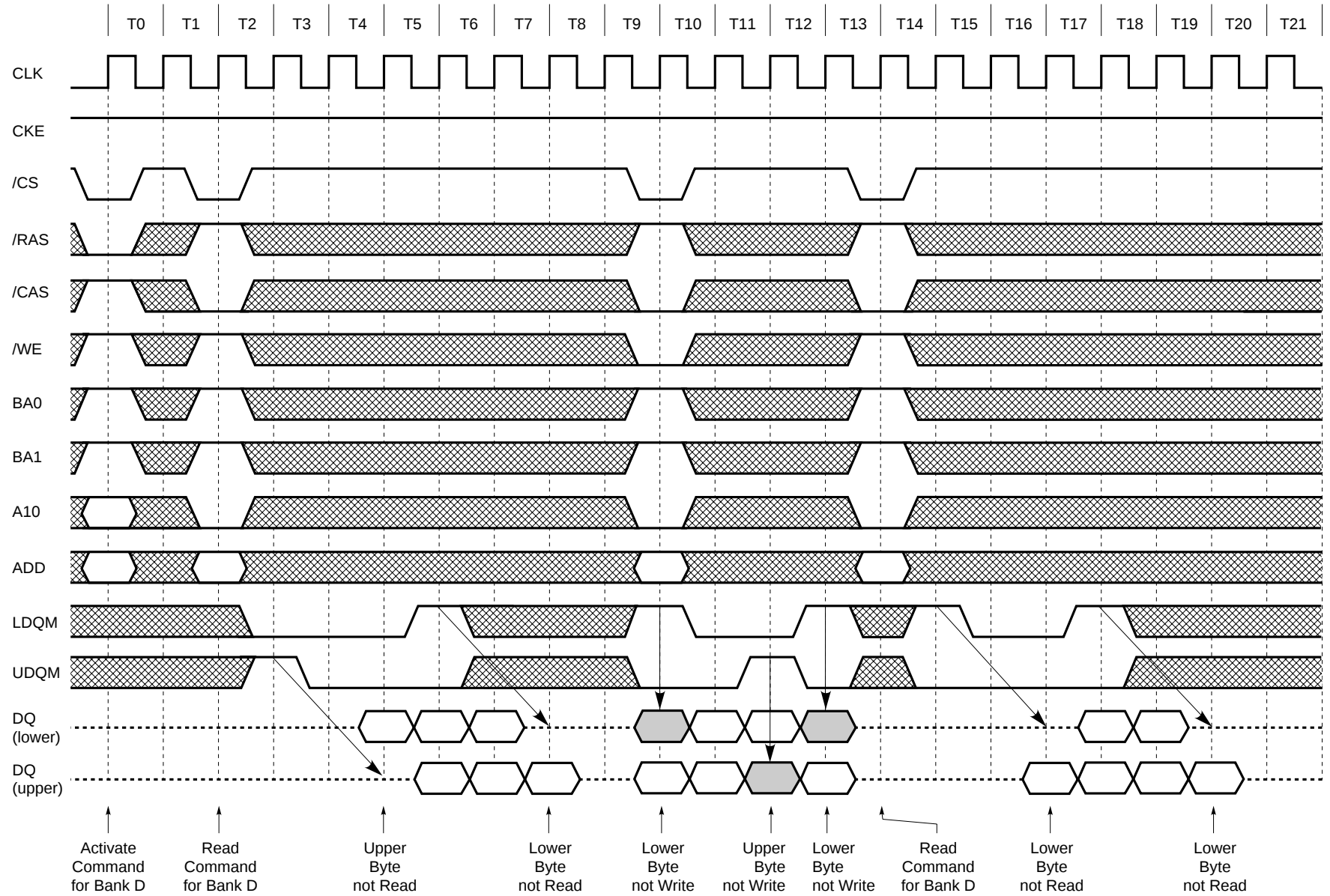
Full Page Write Cycle (2/2) (ICAS Latency = 3)



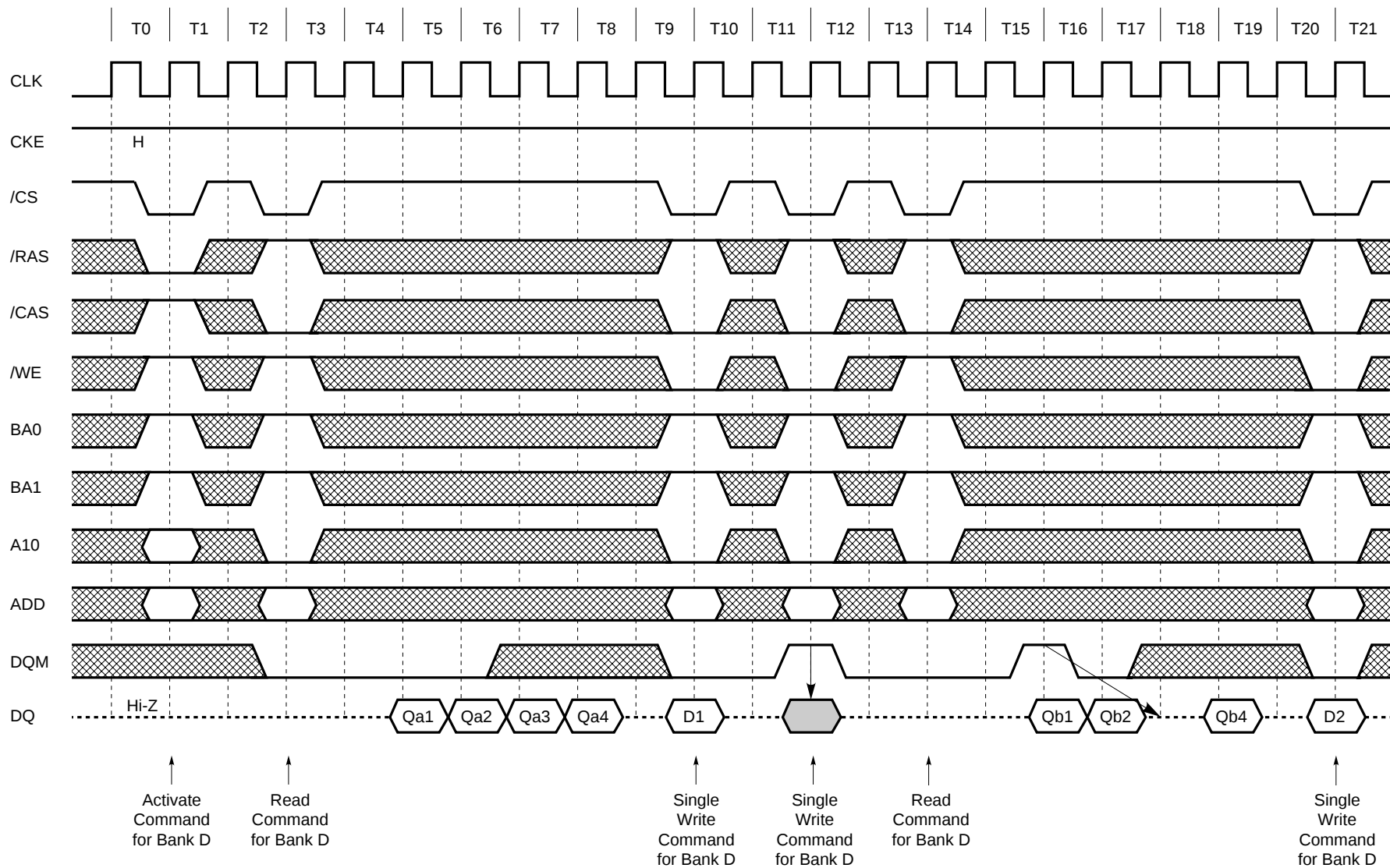
### 13.23 Byte Write Operation (Burst Length = 4, /CAS Latency = 2)



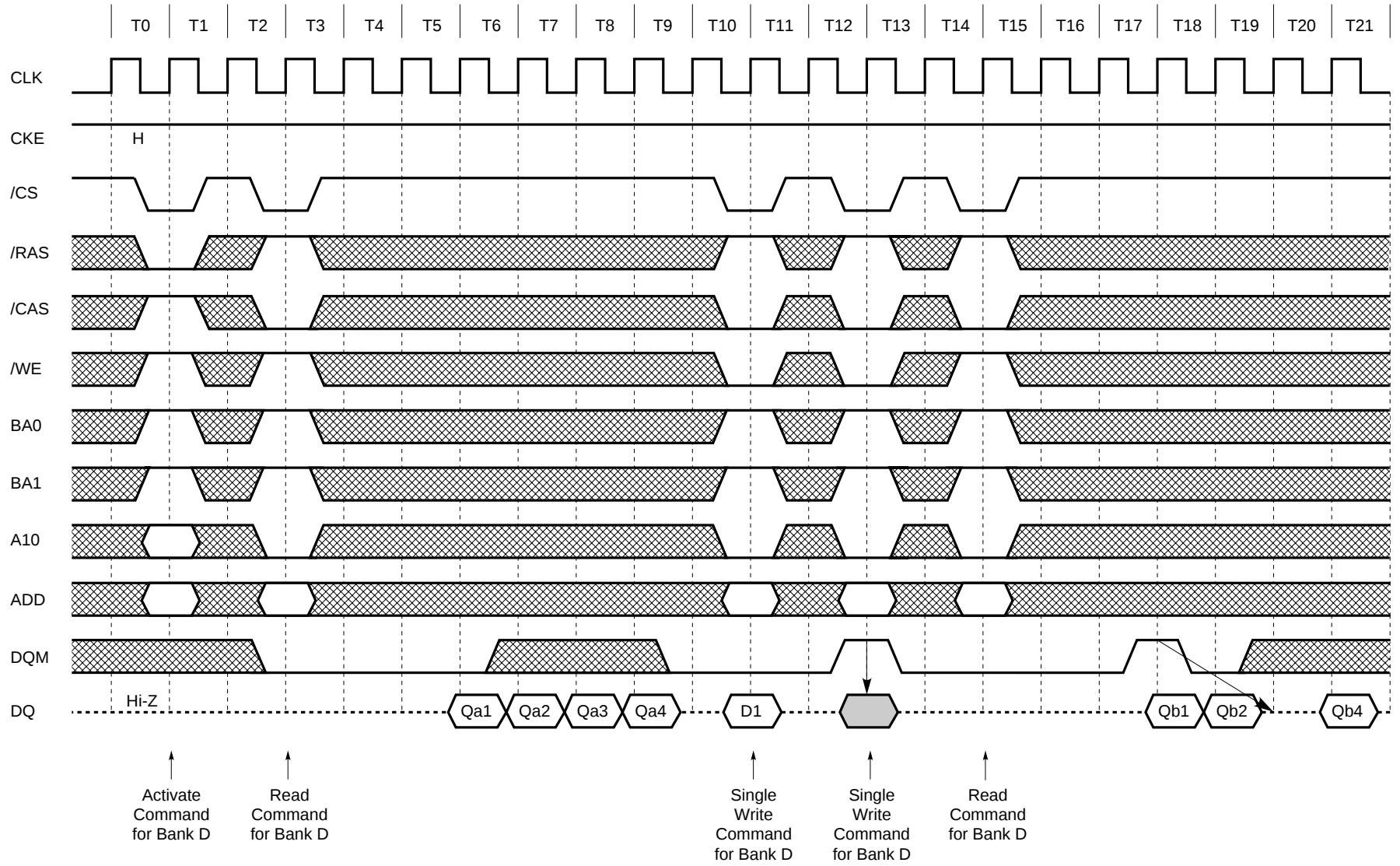
Byte Write Operation (Burst Length = 4, /CAS Latency = 3)



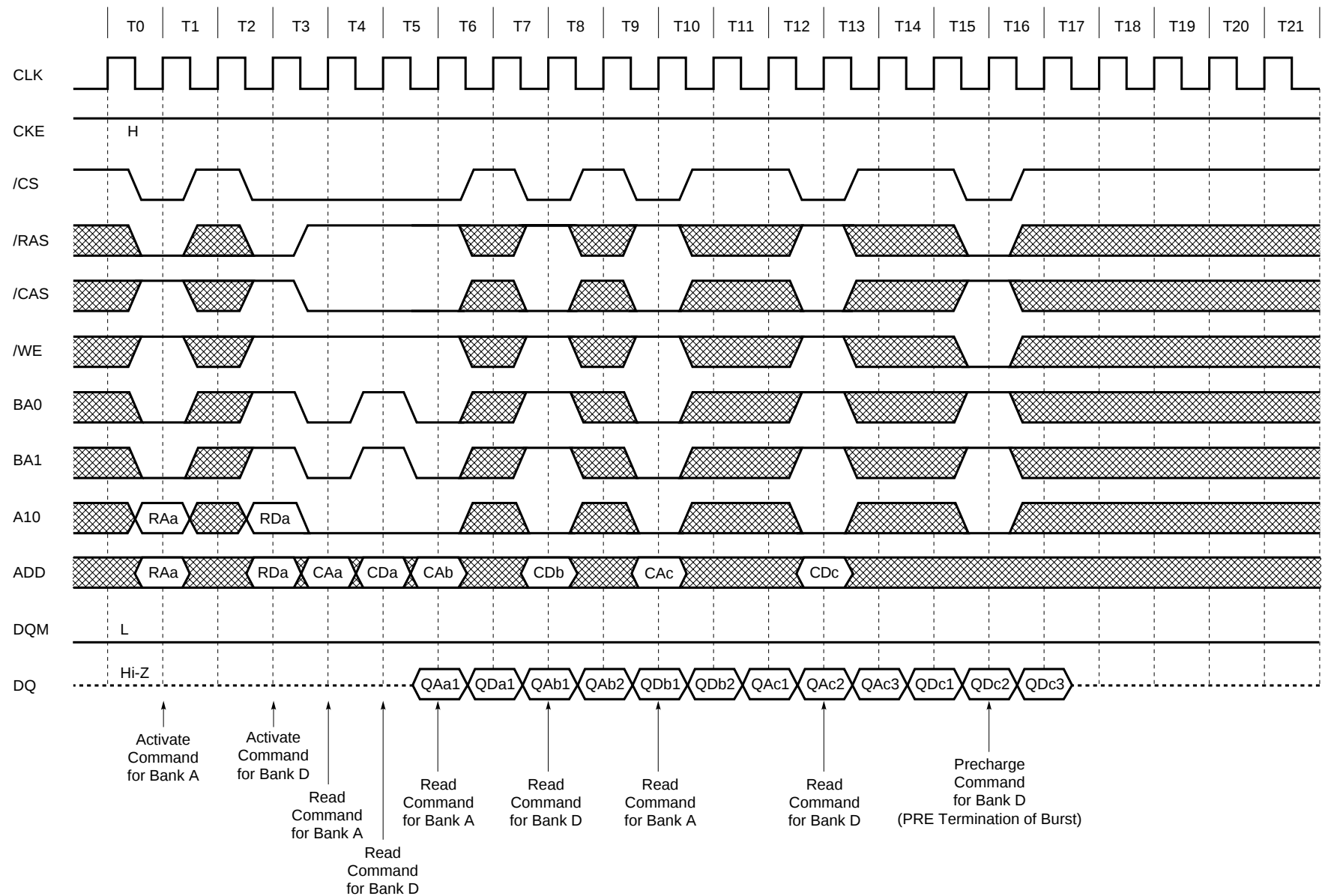
### 13.24 Burst Read and Single Write (Option) (Burst Length = 4, /CAS Latency = 2)



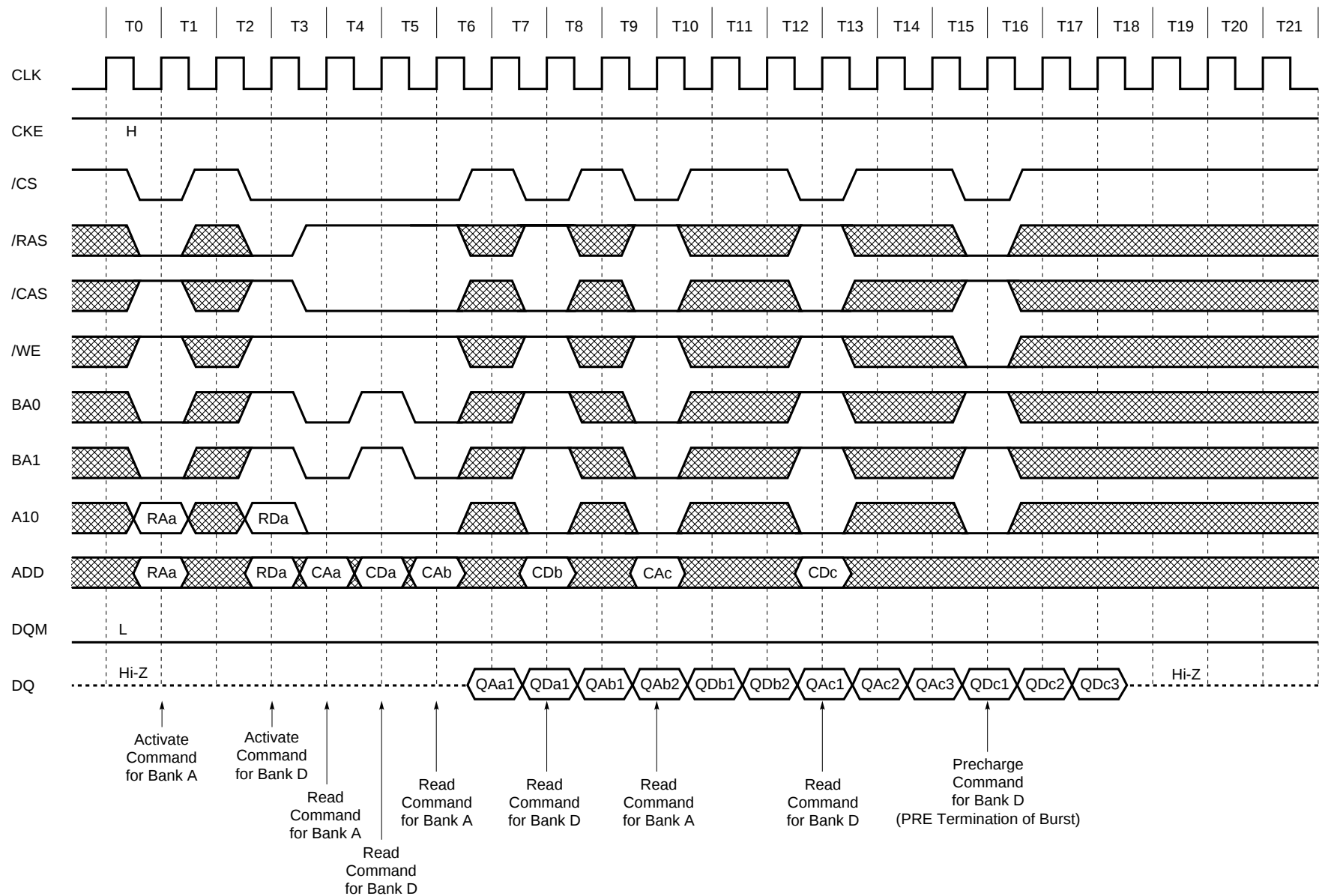
Burst Read and Single Write (Option) (Burst Length = 4, /CAS Latency = 3)



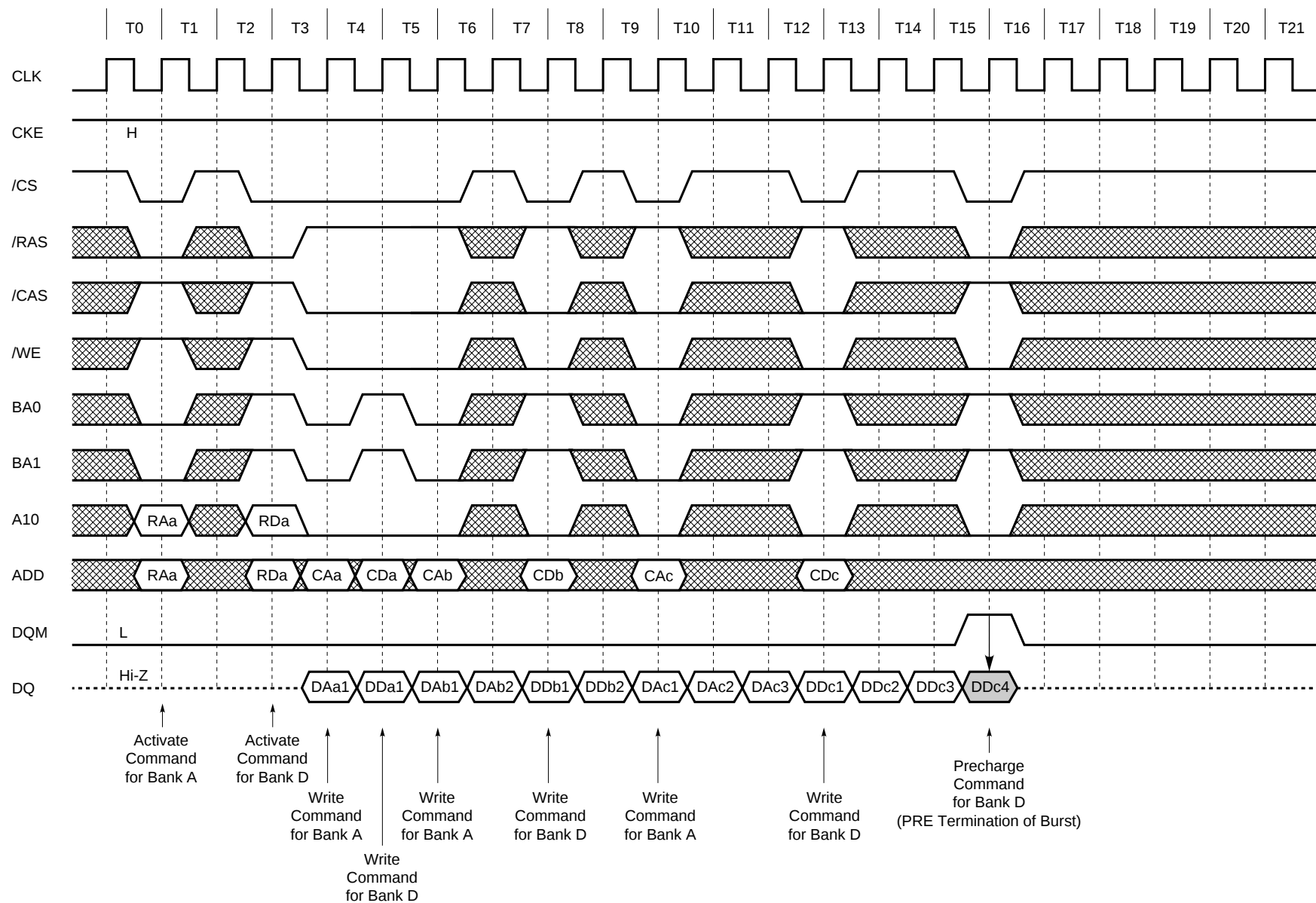
### 13.25 Full Page Random Column Read (Burst Length = Full Page, /CAS Latency = 2)



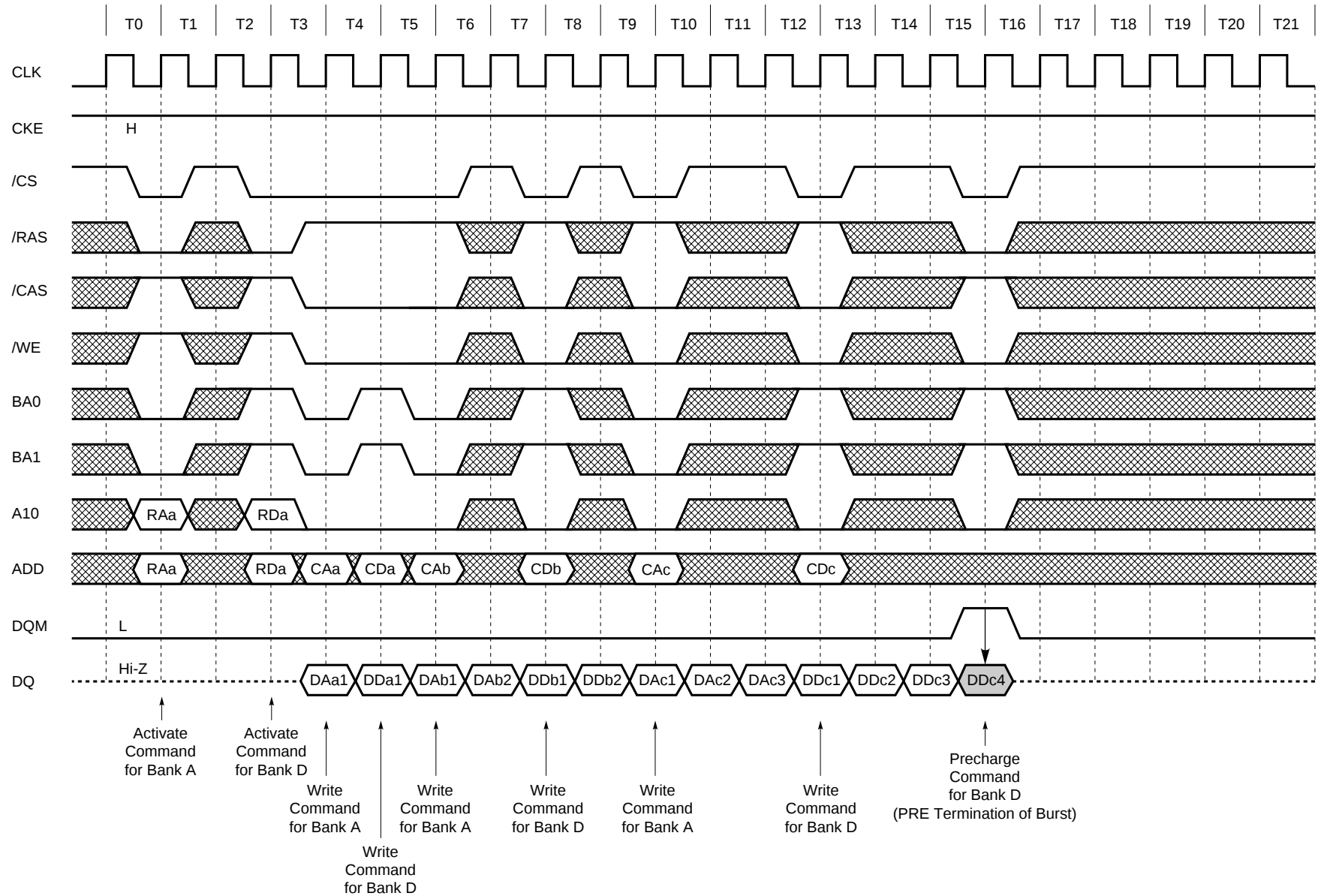
Full Page Random Column Read (Burst Length = Full Page, /CAS Latency = 3)



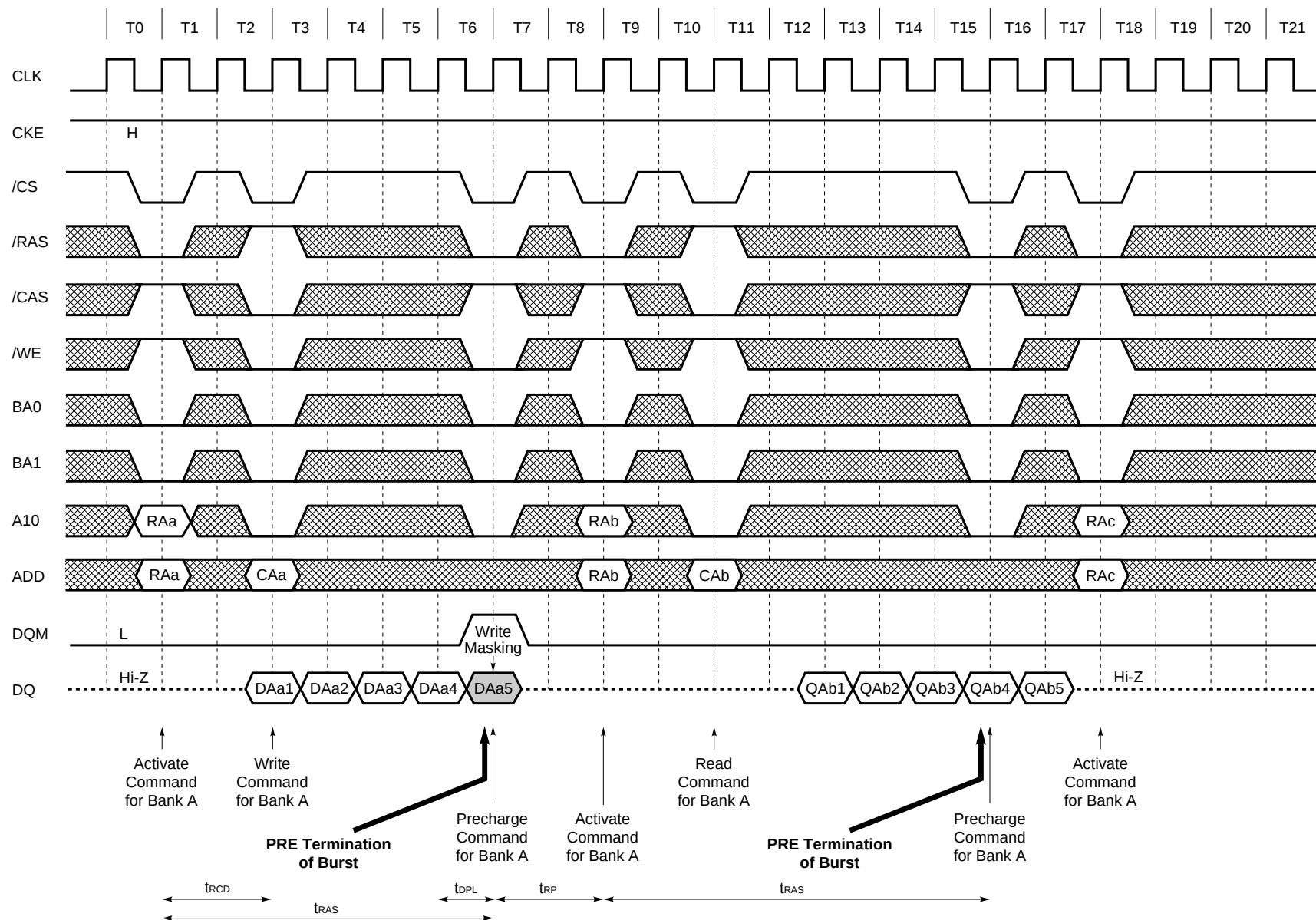
### 13.26 Full Page Random Column Write (Burst Length = Full Page, /CAS Latency = 2)



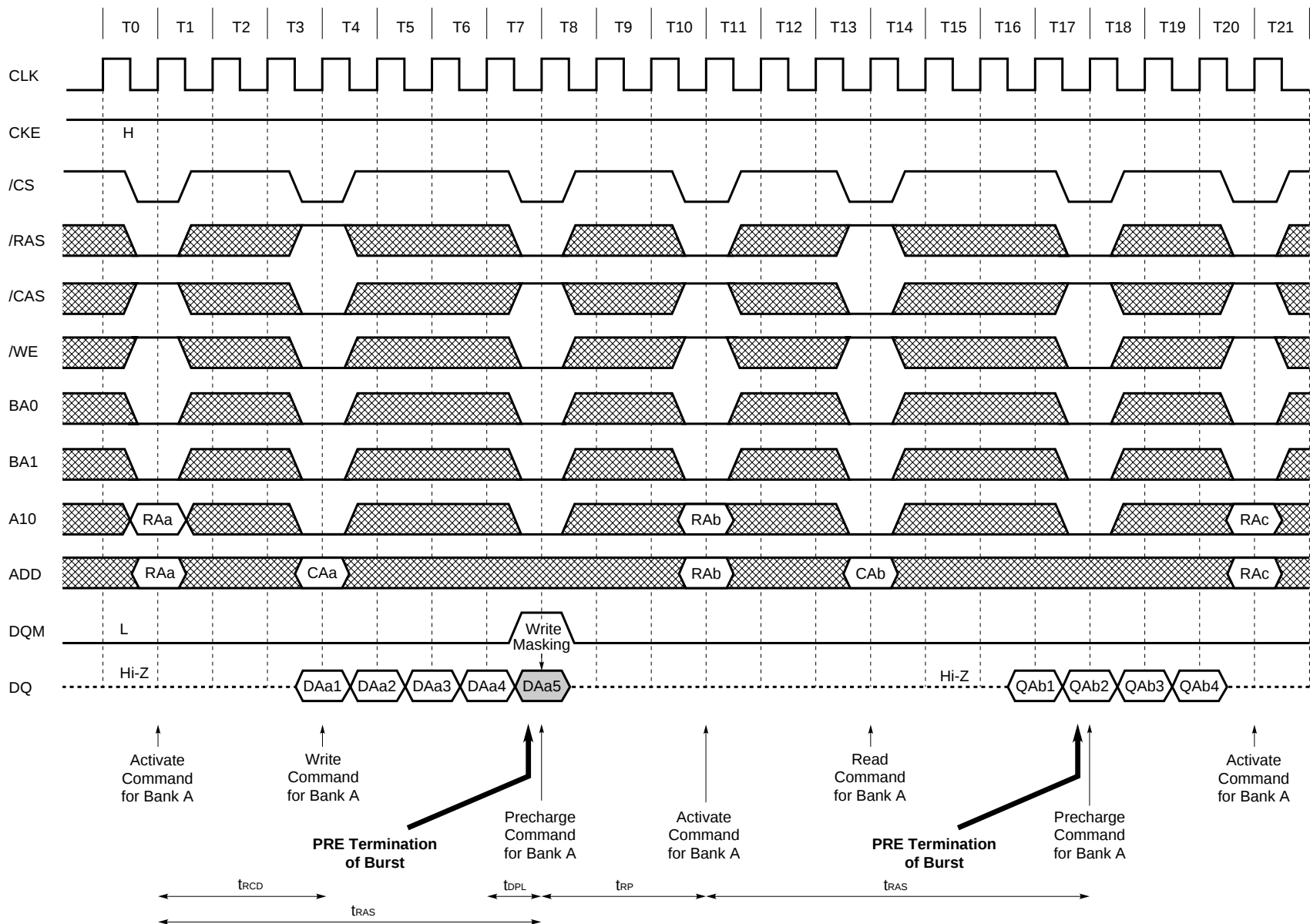
Full Page Random Column Write (Burst Length = Full Page, /CAS Latency = 3)



13.27 PRE (Precharge) Termination of Burst (1/2) (Burst Length = 8, /CAS Latency = 2)

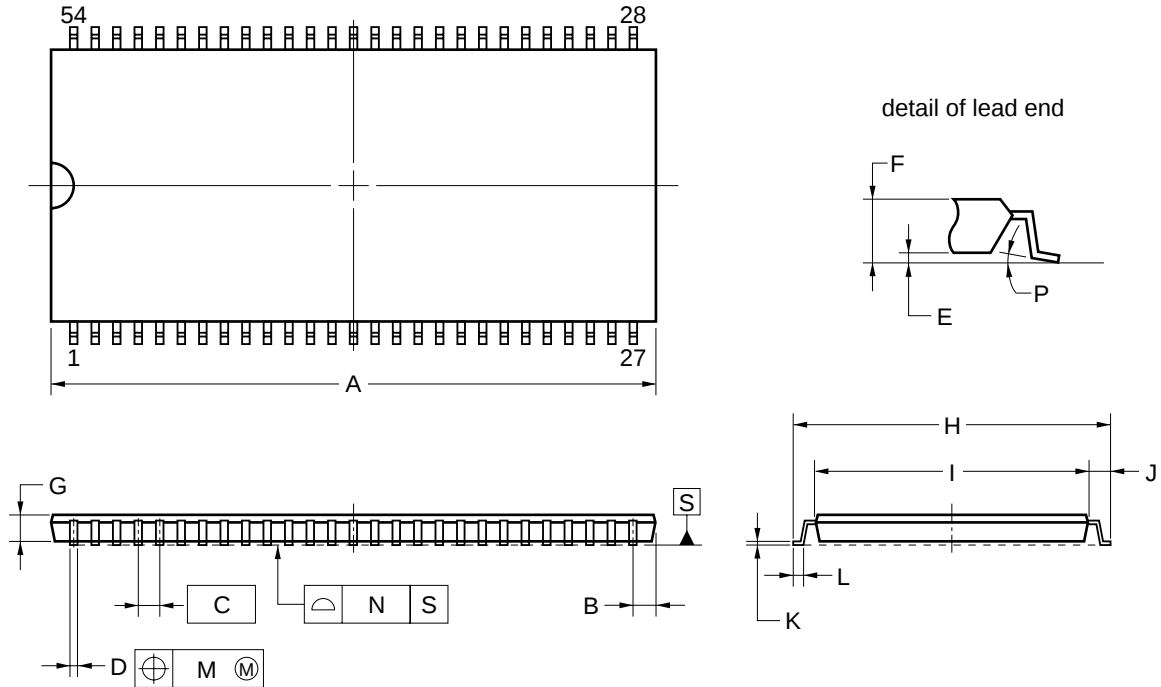


PRE (Precharge) Termination of Burst (2/2) (Burst Length = 8, /CAS Latency = 3)



## 14. Package Drawing

### 54-PIN PLASTIC TSOP (II) (10.16 mm (400))



#### NOTES

- Each lead centerline is located within 0.13 mm of its true position (T.P.) at maximum material condition.
- Dimension "A" does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per side.

| ITEM           | MILLIMETERS                               |
|----------------|-------------------------------------------|
| A              | 22.22±0.05                                |
| B              | 0.91 MAX.                                 |
| C              | 0.80 (T.P.)                               |
| D              | 0.32 <sup>+0.08</sup> <sub>-0.07</sub>    |
| E              | 0.10±0.05                                 |
| F              | 1.1±0.1                                   |
| G              | 1.00                                      |
| H              | 11.76±0.20                                |
| I              | 10.16±0.10                                |
| J              | 0.80±0.20                                 |
| K              | 0.145 <sup>+0.025</sup> <sub>-0.015</sub> |
| L              | 0.50±0.10                                 |
| M              | 0.13                                      |
| N              | 0.10                                      |
| P              | 3 <sup>+7°</sup> <sub>-3°</sub>           |
| S54G5-80-9JF-2 |                                           |

## 15. Recommended Soldering Conditions

Please consult with our sales offices for soldering conditions of the  $\mu$ PD45128xxx.

### Type of Surface Mount Device

$\mu$ PD45128xxxG5 : 54-pin Plastic TSOP (II) (10.16mm (400))

## 16. Revision History

| Edition /<br>Date           | Page                |                     | Description               |                                                                                                                                |
|-----------------------------|---------------------|---------------------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------|
|                             | This<br>edition     | Previous<br>edition | Type of<br>revision       | Location                                                                                                                       |
| 9th edition /<br>Mar. 1999  | p.15                | p.15                | Modification,<br>Addition | CKE Truth Table - Power down                                                                                                   |
|                             | p.19                | p.19                | Modification,<br>Addition | Command Truth Table for CKE - Power down                                                                                       |
|                             | p.35                | p.35                | Modification              | I <sub>CC1</sub> (spec), I <sub>CC2NS</sub> (spec), I <sub>CC3N</sub> (spec), I <sub>CC4</sub> (spec), I <sub>CC5</sub> (spec) |
|                             | p.37                | p.37                | Modification              | Output load                                                                                                                    |
|                             | p.50                | p.50                | Modification              | Timing Chart (Power Down Mode and Clock Mask)                                                                                  |
|                             | p.77                | p.77                | Modification              | Timing Chart (Full Page Random Column Read)                                                                                    |
| 10th edition /<br>Jan. 2000 | Throughout          | Throughout          | Modification              | A13 → BA0, A12 → BA1                                                                                                           |
|                             | p.2, 3              | p.2, 3              | Addition                  | -A75                                                                                                                           |
|                             |                     |                     | Deletion                  | -AxxL (Low power)                                                                                                              |
|                             | p.34                | p.34                | Addition                  | Pin Capacitance (MAX.)                                                                                                         |
|                             | p.35                | p.35                | Addition                  | -A75 specs                                                                                                                     |
|                             |                     |                     | Modification              | I <sub>CC5</sub>                                                                                                               |
|                             |                     |                     | Deletion                  | I <sub>CC6</sub> -AxxL (Low power)                                                                                             |
|                             | p.36                | p.36                | Modification              | AC Characteristics Test Conditions                                                                                             |
|                             | p.37, 38,<br>42     | p.37, 38,<br>42     | Addition                  | -A75 specs                                                                                                                     |
|                             | p.76, 78,<br>80, 82 | —                   | Addition                  | Timing chart (/CAS latency = 3)                                                                                                |
| 11th edition /<br>Apr. 2000 | p.85                | p.81                | Modification              | Package Drawing                                                                                                                |
|                             | p.38                | p.38                | Modification              | t <sub>RC1</sub> spec (-A10)                                                                                                   |

[MEMO]

[MEMO]

[MEMO]

## NOTES FOR CMOS DEVICES

### ① PRECAUTION AGAINST ESD FOR SEMICONDUCTORS

Note:

Strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor devices on it.

### ② HANDLING OF UNUSED INPUT PINS FOR CMOS

Note:

No connection for CMOS device inputs can be cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to  $V_{DD}$  or GND with a resistor, if it is considered to have a possibility of being an output pin. All handling related to the unused pins must be judged device by device and related specifications governing the devices.

### ③ STATUS BEFORE INITIALIZATION OF MOS DEVICES

Note:

Power-on does not necessarily define initial status of MOS device. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the devices with reset function have not yet been initialized. Hence, power-on does not guarantee out-pin levels, I/O settings or contents of registers. Device is not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for devices having reset function.

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